



# THE DATASHEET OF S25FL132K0XNFV011



## S25FL116K/S25FL132K/S25FL164K

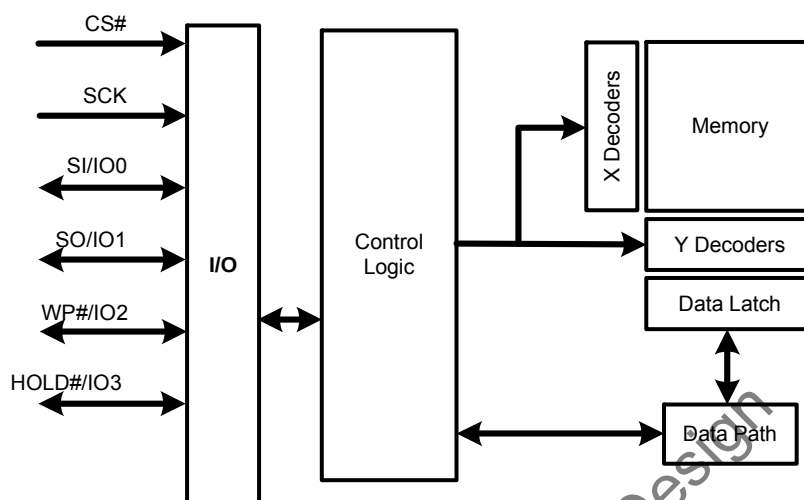
### 16-Mbit (2 Mbyte)/32-Mbit (4 Mbyte)/ 64-Mbit (8 Mbyte), 3.0 V, SPI Flash Memory

This product family has been retired and is not recommended for designs. For new and current designs, S25FL064L supersedes the S25FL1-K family. These are the factory-recommended migration paths. Please refer to the S25FL-L Family datasheets for specifications and ordering information.

## Features

- Serial Peripheral Interface (SPI) with Multi-I/O
  - SPI Clock polarity and phase modes 0 and 3
  - Command subset and footprint compatible with S25FL-K
- Read
  - Normal Read (Serial):
    - 50 MHz clock rate (–40 °C to +85 °C/105 °C)
  - Fast Read (Serial):
    - 108 MHz clock rate (–40 °C to +85 °C/105 °C)
  - Dual Read:
    - 108 MHz clock rate (–40 °C to +85 °C/105 °C)
  - Quad Read:
    - 108 MHz clock rate (–40 °C to +85 °C/105 °C)
  - 54 MB/s maximum continuous data transfer rate (–40 °C to +85 °C/105 °C)
  - Efficient Execute-In-Place (XIP)
  - Continuous and wrapped read modes
  - Serial Flash Discoverable Parameters (SFDP)
- Program
  - Serial-input Page Program (up to 256 bytes)
  - Program Suspend and Resume
- Erase
  - Uniform sector erase (4 kB)
  - Uniform block erase (64 kB)
  - Chip erase
  - Erase Suspend and Resume
- Cycling Endurance
  - 100K Program-Erase cycles, minimum
- Data Retention
  - 20-year data retention, minimum
- Security
  - Three 256-byte Security Registers with OTP protection
  - Low supply voltage protection of the entire memory
  - Pointer-based security protection feature (**S25FL132K and S25FL164K**)
  - Top / Bottom relative Block Protection Range, 4 kB to all of memory
- 8-Byte Unique ID for each device
- Non-volatile Status Register bits control protection modes
  - Software command protection
  - Hardware input signal protection
  - Lock-Down until power cycle protection
  - OTP protection of security registers
- 90 nm Floating Gate Technology
- Single Supply Voltage
  - 2.7 V to 3.6 V (Industrial, Industrial Plus, and Extended temperature range)
  - 2.6 V to 3.6 V (Extended temperature range)
- Temperature Ranges
  - Industrial (–40 °C to +85 °C)
  - Industrial Plus (–40 °C to +105 °C)
  - Automotive, AEC-Q100 Grade 3 (–40°C to +85°C)
  - Automotive, AEC-Q100 Grade 2 (–40°C to +105°C)
- Package Options
  - **S25FL116K**
    - 8-lead SOIC (150 mil) – SOA008
    - 8-lead SOIC (208 mil) – SOC008
    - 8-contact WSON 5 mm x 6 mm – WND008
    - 24-ball BGA 6 mm x 8 mm – FAB024 and FAC024
    - KGD / KGW
  - **S25FL132K**
    - 8-lead SOIC (150 mil) – SOA008
    - 8-lead SOIC (208 mil) – SOC008
    - 8-contact USON 4 mm x 4 mm – UNF008
    - 8-contact WSON 5 mm x 6 mm – WND008
    - 24-ball BGA 6 mm x 8 mm – FAB024 and FAC024
    - KGD / KGW
  - **S25FL164K**
    - 8-lead SOIC (208 mil) – SOC008
    - 16-lead SOIC (300 mil) – SO3016
    - 8-contact WSON 5 mm x 6 mm – WND008
    - 24-ball BGA 6 mm x 8 mm – FAB024 and FAC024

## Logic Block Diagram



## Performance Summary

Maximum Read Rates ( $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ ,  $85^\circ\text{C}/105^\circ\text{C}$ )

| Command   | Clock Rate (MHz) | Mbytes/s |
|-----------|------------------|----------|
| Read      | 50               | 6.25     |
| Fast Read | 108              | 13.5     |
| Dual Read | 108              | 27       |
| Quad Read | 108              | 54       |

Typical Program and Erase Rates ( $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ ,  $85^\circ\text{C}/105^\circ\text{C}$ )

| Operation                               | kbytes/s |
|-----------------------------------------|----------|
| Page Programming (256-byte page buffer) | 365      |
| 4-kbyte Sector Erase                    | 81       |
| 64-kbyte Sector Erase                   | 131      |

Typical Current Consumption ( $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ ,  $85^\circ\text{C}/105^\circ\text{C}$ )

| Operation           | Current (mA) |
|---------------------|--------------|
| Serial Read 50 MHz  | 7            |
| Serial Read 108 MHz | 12           |
| Dual Read 108 MHz   | 14           |
| Quad Read 108 MHz   | 16           |
| Program             | 20           |
| Erase               | 20           |
| Standby             | 0.015        |
| Deep-Power Down     | 0.002        |

## Contents

|                                                           |    |                                                                                                    |    |
|-----------------------------------------------------------|----|----------------------------------------------------------------------------------------------------|----|
| <b>1. General Description</b> .....                       | 4  | <b>5.2 Physical Diagrams</b> .....                                                                 | 31 |
| 1.1 Migration Notes .....                                 | 5  | <b>6. Address Space Maps</b> .....                                                                 | 38 |
| 1.2 Glossary .....                                        | 6  | 6.1 Overview .....                                                                                 | 38 |
| 1.3 Other Resources .....                                 | 7  | 6.2 Flash Memory Array .....                                                                       | 38 |
| <b>2. Signal Descriptions</b> .....                       | 8  | 6.3 Security Registers .....                                                                       | 39 |
| 2.1 Input / Output Summary .....                          | 8  | 6.4 Security Register 0 — Serial Flash<br>Discoverable Parameters<br>(SFDP — JEDEC JESD216B) ..... | 39 |
| 2.2 Address and Data Configuration .....                  | 9  | 6.5 Status Registers .....                                                                         | 49 |
| 2.3 Serial Clock (SCK) .....                              | 9  | 6.6 Device Identification .....                                                                    | 59 |
| 2.4 Chip Select (CS#) .....                               | 9  | <b>7. Functional Description</b> .....                                                             | 60 |
| 2.5 Serial Input (SI) / IO0 .....                         | 9  | 7.1 SPI Operations .....                                                                           | 60 |
| 2.6 Serial Output (SO) / IO1 .....                        | 9  | 7.2 Write Protection .....                                                                         | 61 |
| 2.7 Write Protect (WP#) / IO2 .....                       | 9  | 7.3 Status Registers .....                                                                         | 61 |
| 2.8 HOLD# / IO3 .....                                     | 10 | <b>8. Commands</b> .....                                                                           | 62 |
| 2.9 Core and I/O Signal Voltage Supply ( $V_{CC}$ ) ..... | 10 | 8.1 Configuration and Status Commands .....                                                        | 64 |
| 2.10 Supply and Signal Ground ( $V_{SS}$ ) .....          | 10 | 8.2 Program and Erase Commands .....                                                               | 67 |
| 2.11 Not Connected (NC) .....                             | 10 | 8.3 Read Commands .....                                                                            | 70 |
| 2.12 Reserved for Future Use (RFU) .....                  | 10 | 8.4 Reset Commands .....                                                                           | 75 |
| 2.13 Do Not Use (DNU) .....                               | 11 | 8.5 ID and Security Commands .....                                                                 | 77 |
| 2.14 Block Diagrams .....                                 | 11 | 8.6 Set Block / Pointer Protection (39h)<br>— S25FL132K and S25FL164K .....                        | 81 |
| <b>3. Signal Protocols</b> .....                          | 12 | <b>9. Data Integrity</b> .....                                                                     | 83 |
| 3.1 SPI Clock Modes .....                                 | 12 | 9.1 Erase Endurance .....                                                                          | 83 |
| 3.2 Command Protocol .....                                | 12 | 9.2 Data Retention .....                                                                           | 83 |
| 3.3 Interface States .....                                | 16 | 9.3 Initial Delivery State .....                                                                   | 83 |
| 3.4 Status Register Effects on the Interface .....        | 19 | <b>10. Ordering Information</b> .....                                                              | 84 |
| 3.5 Data Protection .....                                 | 19 | <b>11. Revision History</b> .....                                                                  | 87 |
| <b>4. Electrical Characteristics</b> .....                | 20 | <b>Document History Page 87</b>                                                                    |    |
| 4.1 Absolute Maximum Ratings .....                        | 20 | <b>Sales, Solutions, and Legal Information</b> .....                                               | 90 |
| 4.2 Thermal Resistance .....                              | 21 | Worldwide Sales and Design Support .....                                                           | 90 |
| 4.3 Operating Ranges .....                                | 21 | Products .....                                                                                     | 90 |
| 4.4 DC Electrical Characteristics .....                   | 22 | PSoC® Solutions .....                                                                              | 90 |
| 4.5 AC Measurement Conditions .....                       | 23 | Cypress Developer Community .....                                                                  | 90 |
| 4.6 Power-Up Timing .....                                 | 24 | Technical Support .....                                                                            | 90 |
| 4.7 Power-On (Cold) Reset .....                           | 25 |                                                                                                    |    |
| 4.8 AC Electrical Characteristics .....                   | 25 |                                                                                                    |    |
| <b>5. Physical Interface</b> .....                        | 29 |                                                                                                    |    |
| 5.1 Connection Diagrams .....                             | 29 |                                                                                                    |    |

## 1. General Description

The S25FL1-K of non-volatile flash memory devices connect to a host system via a Serial Peripheral Interface (SPI). Traditional SPI single bit serial input and output (Single I/O or SIO) is supported as well as optional two bit (Dual I/O or DIO) and four bit (Quad I/O or QIO) serial protocols. This multiple width interface is called SPI Multi-I/O or MIO.

The SPI-MIO protocols use only 4 to 6 signals:

- Chip Select (CS#)
- Serial Clock (SCK)
  - IO0 (SI)
  - IO1 (SO)
  - IO2 (WP#)
  - IO3 (HOLD#)
- Serial Data

The SIO protocol uses Serial Input (SI) and Serial Output (SO) for data transfer. The DIO protocols use IO0 and IO1 to input or output two bits of data in each clock cycle.

The Write Protect (WP#) input signal option allows hardware control over data protection. Software controlled commands can also manage data protection.

The HOLD# input signal option allows commands to be suspended and resumed on any clock cycle.

The QIO protocols use all of the data signals (IO0 to IO3) to transfer 4 bits in each clock cycle. When the QIO protocols are enabled the WP# and HOLD# inputs and features are disabled.

Clock frequency of up to 108 MHz is supported, allowing data transfer rates up to:

- Single bit data path = 13.5 Mbytes/s
- Dual bit data path = 27 Mbytes/s
- Quad bit data path = 54 Mbytes/s

Executing code directly from flash memory is often called execute-In-Place or XIP. By using S25FL1-K devices at the higher clock rates supported, with QIO commands, the command read transfer rate can match or exceed traditional x8 or x16 parallel interface, asynchronous, NOR flash memories, while reducing signal count dramatically. The Continuous Read Mode allows for random memory access with as few as 8-clocks of overhead for each access, providing efficient XIP operation. The Wrapped Read mode provides efficient instruction or data cache refill via a fast read of the critical byte that causes a cache miss, followed by reading all other bytes in the same cache line in a single read command.

The S25FL1-K:

- Support JEDEC standard manufacturer and device type identification.
- Program pages of 256 bytes each. One to 256 bytes can be programmed in each Page Program operation. Pages can be erased in groups of 16 (4-kB aligned sector erase), groups of 256 (64-kB aligned block erase), or the entire chip (chip erase).
- The S25FL1-K devices operate on a single 2.6V/2.7V to 3.6V power supply and all devices are offered in space-saving packages.
- Provides an ideal storage solution for systems with limited space, signal connections, and power. These memories offer flexibility and performance well beyond ordinary serial flash devices. They are ideal for code shadowing to RAM, executing code directly (XIP), and storing reprogrammable data.

## 1.1 Migration Notes

### 1.1.1 Features Comparison

The S25FL1-K is command set and footprint compatible with prior generation FL-K and FL-P families.

**Table 1. FL Generations Comparison**

| Parameter                    | S25FL1-K                        | S25FL-K                      | S25FL-P                 |
|------------------------------|---------------------------------|------------------------------|-------------------------|
| Technology Node              | 90 nm                           | 90 nm                        | 90 nm                   |
| Architecture                 | Floating Gate                   | Floating Gate                | MirrorBit®              |
| Release Date                 | In Production                   | In Production                | In Production           |
| Density                      | 16 Mbit - 64 Mbit               | 4 Mbit - 128 Mbit            | 32 Mbit - 256 Mbit      |
| Bus Width                    | x1, x2, x4                      | x1, x2, x4                   | x1, x2, x4              |
| Supply Voltage               | 2.6V / 2.7V - 3.6V              | 2.7V - 3.6V                  | 2.7V - 3.6V             |
| Normal Read Speed            | 6 MB/s (50 MHz)                 | 6 MB/s (50 MHz)              | 5 MB/s (40 MHz)         |
| Fast Read Speed              | 13.5 MB/s (108 MHz)             | 13 MB/s (104 MHz)            | 13 MB/s (104 MHz)       |
| Dual Read Speed              | 27 MB/s (108 MHz)               | 26 MB/s (104 MHz)            | 20 MB/s (80 MHz)        |
| Quad Read Speed              | 54 MB/s (108 MHz at 85°C/105°C) | 52 MB/s (104 MHz)            | 40 MB/s (80 MHz)        |
| Program Buffer Size          | 256B                            | 256B                         | 256B                    |
| Page Programming Time (typ.) | 700 µs (256B)                   | 700 µs (256B)                | 1500 µs (256B)          |
| Program Suspend / Resume     | Yes                             | Yes                          | No                      |
| Erase Sector Size            | 4 kB / 64 kB                    | 4 kB / 32 kB / 64 kB         | 64 kB / 256 kB          |
| Parameter Sector Size        | N/A                             | N/A                          | 4 kB                    |
| Sector Erase Time (typ.)     | 50 ms (4 kB), 500 ms (64 kB)    | 30 ms (4 kB), 150 ms (64 kB) | 500 ms (64 kB)          |
| Erase Suspend / Resume       | Yes                             | Yes                          | No                      |
| OTP Size                     | 768B (3 x 256B)                 | 768B (3 x 256B)              | 506B                    |
| Operating Temperature        | -40°C to +85°C / +105°C         | -40°C to +85°C               | -40°C to +85°C / +105°C |

**Notes:**

1. S25FL-K family devices can erase 4-kB sectors in groups of 32 kB or 64 kB.
2. S25FL1-K family devices can erase 4-kB sectors in groups of 64 kB.
3. S25FL-P has either 64-kB or 256-kB uniform sectors depending on an ordering option.
4. Refer to individual data sheets for further details.

### 1.1.2 Known Feature Differences from Prior Generations

#### 1.1.2.1 Secure Silicon Region (OTP)

The size and format (address map) of the One Time Program area is the same for the S25FL1-K and the S25FL-K but different for the S25FL-P.

### 1.1.2.2 Commands Not Supported

The following S25FL-K and S25FL-P commands are not supported:

- Quad Page PGM (32h)
- Half-Block Erase 32K (52h)
- Word read Quad I/O (E7)
- Octal Word Read Quad I/O (E3h)
- MFID dual I/O (92h)
- MFID quad I/O (94h)
- Read Unique ID (4Bh)

### 1.1.2.3 New Features

The S25FL1-K introduces new features to low density SPI category memories:

- Variable read latency (number of dummy cycles) for faster initial access time or higher clock rate read commands
- Industrial Plus and Extended temperature range
- Volatile configuration option in addition to legacy non-volatile configuration

## 1.2 Glossary

- **Command.** All information transferred between the host system and memory during one period while CS# is low. This includes the instruction (sometimes called an operation code or opcode) and any required address, mode bits, latency cycles, or data.
- **Flash.** The name for a type of Electrical Erase Programmable Read Only Memory (EEPROM) that erases large blocks of memory bits in parallel, making the erase operation much faster than early EEPROM.
- **High.** A signal voltage level  $\geq V_{IH}$  or a logic level representing a binary one (1).
- **Instruction.** The 8-bit code indicating the function to be performed by a command (sometimes called an operation code or opcode). The instruction is always the first 8 bits transferred from host system to the memory in any command.
- **Low.** A signal voltage level  $\leq V_{IL}$  or a logic level representing a binary zero (0).
- **LSB.** Least Significant Bit. Generally the right most bit, with the lowest order of magnitude value, within a group of bits of a register or data value.
- **MSB.** Most Significant Bit. Generally the left most bit, with the highest order of magnitude value, within a group of bits of a register or data value.
- **Non-Volatile.** No power is needed to maintain data stored in the memory.
- **OPN.** Ordering Part Number. The alphanumeric string specifying the memory device type, density, package, factory non-volatile configuration, etc. used to select the desired device.
- **Page.** 256-byte aligned and length group of data.
- **PCB.** Printed Circuit Board.
- **Register Bit References.** Are in the format: Register\_name[bit\_number] or Register\_name[bit\_range\_MSB: bit\_range\_LSB].
- **Sector.** Erase unit size; all sectors are physically 4-kbytes aligned and length. Depending on the erase command used, groups of physical sectors may be erased as a larger logical sector of 64 kbytes.
- **Write.** An operation that changes data within volatile or non-volatile registers bits or non-volatile flash memory. When changing non-volatile data, an erase and reprogramming of any unchanged non-volatile data is done, as part of the operation, such that the non-volatile data is modified by the write operation, in the same way that volatile data is modified – as a single operation. The non-volatile data appears to the host system to be updated by the single write command, without the need for separate commands for erase and reprogram of adjacent, but unaffected data.

## **1.3 Other Resources**

### **1.3.1 Cypress Flash Memory Roadmap**

[www.cypress.com/product-roadmaps/cypress-flash-memory-roadmap](http://www.cypress.com/product-roadmaps/cypress-flash-memory-roadmap)

### **1.3.2 Links to Software**

[www.cypress.com/software-and-drivers-cypress-flash-memory](http://www.cypress.com/software-and-drivers-cypress-flash-memory)

### **1.3.3 Links to Application Notes**

[www.cypress.com/cypressappnotes](http://www.cypress.com/cypressappnotes)

Not Recommended for New Design

## Hardware Interface

### Serial Peripheral Interface with Multiple Input / Output (SPI-MIO)

Many memory devices connect to their host system with separate parallel control, address, and data signals that require a large number of signal connections and larger package size. The large number of connections increase power consumption due to so many signals switching and the larger package increases cost.

The S25FL1-K reduces the number of signals for connection to the host system by serially transferring all control, address, and data information over 4 to 6 signals. This reduces the cost of the memory package, reduces signal switching power, and either reduces the host connection count or frees host connectors for use in providing other features.

The S25FL1-K uses the industry standard single bit Serial Peripheral Interface (SPI) and also supports commands for two bit (Dual) and four bit (Quad) wide serial transfers. This multiple width interface is called SPI Multi-I/O or SPI-MIO.

## 2. Signal Descriptions

### 2.1 Input / Output Summary

Table 2. Signal List

| Signal Name     | Type     | Description                                                                                                                                                                                                                                                                                                                                                |
|-----------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SCK             | Input    | <b>Serial Clock.</b>                                                                                                                                                                                                                                                                                                                                       |
| CS#             | Input    | <b>Chip Select.</b>                                                                                                                                                                                                                                                                                                                                        |
| SI (IO0)        | I/O      | <b>Serial Input</b> for single bit data commands. IO0 for Dual or Quad commands.                                                                                                                                                                                                                                                                           |
| SO (IO1)        | I/O      | <b>Serial Output</b> for single bit data commands. IO1 for Dual or Quad commands.                                                                                                                                                                                                                                                                          |
| WP# (IO2)       | I/O      | <b>Write Protect</b> in single bit or Dual data commands. IO2 in Quad mode. The signal has an internal pull-up resistor and may be left unconnected in the host system if not used for Quad commands.                                                                                                                                                      |
| HOLD# (IO3)     | I/O      | <b>Hold</b> (pause) serial transfer in single bit or Dual data commands. IO3 in Quad-I/O mode. The signal has an internal pull-up resistor and may be left unconnected in the host system if not used for Quad commands.                                                                                                                                   |
| V <sub>CC</sub> | Supply   | <b>Core and I/O Power Supply.</b>                                                                                                                                                                                                                                                                                                                          |
| V <sub>SS</sub> | Supply   | <b>Ground.</b>                                                                                                                                                                                                                                                                                                                                             |
| NC              | Unused   | <b>Not Connected.</b> No device internal signal is connected to the package connector nor is there any future plan to use the connector for a signal. The connection may safely be used for routing space for a signal on a Printed Circuit Board (PCB). However, any signal connected to an NC must not have voltage levels higher than V <sub>CC</sub> . |
| RFU             | Reserved | <b>Reserved for Future Use.</b> No device internal signal is currently connected to the package connector but there is potential future use of the connector for a signal. It is recommended to not use RFU connectors for PCB routing channels so that the PCB may take advantage of future enhanced features in compatible footprint devices.            |
| DNU             | Reserved | <b>Do Not Use.</b> Do not use these connections for PCB signal routing channels. Do not connect any host system signal to this connection.                                                                                                                                                                                                                 |

**Note:**

1. A signal name ending with the # symbol is active when low.

## 2.2 Address and Data Configuration

Traditional SPI single bit wide commands (Single or SIO) send information from the host to the memory only on the SI signal. Data may be sent back to the host serially on the Serial Output (SO) signal.

Dual or Quad Output commands send information from the host to the memory only on the SI signal. Data will be returned to the host as a sequence of bit pairs on IO0 and IO1 or four bit (nibble) groups on IO0, IO1, IO2, and IO3.

Dual or Quad Input / Output (I/O) commands send information from the host to the memory as bit pairs on IO0 and IO1 or four bit (nibble) groups on IO0, IO1, IO2, and IO3. Data is returned to the host similarly as bit pairs on IO0 and IO1 or four bit (nibble) groups on IO0, IO1, IO2, and IO3.

## 2.3 Serial Clock (SCK)

This input signal provides the synchronization reference for the SPI interface. Instructions, addresses, or data input are latched on the rising edge of the SCK signal. Data output changes after the falling edge of SCK.

## 2.4 Chip Select (CS#)

The chip select signal indicates when a command for the device is in process and the other signals are relevant for the memory device. When the CS# signal is at the logic high state, the device is not selected and all input signals are ignored and all output signals are high impedance. Unless an internal Program, Erase or Write Status Registers embedded operation is in progress, the device will be in the Standby Power mode. Driving the CS# input to logic low state enables the device, placing it in the Active Power mode. After Power-Up, a falling edge on CS# is required prior to the start of any command.

## 2.5 Serial Input (SI) / IO0

This input signal is used to transfer data serially into the device. It receives instructions, addresses, and data to be programmed. Values are latched on the rising edge of serial SCK clock signal.

SI becomes IO0 - an input and output during Dual and Quad commands for receiving instructions, addresses, and data to be programmed (values latched on rising edge of serial SCK clock signal) as well as shifting out data (on the falling edge of SCK).

## 2.6 Serial Output (SO) / IO1

This output signal is used to transfer data serially out of the device. Data is shifted out on the falling edge of the serial SCK clock signal.

SO becomes IO1, an input and output during Dual and Quad commands for receiving instructions, addresses, and data to be programmed (values latched on rising edge of serial SCK clock signal) as well as shifting out data (on the falling edge of SCK).

## 2.7 Write Protect (WP#) / IO2

When WP# is driven Low ( $V_{IL}$ ), while the Status Register Protect bits (SRP1 and SRP0) of the Status Registers (SR2[0] and SR1[7]) are set to 0 and 1 respectively, it is not possible to write to the Status Registers. This prevents any alteration of the Status Registers. As a consequence, all the data bytes in the memory area that are protected by the Block Protect, TB, SEC, and CMP bits in the status registers, are also hardware protected against data modification while WP# remains Low.

The WP# function is not available when the Quad mode is enabled (QE) in Status Register-2 (SR2[1]=1). The WP# function is replaced by IO2 for input and output during Quad mode for receiving addresses, and data to be programmed (values are latched on rising edge of the SCK signal) as well as shifting out data (on the falling edge of SCK).

WP# has an internal pull-up resistance; when unconnected, WP# is at  $V_{IH}$  and may be left unconnected in the host system if not used for Quad mode.

## 2.8 HOLD# / IO3

The HOLD# signal is used to pause any serial communications with the device without deselecting the device or stopping the serial clock.

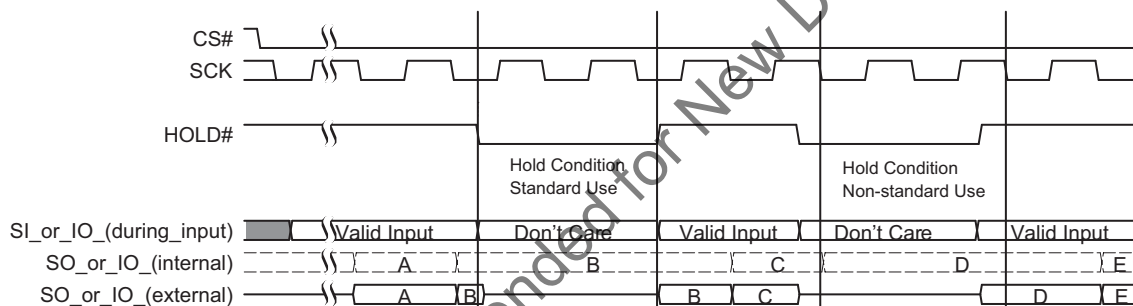
To enter the Hold condition, the device must be selected by driving the CS# input to the logic low state. It is required that the user keep the CS# input low state during the entire duration of the Hold condition. This is to ensure that the state of the interface logic remains unchanged from the moment of entering the Hold condition.

The Hold condition starts on the falling edge of the Hold (HOLD#) signal, provided that this coincides with SCK being at the logic low state. If the falling edge does not coincide with the SCK signal being at the logic low state, the Hold condition starts whenever the SCK signal reaches the logic low state. Taking the HOLD# signal to the logic low state does not terminate any Write, Program or Erase operation that is currently in progress.

During the Hold condition, SO is in high impedance and both the SI and SCK input are Don't Care.

The Hold condition ends on the rising edge of the Hold (HOLD#) signal, provided that this coincides with the SCK signal being at the logic low state. If the rising edge does not coincide with the SCK signal being at the logic low state, the Hold condition ends whenever the SCK signal reaches the logic low state.

**Figure 1. Hold Condition**



## 2.9 Core and I/O Signal Voltage Supply ( $V_{CC}$ )

$V_{CC}$  is the voltage source for all device internal logic and input / output signals. It is the single voltage used for all device functions including read, program, and erase.

## 2.10 Supply and Signal Ground ( $V_{SS}$ )

$V_{SS}$  is the common voltage drain and ground reference for the device core, input signal receivers, and output drivers.

## 2.11 Not Connected (NC)

No device internal signal is connected to the package connector nor is there any future plan to use the connector for a signal. The connection may safely be used for routing space for a signal on a Printed Circuit Board (PCB).

## 2.12 Reserved for Future Use (RFU)

No device internal signal is currently connected to the package connector but is there potential future use for the connector for a signal. It is recommended to not use RFU connectors for PCB routing channels so that the PCB may take advantage of future enhanced features in compatible footprint devices.

## 2.13 Do Not Use (DNU)

A device internal signal may be connected to the package connector. The connection may be used by Cypress for test or other purposes and is not intended for connection to any host system signal. Any DNU signal related function will be inactive when the signal is at  $V_{IL}$ . The signal has an internal pull-down resistor and may be left unconnected in the host system or may be tied to  $V_{SS}$ . Do not use these connections for PCB signal routing channels. Do not connect any host system signal to these connections.

## 2.14 Block Diagrams

**Figure 2. Bus Master and Memory Devices on the SPI Bus – Single Bit Data Path**

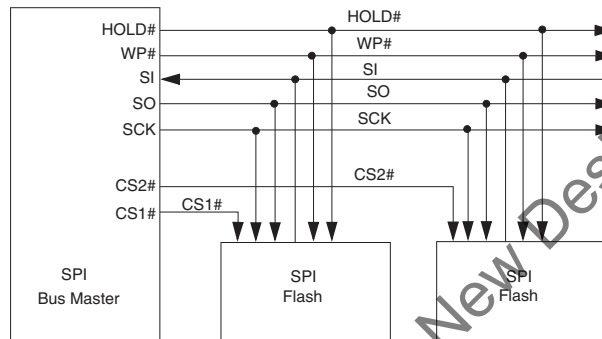


**Figure 3. Bus Master and Memory Devices on the SPI Bus – Dual Bit Data Path**

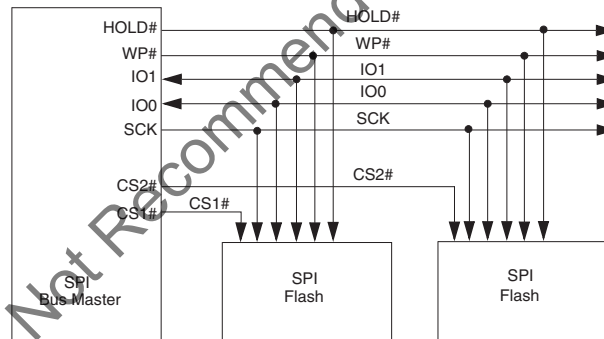
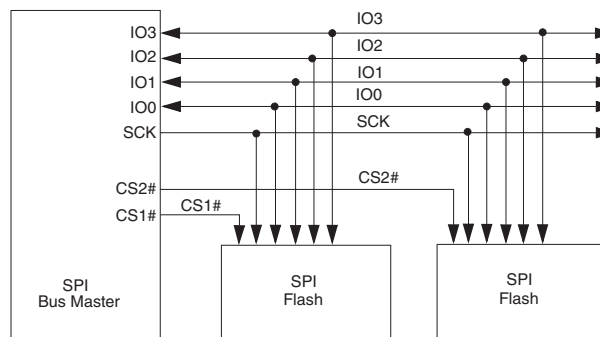


**Figure 4. Bus Master and Memory Devices on the SPI Bus – Quad Bit Data Path**



## 3. Signal Protocols

### 3.1 SPI Clock Modes

The S25FL1-K can be driven by an embedded microcontroller (bus master) in either of the two following clocking modes.

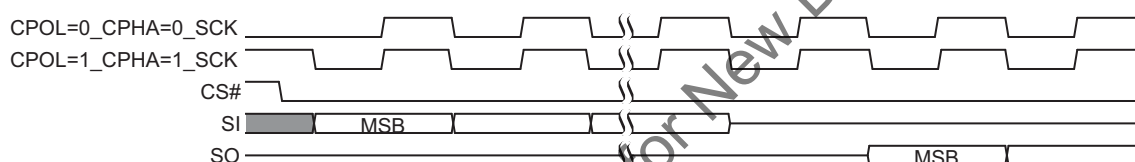
- **Mode 0** with Clock Polarity (CPOL) = 0 and, Clock Phase (CPHA) = 0
- **Mode 3** with CPOL = 1 and, CPHA = 1

For these two modes, input data into the device is always latched in on the rising edge of the SCK signal and the output data is always available from the falling edge of the SCK clock signal.

The difference between the two modes is the clock polarity when the bus master is in standby mode and not transferring any data.

- SCK will stay at logic low state with CPOL = 0, CPHA = 0
- SCK will stay at logic high state with CPOL = 1, CPHA = 1

**Figure 5. SPI Modes Supported**



Timing diagrams throughout the remainder of the document are generally shown as both mode 0 and 3 by showing SCK as both high and low at the fall of CS#. In some cases a timing diagram may show only mode 0 with SCK low at the fall of CS#. In such a case, mode 3 timing simply means clock is high at the fall of CS# so no SCK rising edge set up or hold time to the falling edge of CS# is needed for mode 3.

SCK cycles are measured (counted) from one falling edge of SCK to the next falling edge of SCK. In mode 0 the beginning of the first SCK cycle in a command is measured from the falling edge of CS# to the first falling edge of SCK because SCK is already low at the beginning of a command.

### 3.2 Command Protocol

All communication between the host system and S25FL1-K memory devices is in the form of units called commands.

All commands begin with an instruction that selects the type of information transfer or device operation to be performed. Commands may also have an address, instruction modifier (mode), latency period, data transfer to the memory, or data transfer from the memory. All instruction, address, and data information is transferred serially between the host system and memory device.

All instructions are transferred from host to memory as a single bit serial sequence on the SI signal.

Single bit wide commands may provide an address or data sent only on the SI signal. Data may be sent back to the host serially on the SO signal.

Dual or Quad Output commands provide an address sent to the memory only on the SI signal. Data will be returned to the host as a sequence of bit pairs on IO0 and IO1 or four bit (nibble) groups on IO0, IO1, IO2, and IO3.

Dual or Quad Input / Output (I/O) commands provide an address sent from the host as bit pairs on IO0 and IO1 or, four bit (nibble) groups on IO0, IO1, IO2, and IO3. Data is returned to the host similarly as bit pairs on IO0 and IO1 or, four bit (nibble) groups on IO0, IO1, IO2, and IO3.

Commands are structured as follows:

- Each command begins with CS# going low and ends with CS# returning high. The memory device is selected by the host driving the Chip Select (CS#) signal low throughout a command.
- The serial clock (SCK) marks the transfer of each bit or group of bits between the host and memory.
- Each command begins with an eight bit (byte) instruction. The instruction is always presented only as a single bit serial sequence on the Serial Input (SI) signal with one bit transferred to the memory device on each SCK rising edge. The instruction selects the type of information transfer or device operation to be performed.
- The instruction may be stand alone or may be followed by address bits to select a location within one of several address spaces in the device. The instruction determines the address space used. The address is a 24-bit, byte boundary, address. The address transfers occur on SCK rising edge.
- The width of all transfers following the instruction are determined by the instruction sent. Following transfers may continue to be single bit serial on only the SI or Serial Output (SO) signals, they may be done in 2-bit groups per (dual) transfer on the IO0 and IO1 signals, or they may be done in 4-bit groups per (quad) transfer on the IO0-IO3 signals. Within the dual or quad groups the least significant bit is on IO0. More significant bits are placed in significance order on each higher numbered IO signal. Single bits or parallel bit groups are transferred in most to least significant bit order.
- Some instructions send an instruction modifier called mode bits, following the address, to indicate that the next command will be of the same type with an implied, rather than an explicit, instruction. The next command thus does not provide an instruction byte, only a new address and mode bits. This reduces the time needed to send each command when the same command type is repeated in a sequence of commands. The mode bit transfers occur on SCK rising edge.
- The address or mode bits may be followed by write data to be stored in the memory device or by a read latency period before read data is returned to the host.
- Write data bit transfers occur on SCK rising edge.
- SCK continues to toggle during any read access latency period. The latency may be zero to several SCK cycles (also referred to as dummy cycles). At the end of the read latency cycles, the first read data bits are driven from the outputs on SCK falling edge at the end of the last read latency cycle. The first read data bits are considered transferred to the host on the following SCK rising edge. Each following transfer occurs on the next SCK rising edge.
- If the command returns read data to the host, the device continues sending data transfers until the host takes the CS# signal high. The CS# signal can be driven high after any transfer in the read data sequence. This will terminate the command.
- At the end of a command that does not return data, the host drives the CS# input high. The CS# signal must go high after the eighth bit, of a stand alone instruction or, of the last write data byte that is transferred. That is, the CS# signal must be driven high when the number of clock cycles after CS# signal was driven low is an exact multiple of eight cycles. If the CS# signal does not go high exactly at the eight SCK cycle boundary of the instruction or write data, the command is rejected and not executed.
- All instruction, address, and mode bits are shifted into the device with the most significant bits (MSB) first. The data bits are shifted in and out of the device MSB first. All data is transferred in byte units with the lowest address byte sent first. Following bytes of data are sent in lowest to highest byte address order i.e. the byte address increments.
- All attempts to read the flash memory array during a program, erase, or a write cycle (embedded operations) are ignored. The embedded operation will continue to execute without any affect. A very limited set of commands are accepted during an embedded operation. These are discussed in the individual command descriptions.
- Depending on the command, the time for execution varies. A command to read status information from an executing command is available to determine when the command completes execution and whether the command was successful.

### 3.2.1 Command Sequence Examples

**Figure 6. Stand Alone Instruction Command**

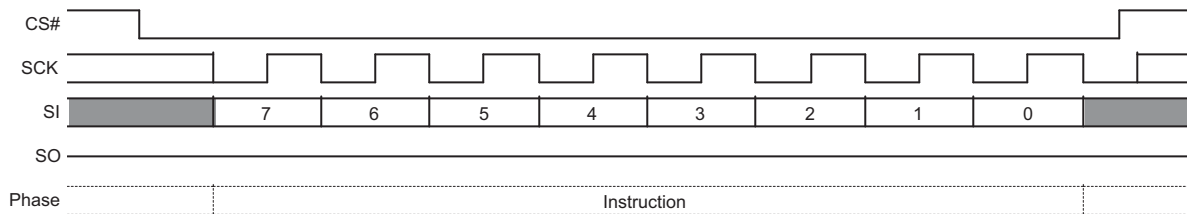


**Figure 7. Single Bit Wide Input Command**

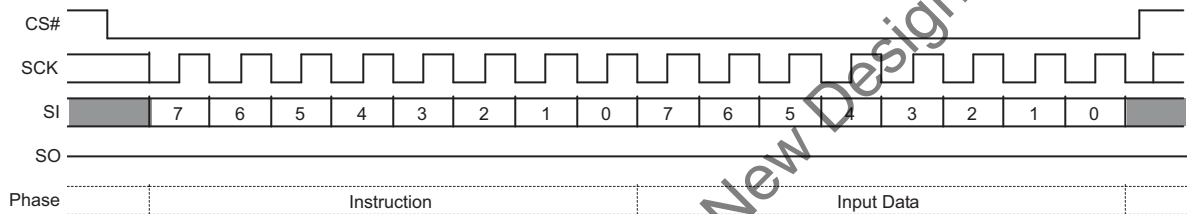


**Figure 8. Single Bit Wide Output Command**

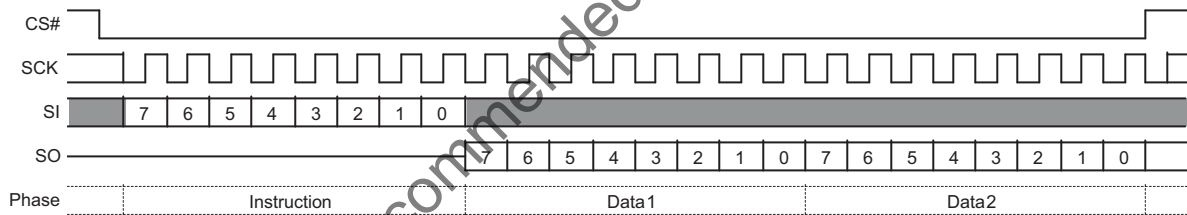


**Figure 9. Single Bit Wide I/O Command without Latency**

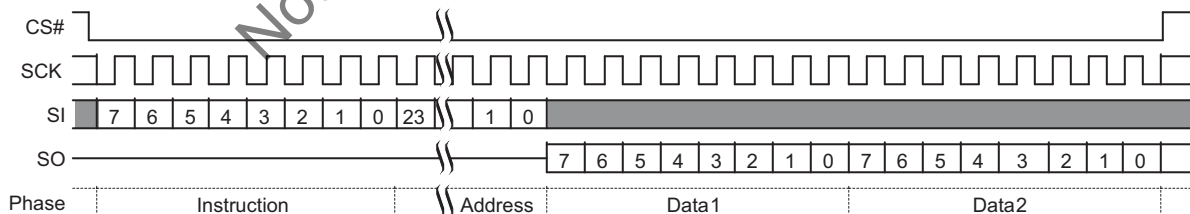


**Figure 10. Single Bit Wide I/O Command with Latency**

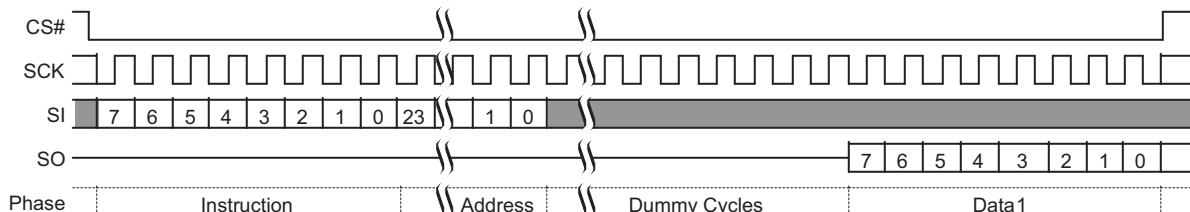
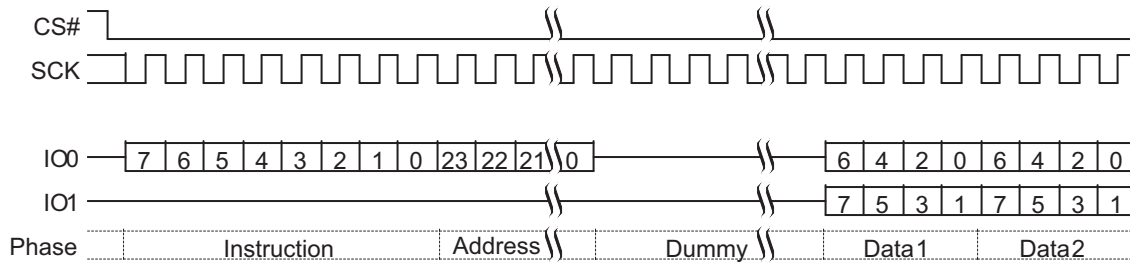
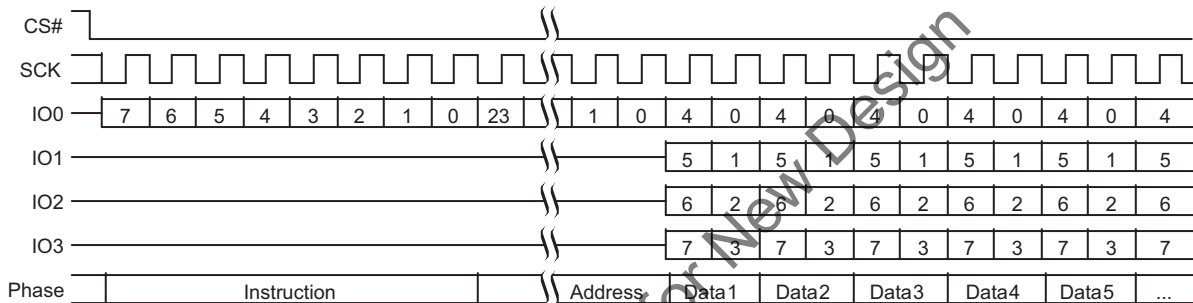
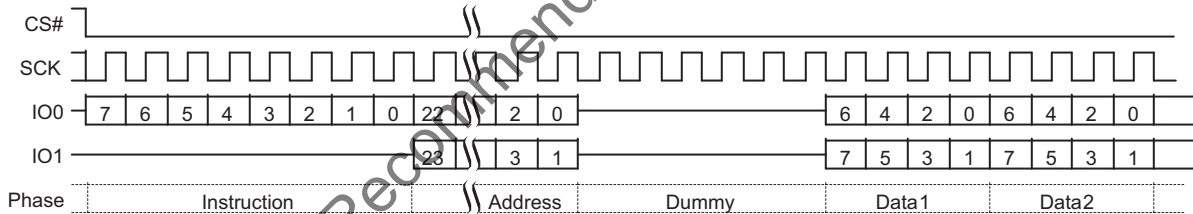
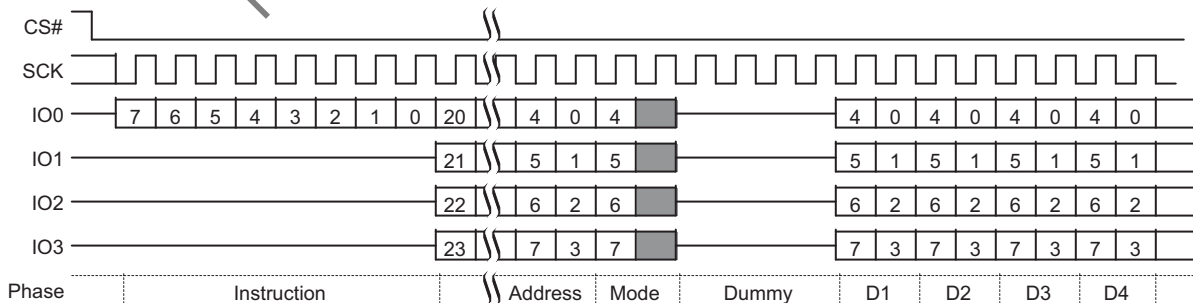


**Figure 11. Dual Output Command**

**Figure 12. Quad Output Command without Latency**

**Figure 13. Dual I/O Command**

**Figure 14. Quad I/O Command**


Additional sequence diagrams, specific to each command, are provided in [Commands on page 62](#).

### 3.3 Interface States

This section describes the input and output signal levels as related to the SPI interface behavior.

**Table 3. Interface States Summary**

| Interface State                                | V <sub>CC</sub>         | SCK      | CS# | HOLD# / IO3 | WP# / IO2 | SO / IO1 | SI / IO0 |
|------------------------------------------------|-------------------------|----------|-----|-------------|-----------|----------|----------|
| Low Power<br>Hardware Data Protection          | < V <sub>WI</sub>       | X        | X   | X           | X         | Z        | X        |
| Power-On (Cold) Reset                          | ≥ V <sub>CC</sub> (min) | X        | HH  | X           | X         | Z        | X        |
| Interface Standby                              | ≥ V <sub>CC</sub> (min) | X        | X   | X           | X         | Z        | X        |
| Instruction Cycle                              | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | HV        | Z        | HV       |
| Hold Cycle                                     | ≥ V <sub>CC</sub> (min) | HV or HT | HL  | HL          | X         | X        | X        |
| Single Input Cycle<br>Host to Memory Transfer  | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | Z        | HV       |
| Single Latency (Dummy) Cycle                   | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | Z        | X        |
| Single Output Cycle<br>Memory to Host Transfer | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | MV       | X        |
| Dual Input Cycle<br>Host to Memory Transfer    | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | HV       | HV       |
| Dual Latency (Dummy) Cycle                     | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | X        | X        |
| Dual Output Cycle<br>Memory to Host Transfer   | ≥ V <sub>CC</sub> (min) | HT       | HL  | HH          | X         | MV       | MV       |
| Quad Input Cycle<br>Host to Memory Transfer    | ≥ V <sub>CC</sub> (min) | HT       | HL  | HV          | HV        | HV       | HV       |
| Quad Latency (Dummy) Cycle                     | ≥ V <sub>CC</sub> (min) | HT       | HL  | X           | X         | X        | X        |
| Quad Output Cycle<br>Memory to Host Transfer   | ≥ V <sub>CC</sub> (min) | HT       | HL  | MV          | MV        | MV       | MV       |

**Legend:**

Z = no driver - floating signal  
 HL = Host driving V<sub>IL</sub>  
 HH = Host driving V<sub>IH</sub>  
 HV = either HL or HH  
 X = HL or HH or Z  
 HT = toggling between HL and HH  
 ML = Memory driving V<sub>IL</sub>  
 MH = Memory driving V<sub>IH</sub>  
 MV = either ML or MH

#### 3.3.1 Low Power Hardware Data Protection

When V<sub>CC</sub> is less than V<sub>WI</sub> the memory device will ignore commands to ensure that program and erase operations can not start when the core supply voltage is out of the operating range.

#### 3.3.2 Power-On (Cold) Reset

When the core voltage supply remains at or below the V<sub>CC (Low)</sub> voltage for > t<sub>PD</sub> time, then rises to ≥ V<sub>WI</sub> the device will begin its Power-On-Reset (POR) process. POR continues until the end of t<sub>PUR</sub>. During t<sub>PUR</sub> the device does not react to write commands. Following the end of t<sub>PUR</sub> the device transitions to the Interface Standby state and can accept write commands. For additional information on POR see [Power-On \(Cold\) Reset on page 25](#).

### 3.3.3 Interface Standby

When CS# is high the SPI interface is in standby state. Inputs are ignored. The interface waits for the beginning of a new command. The next interface state is Instruction Cycle when CS# goes low to begin a new command.

While in interface standby state the memory device draws standby current ( $I_{SB}$ ) if no embedded algorithm is in progress. If an embedded algorithm is in progress, the related current is drawn until the end of the algorithm when the entire device returns to standby current draw.

### 3.3.4 Instruction Cycle

When the host drives the MSB of an instruction and CS# goes low, on the next rising edge of SCK the device captures the MSB of the instruction that begins the new command. On each following rising edge of SCK the device captures the next lower significance bit of the 8-bit instruction. The host keeps CS# low, HOLD# high, and drives Write Protect (WP#) signal as needed for the instruction. However, WP# is only relevant during instruction cycles of a Write Status Registers command and is otherwise ignored.

Each instruction selects the address space that is operated on and the transfer format used during the remainder of the command. The transfer format may be Single, Dual output, Quad output, Dual I/O, or Quad I/O. The expected next interface state depends on the instruction received.

Some commands are stand alone, needing no address or data transfer to or from the memory. The host returns CS# high after the rising edge of SCK for the eighth bit of the instruction in such commands. The next interface state in this case is Interface Standby.

### 3.3.5 Hold

When Quad mode is not enabled (SR2[1]=0) the HOLD# / IO3 signal is used as the HOLD# input. The host keeps HOLD# low, SCK may be at a valid level or continue toggling, and CS# is low. When HOLD# is low a command is paused, as though SCK were held low. SI / IO0 and SO / IO1 ignore the input level when acting as inputs and are high impedance when acting as outputs during hold state. Whether these signals are input or output depends on the command and the point in the command sequence when HOLD# is asserted low.

When HOLD# returns high the next state is the same state the interface was in just before HOLD# was asserted low.

### 3.3.6 Single Input Cycle — Host to Memory Transfer

Several commands transfer information after the instruction on the single serial input (SI) signal from host to the memory device. The dual output, and quad output commands send address to the memory using only SI but return read data using the I/O signals. The host keeps CS# low, HOLD# high, and drives SI as needed for the command. The memory does not drive the Serial Output (SO) signal.

The expected next interface state depends on the instruction. Some instructions continue sending address or data to the memory using additional Single Input Cycles. Others may transition to Single Latency, or directly to Single, Dual, or Quad Output.

### 3.3.7 Single Latency (Dummy) Cycle

Read commands may have zero to several latency cycles during which read data is read from the main flash memory array before transfer to the host. The number of latency cycles are determined by the instruction. During the latency cycles, the host keeps CS# low, and HOLD# high. The Write Protect (WP#) signal is ignored. The host may drive the SI signal during these cycles or the host may leave SI floating. The memory does not use any data driven on SI / IO0 or other I/O signals during the latency cycles. In dual or quad read commands, the host must stop driving the I/O signals on the falling edge at the end of the last latency cycle. It is recommended that the host stop driving I/O signals during latency cycles so that there is sufficient time for the host drivers to turn off before the memory begins to drive at the end of the latency cycles. This prevents driver conflict between host and memory when the signal direction changes. The memory does not drive the Serial Output (SO) or I/O signals during the latency cycles.

The next interface state depends on the command structure i.e. the number of latency cycles, and whether the read is single, dual, or quad width.

### **3.3.8 Single Output Cycle — Memory to Host Transfer**

Several commands transfer information back to the host on the single Serial Output (SO) signal. The host keeps CS# low, and HOLD# high. The Write Protect (WP#) signal is ignored. The memory ignores the Serial Input (SI) signal. The memory drives SO with data.

The next interface state continues to be Single Output Cycle until the host returns CS# to high ending the command.

### **3.3.9 Dual Input Cycle — Host to Memory Transfer**

The Read Dual I/O command transfers two address or mode bits to the memory in each cycle. The host keeps CS# low, HOLD# high. The Write Protect (WP#) signal is ignored. The host drives address on SI / IO0 and SO / IO1.

The next interface state following the delivery of address and mode bits is a Dual Latency Cycle if there are latency cycles needed or Dual Output Cycle if no latency is required.

#### **3.3.10 Dual Latency (Dummy) Cycle**

Read commands may have zero to several latency cycles during which read data is read from the main flash memory array before transfer to the host. The number of latency cycles are determined by the instruction. During the latency cycles, the host keeps CS# low, and HOLD# high. The Write Protect (WP#) signal is ignored. The host may drive the SI / IO0 and SO / IO1 signals during these cycles or the host may leave

SI / IO0 and SO / IO1 floating. The memory does not use any data driven on SI / IO0 and SO / IO1 during the latency cycles. The host must stop driving SI / IO0 and SO / IO1 on the falling edge at the end of the last latency cycle. It is recommended that the host stop driving them during all latency cycles so that there is sufficient time for the host drivers to turn off before the memory begins to drive at the end of the latency cycles. This prevents driver conflict between host and memory when the signal direction changes. The memory does not drive the SI / IO0 and SO / IO1 signals during the latency cycles.

The next interface state following the last latency cycle is a Dual Output Cycle.

#### **3.3.11 Dual Output Cycle — Memory to Host Transfer**

The Read Dual Output and Read Dual I/O return data to the host two bits in each cycle. The host keeps CS# low, and HOLD# high. The Write Protect (WP#) signal is ignored. The memory drives data on the SI / IO0 and SO / IO1 signals during the dual output cycles.

The next interface state continues to be Dual Output Cycle until the host returns CS# to high ending the command.

#### **3.3.12 Quad Input Cycle — Host to Memory Transfer**

The Read Quad I/O command transfers four address, mode, or data bits to the memory in each cycle. The host keeps CS# low, and drives the IO signals.

For Read Quad I/O the next interface state following the delivery of address and mode bits is a Quad Latency Cycle if there are latency cycles needed or Quad Output Cycle if no latency is required.

#### **3.3.13 Quad Latency (Dummy) Cycle**

Read commands may have zero to several latency cycles during which read data is read from the main flash memory array before transfer to the host. The number of latency cycles are determined by the Latency Control in the Status Register-3 (SR3[3:0]). During the latency cycles, the host keeps CS# low. The host may drive the IO signals during these cycles or the host may leave the IO floating. The memory does not use any data driven on IO during the latency cycles. The host must stop driving the IO signals on the falling edge at the end of the last latency cycle. It is recommended that the host stop driving them during all latency cycles so that there is sufficient time for the host drivers to turn off before the memory begins to drive at the end of the latency cycles. This prevents driver conflict between host and memory when the signal direction changes. The memory does not drive the IO signals during the latency cycles.

The next interface state following the last latency cycle is a Quad Output Cycle.

### **3.3.14 Quad Output Cycle — Memory to Host Transfer**

The Read Quad Output and Read Quad I/O return data to the host four bits in each cycle. The host keeps CS# low. The memory drives data on IO0-IO3 signals during the Quad output cycles.

The next interface state continues to be Quad Output Cycle until the host returns CS# to high ending the command.

## **3.4 Status Register Effects on the Interface**

The Status Register-2, bit 1 (SR2[1]), selects whether Quad mode is enabled to ignore HOLD# and WP# and allow Read Quad Output, and Read Quad I/O commands.

## **3.5 Data Protection**

Some basic protection against unintended changes to stored data are provided and controlled purely by the hardware design. These are described below. Other software managed protection methods are discussed in the software section of this document.

### **3.5.1 Low Power**

When  $V_{CC}$  is less than  $V_{WL}$  the memory device will ignore commands to ensure that program and erase operations can not start when the core supply voltage is out of the operating range.

### **3.5.2 Power-Up**

Program and erase operations continue to be prevented during the Power-Up to Write delay ( $t_{PUW}$ ) because no write command is accepted until after  $t_{PUW}$ .

### **3.5.3 Deep Power-Down (DPD)**

In DPD mode the device responds only to the Resume from DPD command (RES ABh). All other commands are ignored during DPD mode, thereby protecting the memory from program and erase operations.

### **3.5.4 Clock Pulse Count**

The device verifies that all program, erase, and Write Status Registers commands consist of a clock pulse count that is a multiple of eight before executing them. A command not having a multiple of 8 clock pulse count is ignored and no error status is set for the command.

## 4. Electrical Characteristics

### 4.1 Absolute Maximum Ratings

Table 4. Absolute Maximum Ratings

| Parameters (1)                  | Symbol     | Conditions                           | Range          | Unit |
|---------------------------------|------------|--------------------------------------|----------------|------|
| Supply Voltage                  | $V_{CC}$   |                                      | -0.6 to +4.0   | V    |
| Voltage Applied to any Pin      | $V_{IO}$   | Relative to Ground                   | -0.6 to +4.0   | V    |
| Transient Voltage on any Pin    | $V_{IOT}$  | < 20 ns Transient Relative to Ground | -2.0 to 6.0    | V    |
| Storage Temperature             | $T_{STG}$  |                                      | -65 to +150    | °C   |
| Lead Temperature                | $T_{LEAD}$ |                                      | (2)            | °C   |
| Electrostatic Discharge Voltage | $V_{ESD}$  | Human Body Model (3)                 | -2000 to +2000 | V    |

**Notes:**

1. This device has been designed and tested for the specified operation ranges. Proper operation outside of these levels is not guaranteed. Exposure to absolute maximum ratings may affect device reliability. Exposure beyond absolute maximum ratings may cause permanent damage.
2. Compliant with JEDEC Standard J-STD-20C for small body Sn-Pb or Pb-free (Green) assembly and the European directive on restrictions on hazardous substances (RoHS) 2002/95/EU.
3. JEDEC Std JESD22-A114A ( $C1=100$  pF,  $R1=1500$  ohms,  $R2=500$  ohms).

#### 4.1.1 Input Signal Overshoot

During DC conditions, input or I/O signals should remain equal to or between  $V_{SS}$  and  $V_{CC}$ . During voltage transitions, inputs or I/Os may overshoot  $V_{SS}$  to negative  $V_{IOT}$  or overshoot to positive  $V_{IOT}$  for periods up to 20 ns.

Figure 15. Maximum Negative Overshoot Waveform

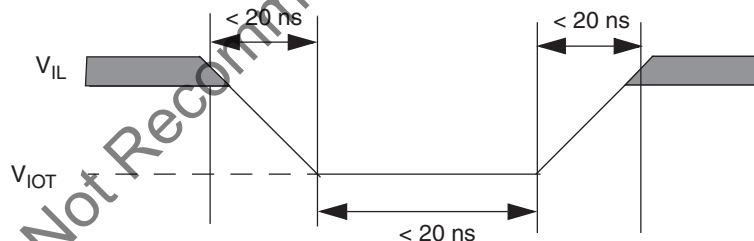
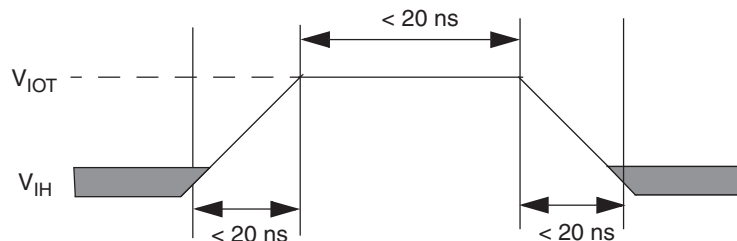


Figure 16. Maximum Positive Overshoot Waveform



## 4.1.2 Latchup Characteristics

**Table 5. Latchup Specification**

| Description                                                          | Min  | Max            | Unit |
|----------------------------------------------------------------------|------|----------------|------|
| Input voltage with respect to $V_{SS}$ on all input only connections | -1.0 | $V_{CC} + 1.0$ | V    |
| Input voltage with respect to $V_{SS}$ on all I/O connections        | -1.0 | $V_{CC} + 1.0$ | V    |
| $V_{CC}$ Current                                                     | -100 | +100           | mA   |

**Note:**

1. Excludes power supply  $V_{CC}$ . Test conditions:  $V_{CC} = 3.0V$ , one connection at a time tested, connections not being tested are at  $V_{SS}$ .

## 4.2 Thermal Resistance

**Table 6. Thermal Resistance**

| Parameter | Description                              | SOA008 | SOC008 | FAB024 | FAC024 | WS0N | Unit |
|-----------|------------------------------------------|--------|--------|--------|--------|------|------|
| Theta JA  | Thermal resistance (junction to ambient) | 75     | 75     | 39     | 39     | 18   | °C/W |

## 4.3 Operating Ranges

Operating ranges define those limits between which functionality of the device is guaranteed.

**Table 7. Operating Ranges**

| Parameter           | Symbol   | Conditions                          | Spec |      | Unit |
|---------------------|----------|-------------------------------------|------|------|------|
|                     |          |                                     | Min  | Max  |      |
| Ambient Temperature | $T_A$    | Industrial                          | -40  | +85  | °C   |
|                     |          | Industrial Plus                     | -40  | +105 |      |
| Supply Voltage      | $V_{CC}$ | Industrial and Industrial Plus Temp | 2.7  | 3.6  | V    |

**Note:**

1.  $V_{CC}$  voltage during read can operate across the min and max range but should not exceed  $\pm 10\%$  of the voltage used during programming or erase of the data being read.

## 4.4 DC Electrical Characteristics

Table 8. DC Electrical Characteristics

| Parameter                                          | Symbol    | Conditions                                     | Min                 | Typ          | Max                 |                     | Unit |
|----------------------------------------------------|-----------|------------------------------------------------|---------------------|--------------|---------------------|---------------------|------|
|                                                    |           |                                                |                     |              | -40 to 85°C         | -40 to 105°C        |      |
| Input Leakage                                      | $I_{LI}$  |                                                |                     |              | ±2                  |                     | μA   |
| I/O Leakage                                        | $I_{LO}$  |                                                |                     |              | ±2                  |                     | μA   |
| Standby Current                                    | $I_{CC1}$ | CS# = $V_{CC}$ , $V_{IN}$ = GND or $V_{CC}$    |                     | 15           | 25                  | 25                  | μA   |
| Deep Power-Down Current (S25FL116K)                | $I_{CC2}$ | CS# = $V_{CC}$ , $V_{IN}$ = GND or $V_{CC}$    |                     | 2            | 5                   | 5                   | μA   |
| Deep Power-Down Current (S25FL132K / S25FL164K)    | $I_{CC2}$ | CS# = $V_{CC}$ , $V_{IN}$ = GND or $V_{CC}$    |                     | 2            | 8                   | 10                  | μA   |
| Current: Read Single / Dual / Quad 1 MHz (4.4.1)   | $I_{CC3}$ | SCK = 0.1 $V_{CC}$ / 0.9 $V_{CC}$<br>SO = Open |                     | 4 / 5 / 6    | 6 / 7.5 / 9         | 6 / 7.5 / 9         | mA   |
| Current: Read Single / Dual / Quad 33 MHz (4.4.1)  | $I_{CC3}$ | SCK = 0.1 $V_{CC}$ / 0.9 $V_{CC}$<br>SO = Open |                     | 6 / 7 / 8    | 9 / 10.5 / 12       | 9 / 10.5 / 12       | mA   |
| Current: Read Single / Dual / Quad 50 MHz (4.4.1)  | $I_{CC3}$ | SCK = 0.1 $V_{CC}$ / 0.9 $V_{CC}$<br>SO = Open |                     | 7 / 8 / 9    | 10 / 12 / 13.5      | 10 / 12 / 13.5      | mA   |
| Current: Read Single / Dual / Quad 108 MHz (4.4.1) | $I_{CC3}$ | SCK = 0.1 $V_{CC}$ / 0.9 $V_{CC}$<br>SO = Open |                     | 12 / 14 / 16 | 18 / 22 / 25        | 18 / 22 / 25        | mA   |
| Current: Write Status Registers                    | $I_{CC4}$ | CS# = $V_{CC}$                                 |                     | 8            | 12                  | 12                  | mA   |
| Current Page Program                               | $I_{CC5}$ | CS# = $V_{CC}$                                 |                     | 20           | 25                  | 25                  | mA   |
| Current Sector / Block Erase                       | $I_{CC6}$ | CS# = $V_{CC}$                                 |                     | 20           | 25                  | 25                  | mA   |
| Current Chip Erase                                 | $I_{CC7}$ | CS# = $V_{CC}$                                 |                     | 20           | 25                  | 25                  | mA   |
| Input Low Voltage (S25FL116K)                      | $V_{IL}$  |                                                | -0.5                |              | $V_{CC} \times 0.2$ | $V_{CC} \times 0.2$ | V    |
| Input Low Voltage (S25FL132K / S25FL164K)          | $V_{IL}$  |                                                | -0.5                |              | $V_{CC} \times 0.3$ | $V_{CC} \times 0.3$ | V    |
| Input High Voltage                                 | $V_{IH}$  |                                                | $V_{CC} \times 0.7$ |              | $V_{CC} + 0.4$      | $V_{CC} + 0.4$      | V    |
| Output Low Voltage                                 | $V_{OL}$  | $I_{OL} = 100 \mu A$                           | $V_{SS}$            |              | 0.2                 | 0.2                 | V    |
|                                                    |           | $I_{OL} = 1.6 mA$                              | $V_{SS}$            |              | 0.4                 | 0.4                 | V    |
| Output High Voltage                                | $V_{OH}$  | $I_{OH} = -100 \mu A$                          | $V_{CC} - 0.2$      |              | $V_{CC}$            | $V_{CC}$            | V    |

**Notes:**

1. Tested on sample basis and specified through design and characterization data.  $T_A = 25^\circ C$ ,  $V_{CC} = 3V$ .

### 4.4.1 Active Power and Standby Power Modes

The device is enabled and in the Active Power mode when Chip Select (CS#) is Low. When CS# is high, the device is disabled, but may still be in an Active Power mode until all program, erase, and write operations have completed. The device then goes into the Standby Power mode, and power consumption drops to  $I_{SB}$ .

## 4.5 AC Measurement Conditions

Figure 17. Test Setup

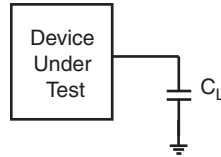


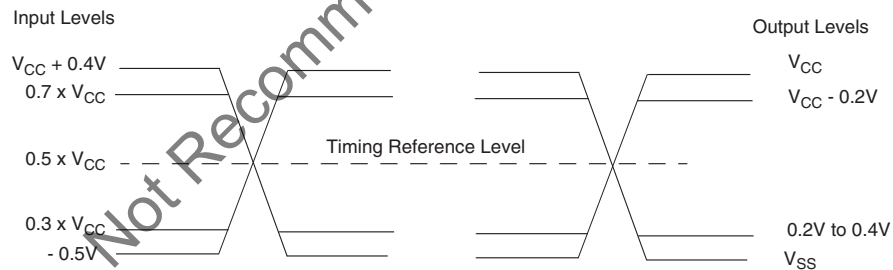
Table 9. AC Measurement Conditions

| Symbol     | Parameter                 | Min                                        | Max | Unit |
|------------|---------------------------|--------------------------------------------|-----|------|
| $C_L$      | Load Capacitance          |                                            | 30  | pF   |
| $T_R, T_F$ | Input Rise and Fall Times |                                            | 24  | ns   |
|            | Input Pulse Voltage       | $0.2 \times V_{CC}$ to $0.8 \times V_{CC}$ |     | V    |
|            | Input Timing Ref Voltage  | $0.5 V_{CC}$                               |     | V    |
|            | Output Timing Ref Voltage | $0.5 V_{CC}$                               |     | V    |

**Notes:**

1. Output High-Z is defined as the point where data is no longer driven.
2. Input slew rate: 1.5 V/ns.
3. AC characteristics tables assume clock and data signals have the same slew rate (slope).

Figure 18. Input, Output, and Timing Reference Levels



### 4.5.1 Capacitance Characteristics

Table 10. Capacitance

|           | Parameter                               | Test Conditions | Min | Max | Unit |
|-----------|-----------------------------------------|-----------------|-----|-----|------|
| $C_{IN}$  | Input Capacitance (applies to SCK, CS#) | 1 MHz           |     | 8   | pF   |
| $C_{OUT}$ | Output Capacitance (applies to All I/O) | 1 MHz           |     | 8   | pF   |

**Notes:**

1. Sampled, not 100% tested.
2. Test conditions  $T_A = 25^\circ\text{C}$ ,  $f = 1.0 \text{ MHz}$ .

## 4.6 Power-Up Timing

**Table 11. Power-Up Timing and Voltage Levels**

| Parameter                                           | Symbol       | Spec |     | Unit    |
|-----------------------------------------------------|--------------|------|-----|---------|
|                                                     |              | Min  | Max |         |
| $V_{CC}$ (min) to CS# Low                           | $t_{VSL}$    | 10   |     | $\mu s$ |
| Power-Up to Write — Time Delay Before Write Command | $t_{PUW}$    | 10   |     | ms      |
| Write Inhibit Threshold Voltage                     | $V_{WI}$     | 2.4  |     | V       |
| Power-Down Time                                     | $t_{PD}$     | 10.0 |     | $\mu s$ |
| $V_{CC}$ Power-Down Reset Threshold Voltage         | $V_{CC}$ Low | 1.0  |     | V       |

**Note:**

1. These parameters are characterized only.

**Figure 19. Power-Up Timing and Voltage Levels**

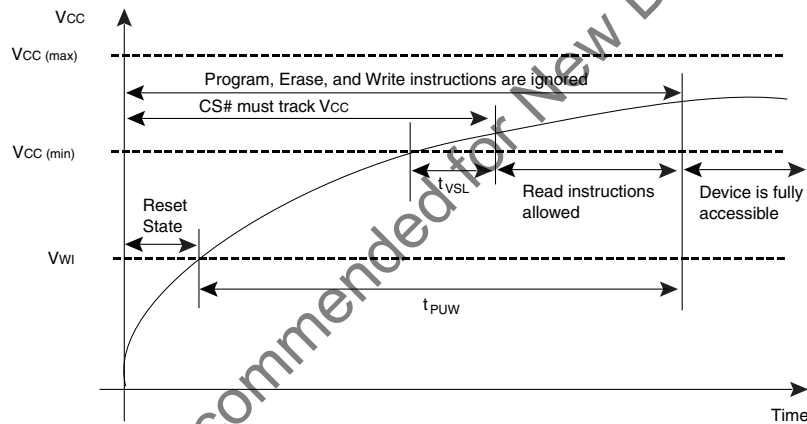
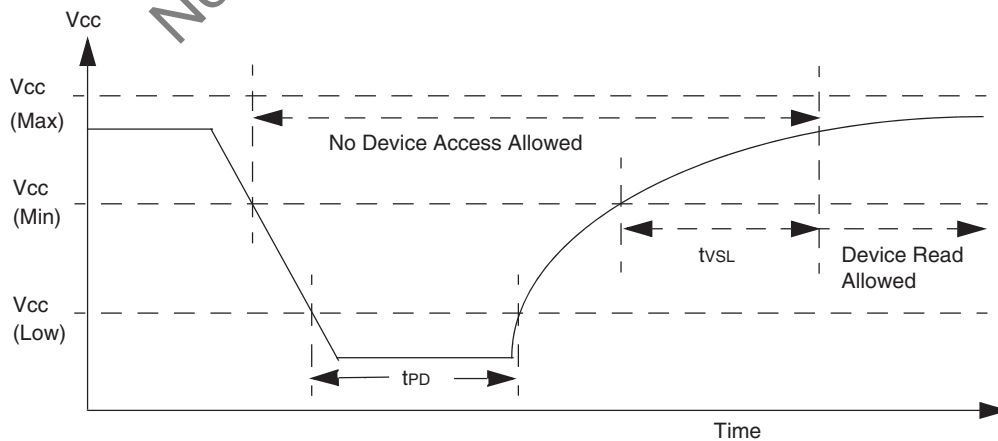


**Figure 20. Power-Down and Voltage Drop**



## 4.7 Power-On (Cold) Reset

The device executes a Power-On Reset (POR) process until a time delay of  $t_{PUW}$  has elapsed after the moment that  $V_{CC}$  rises above the  $V_{WI}$  threshold. See [Figure 19 on page 24](#), [Figure 20 on page 24](#), and [Table on page 24](#). The device must not be selected (CS# to go high with  $V_{CC}$ ) until after ( $t_{VSL}$ ), i.e. no commands may be sent to the device until the end of  $t_{VSL}$ .

## 4.8 AC Electrical Characteristics

**Table 12. AC Electrical Characteristics: -40°C to +85°C/105°C at 2.7V to 3.6V**

| Description                                                                                                                  | Symbol                   | Alt              | Spec |     |     | Unit |
|------------------------------------------------------------------------------------------------------------------------------|--------------------------|------------------|------|-----|-----|------|
|                                                                                                                              |                          |                  | Min  | Typ | Max |      |
| Clock frequency for all SPI commands except for Read Data command (03h) and Fast Read command (0Bh)<br>2.7 V - 3.6V $V_{CC}$ | $F_R$                    | $f_C$            | D.C. |     | 108 | MHz  |
| Clock frequency for Read Data command (03h)                                                                                  | $f_R$                    |                  | D.C. |     | 50  | MHz  |
| Clock frequency for all Fast Read commands SIO and MIO                                                                       | $f_{FR}$                 |                  | D.C. |     | 108 | MHz  |
| Clock Period                                                                                                                 | $P_{SCK}$                |                  | 9.25 |     |     | ns   |
| Clock High, Low Time for $f_{FR}$                                                                                            | $t_{CLH}, t_{CLL}$ (1)   | $t_{CH}, t_{CL}$ | 3.3  |     |     | ns   |
| Clock High, Low Time for $F_R$                                                                                               | $t_{CLH}, t_{CLL}$ (1)   | $t_{CH}, t_{CL}$ | 4.3  |     |     | ns   |
| Clock High, Low Time for $f_R$                                                                                               | $t_{CRLH}, t_{CRLL}$ (1) | $t_{CH}, t_{CL}$ | 6    |     |     | ns   |
| Clock Rise Time                                                                                                              | $t_{CLCH}$ (2)           | $t_{CRT}$        | 0.1  |     |     | V/ns |
| Clock Fall Time                                                                                                              | $t_{CHCL}$ (2)           | $t_{CFT}$        | 0.1  |     |     | V/ns |
| CS# Active Setup Time relative to SCK                                                                                        | $t_{SLCH}$               | $t_{CSS}$        | 5    |     |     | ns   |
| CS# Not Active Hold Time relative to SCK                                                                                     | $t_{CHSL}$               | $t_{CSH}$        | 5    |     |     | ns   |
| Data In Setup Time                                                                                                           | $t_{DVCH}$               | $t_{SU}$         | 2    |     |     | ns   |
| Data In Hold Time                                                                                                            | $t_{CHDX}$               | $t_{HD}$         | 5    |     |     | ns   |
| CS# Active Hold Time relative to SCK                                                                                         | $t_{CHSH}$               | $t_{CSS}$        | 5    |     |     | ns   |
| CS# Not Active Setup Time relative to SCK                                                                                    | $t_{SHCH}$               | $t_{CSH}$        | 5    |     |     | ns   |
| CS# High Time                                                                                                                |                          | $t_{CS}$         | 10   |     |     | ns   |
| CS# Deselect Time (for Array Read -> Array Read)                                                                             | $t_{SHSL1}$              | $t_{CS1}$        | 7    |     |     | ns   |
| CS# Deselect Time (for Erase or Program -> Read Status Registers)                                                            | $t_{SHSL2}$              | $t_{CS2}$        | 40   |     |     | ns   |
| Volatile Status Register Write Time                                                                                          |                          |                  | 40   |     |     |      |
| CS# Deselect Time (for Erase or Program -> Suspend command)                                                                  | $t_{SHSL3}$              | $t_{CS3}$        | 130  |     |     | ns   |
| Output Disable Time                                                                                                          | $t_{SHQZ}$ (2)           | $t_{DIS}$        |      |     | 7   | ns   |
| Clock Low to Output Valid, 30 pF, 2.7V - 3.6V                                                                                | $t_{CLQV1}$              | $t_{V1}$         |      |     | 7   | ns   |
| Clock Low to Output Valid, 15 pF, 2.7V - 3.6V                                                                                | $t_{CLQV1}$              | $t_{V1}$         |      |     | 6   | ns   |
| Clock Low to Output Valid (for Read ID commands) 2.7V - 3.6V                                                                 | $t_{CLQV2}$              | $t_{V2}$         |      |     | 8.5 | ns   |
| Output Hold Time                                                                                                             | $t_{CLQX}$               | $t_{HO}$         | 2    |     |     | ns   |
| HOLD# Active Setup Time relative to SCK                                                                                      | $t_{HLCH}$               |                  | 5    |     |     | ns   |
| HOLD# Active Hold Time relative to SCK                                                                                       | $t_{CHHH}$               |                  | 5    |     |     | ns   |
| HOLD# Not Active Setup Time relative to SCK                                                                                  | $t_{HHCH}$               |                  | 5    |     |     | ns   |

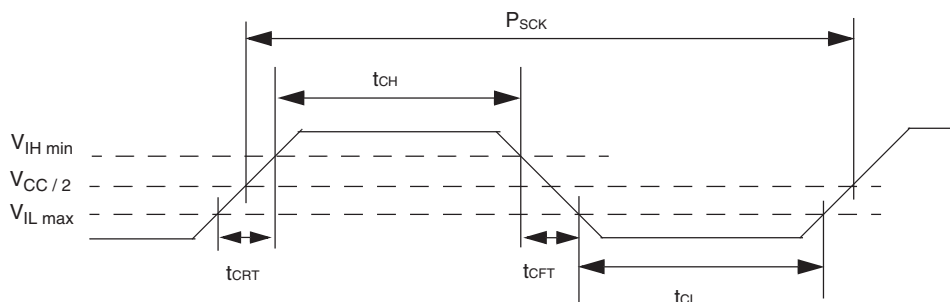
**Table 12. AC Electrical Characteristics: –40°C to +85°C/105°C at 2.7V to 3.6V (Continued)**

| Description                                                | Symbol         | Alt       | Spec |                |                | Unit |
|------------------------------------------------------------|----------------|-----------|------|----------------|----------------|------|
|                                                            |                |           | Min  | Typ            | Max            |      |
| HOLD# Not Active Hold Time relative to SCK                 | $t_{CHHL}$     |           | 5    |                |                | ns   |
| HOLD# to Output Low-Z                                      | $t_{HHQX}$ (2) | $t_{LZ}$  |      |                | 7              | ns   |
| HOLD# to Output High-Z                                     | $t_{HLQZ}$ (2) | $t_{HZ}$  |      |                | 12             | ns   |
| Write Protect Setup Time Before CS# Low                    | $t_{WHSL}$ (3) | $t_{WPS}$ | 20   |                |                | ns   |
| Write Protect Hold Time After CS# High                     | $t_{SHWL}$ (3) | $t_{WPH}$ | 100  |                |                | ns   |
| CS# High to Power-down Mode                                | $t_{DP}$ (2)   |           |      |                | 3              | μs   |
| CS# High to Standby Mode without Electronic Signature Read | $t_{RES1}$ (2) |           |      |                | 3              | μs   |
| CS# High to Standby Mode with Electronic Signature Read    | $t_{RES2}$ (2) |           |      |                | 1.8            | μs   |
| CS# High to next Command after Suspend                     | $t_{SUS}$ (2)  |           |      |                | 20             | μs   |
| Write Status Registers Time                                | $t_W$          |           |      | 2              | 30 (6)         | ms   |
| Byte Program Time (First Byte) (4)(5)                      | $t_{BP1}$      |           |      | 15             | 50             | μs   |
| Additional Byte Program Time (After First Byte) (4)(5)     | $t_{BP2}$      |           |      | 2.5            | 12             | μs   |
| Page Program Time (105°C) (5)                              | $t_{PP}$       |           |      | 0.7            | 3              | ms   |
| Sector Erase Time (4 kB) (5)                               | $t_{SE}$       |           |      | 50             | 450            | ms   |
| Block Erase Time (64 kB) (5)                               | $t_{BE2}$      |           |      | 500            | 2000           | ms   |
| Chip Erase Time 16 Mb / 32 Mb / 64 Mb (5)                  | $t_{CE}$       |           |      | 11.2 / 32 / 64 | 64 / 128 / 256 | s    |
| End of Reset Instruction to CE# High                       | $t_{ROH}$ (2)  |           | 40   |                |                | ns   |
| CE# High to next Instruction after Reset                   | $t_{RST}$ (2)  |           | 1.5  |                |                | μs   |

**Notes:**

1. Clock high + Clock low must be less than or equal to  $1/f_C$ .
2. Value guaranteed by design and / or characterization, not 100% tested in production.
3. Only applicable as a constraint for a Write Status Registers command when Status Register Protect 0 (SRP0) bit is set to 1. Or WPSEL bit = 1.
4. For multiple bytes after first byte within a page,  $t_{BPN} = t_{BP1} + t_{BP2} * N$  (typical) and  $t_{BPN} = t_{BP1} + t_{BP2} * N$  (max), where N = number of bytes programmed.
5. All program and erase times are tested using a random data pattern.
6. For 10K Cycles. 85 ms at 100K cycles.

## 4.8.1 Clock Timing

**Figure 21. Clock Timing**


## 4.8.2 Input / Output Timing

**Figure 22. SPI Single Bit Input Timing**

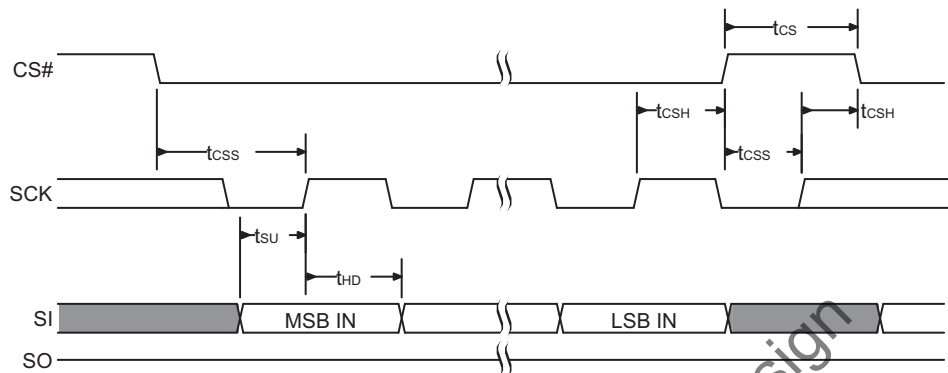


**Figure 23. SPI Single Bit Output Timing**

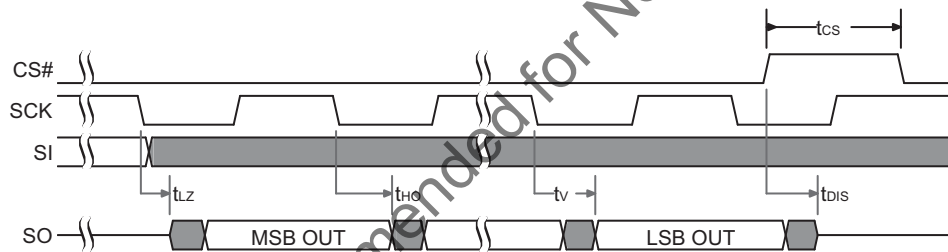


**Figure 24. SPI MIO Timing**

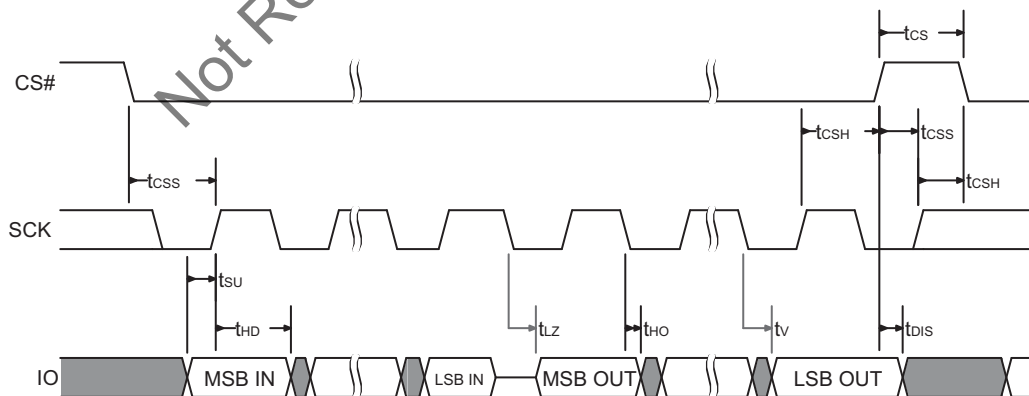
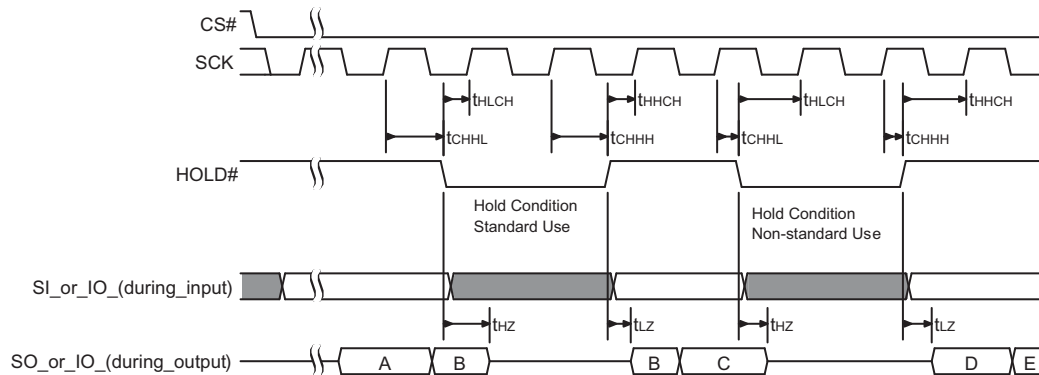
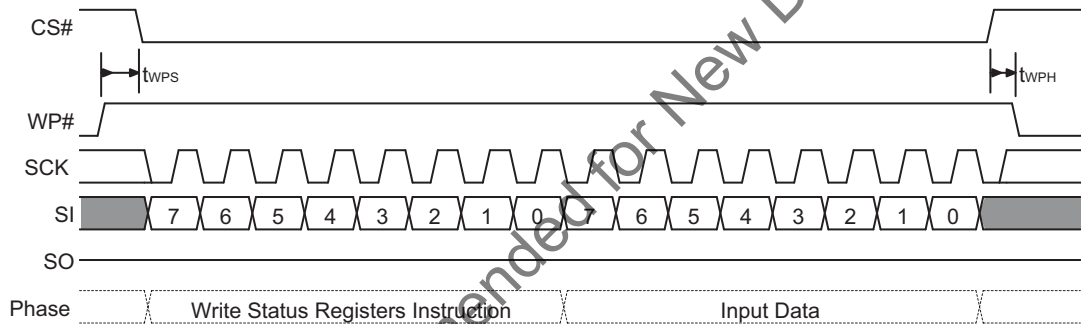
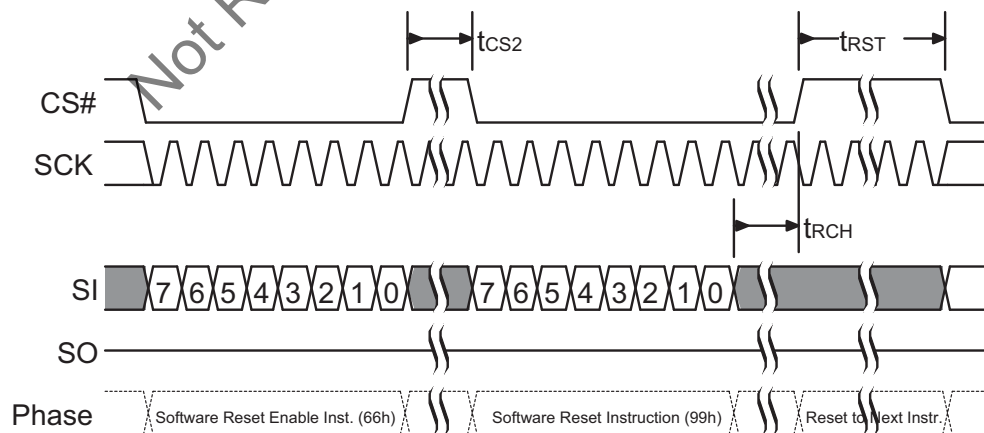


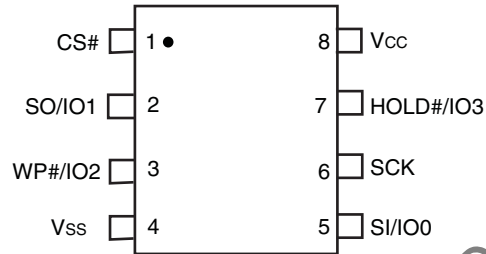
**Figure 25. Hold Timing**

**Figure 26. WP# Input Timing**

**Figure 27. Software Reset Input Timing**


## 5. Physical Interface

### 5.1 Connection Diagrams

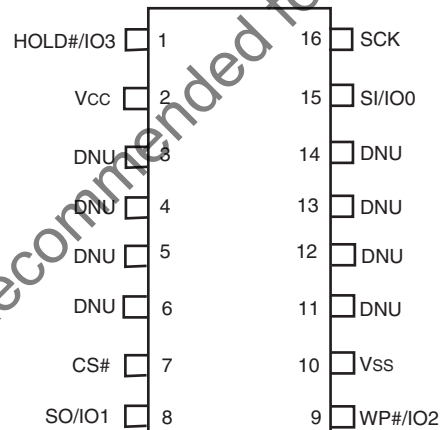
#### 5.1.1 SOIC 8

Figure 28. 8-Pin Plastic Small Outline Package (SO)



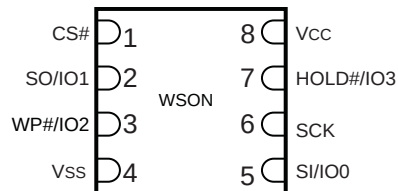
#### 5.1.2 SOIC 16 — S25FL164K

Figure 29. 16-Pin Plastic Small Outline Package (SO)



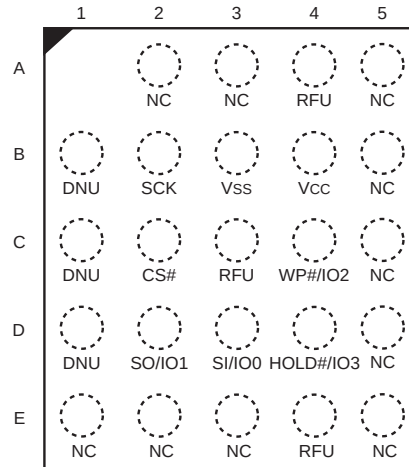
#### 5.1.3 WSON 8

Figure 30. 8-Contact WSON (5 mm x 6 mm) Package / 8-Contact USON (4 mm x 4 mm) Package



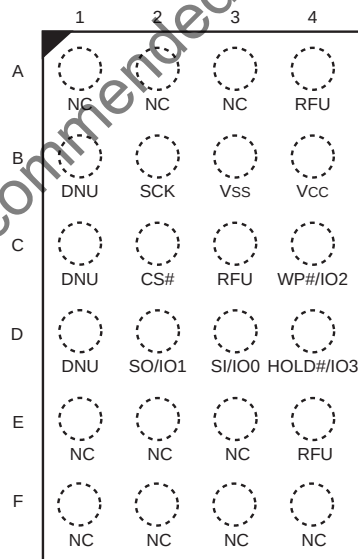
### 5.1.4 FAB024 24-Ball BGA

Figure 31. 24-Ball BGA Package, 5x5 Ball Configuration, Top View



### 5.1.5 FAC024 24-Ball BGA Package

Figure 32. 24-Ball BGA Package, 6x4 Ball Configuration, Top View



**Note:**

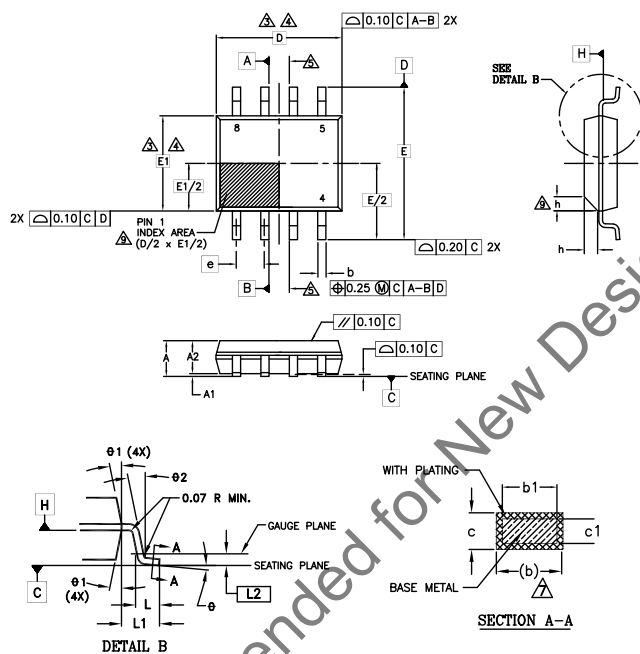
1. Signal connections are in the same relative positions as FAB024 BGA, allowing a single PCB footprint to use either package.

### 5.1.6 Special Handling Instructions for FBGA Packages

Flash memory devices in BGA packages may be damaged if exposed to ultrasonic cleaning methods. The package and / or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

## 5.2 Physical Diagrams

### 5.2.1 SOA008 — 8-Lead Plastic Small Outline Package (150-mils Body Width)



| SYMBOL | DIMENSIONS |      |      |
|--------|------------|------|------|
|        | MIN.       | NOM. | MAX. |
| A      | -          | -    | 1.75 |
| A1     | 0.10       | -    | 0.25 |
| A2     | 1.32       | -    | -    |
| b      | 0.31       | -    | 0.51 |
| b1     | 0.25       | -    | 0.48 |
| c      | 0.17       | -    | 0.25 |
| c1     | 0.17       | -    | 0.23 |
| D      | 4.90 BSC   |      |      |
| E      | 6.00 BSC   |      |      |
| E1     | 3.90 BSC   |      |      |
| e      | 1.27 BSC   |      |      |
| L      | 0.40       | -    | 0.89 |
| L1     | 1.04 REF   |      |      |
| L2     | 0.25 BSC   |      |      |
| N      | 8          |      |      |
| h      | 0.25       | -    | 0.50 |
| θ      | 0°         | -    | 8°   |
| θ 1    | 5°         | -    | 15°  |
| θ 2    | 0° REF     |      |      |

#### NOTES:

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M - 1994.
- DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 mm PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUSIVE OF ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DATUMS A AND B TO BE DETERMINED AT DATUM H.
- "N" IS THE MAXIMUM NUMBER OF TERMINAL POSITIONS FOR THE SPECIFIED PACKAGE LENGTH.
- THE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 mm FROM THE LEAD TIP.
- DIMENSION "b" DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.10 mm TOTAL IN EXCESS OF THE "b" DIMENSION AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE LEAD FOOT.
- THIS CHAMFER FEATURE IS OPTIONAL. IF IT IS NOT PRESENT, THEN A PIN 1 IDENTIFIER MUST BE LOCATED WITHIN THE INDEX AREA INDICATED.
- LEAD COPLANARITY SHALL BE WITHIN 0.10 mm AS MEASURED FROM THE SEATING PLANE.

THIS DRAWING CONTAINS INFORMATION WHICH IS THE PROPRIETARY PROPERTY OF CYPRESS SEMICONDUCTOR CORPORATION. THIS DRAWING IS RECEIVED IN CONFIDENCE AND ITS CONTENTS MAY NOT BE DISCLOSED WITHOUT WRITTEN CONSENT OF CYPRESS SEMICONDUCTOR CORPORATION.

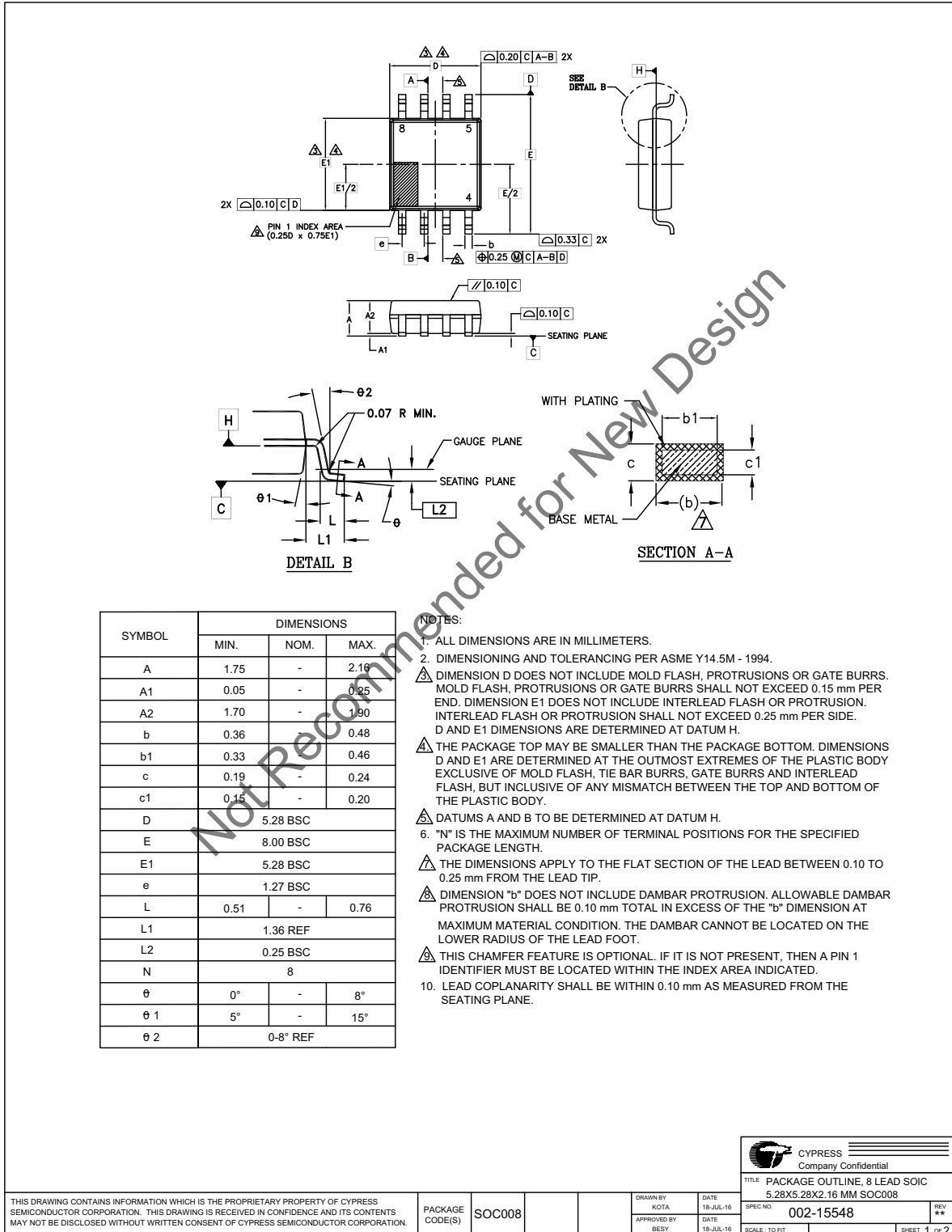
PACKAGE CODE(S) SOA008

DRAWN BY KOTA  
APPROVED BY LKSH

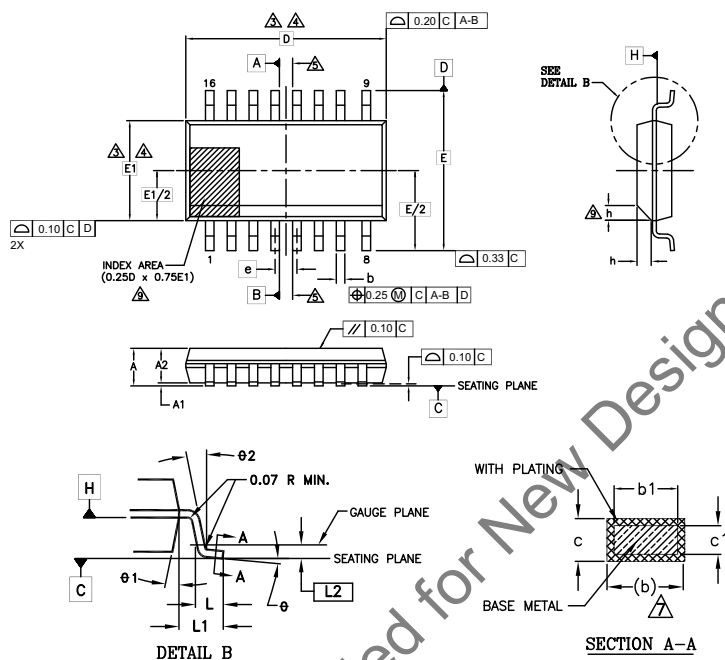
DATE 13-FEB-17  
DATE 13-FEB-17

|                                                                                                                              |              |
|------------------------------------------------------------------------------------------------------------------------------|--------------|
|  <b>CYPRESS</b><br>Company Confidential |              |
| TITLE PACKAGE OUTLINE, 8 LEAD SOIC<br>4.90X3.90X1.75 MM SOA008                                                               |              |
| SPEC NO. 002-18754                                                                                                           | REV **       |
| SCALE: TO FIT                                                                                                                | SHEET 1 OF 2 |

## 5.2.2 SOC008 — 8-Lead Plastic Small Outline Package (208-mils Body Width)

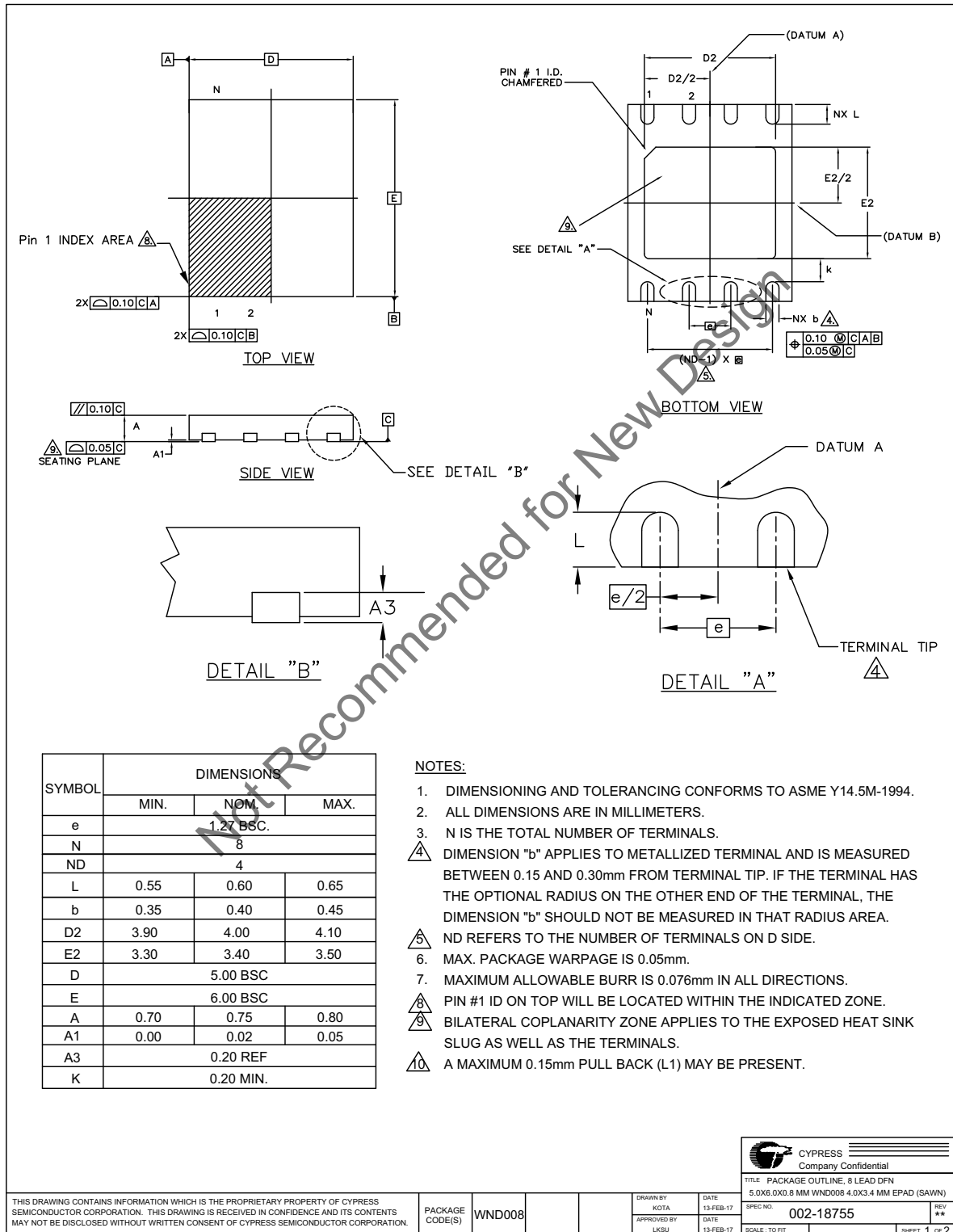


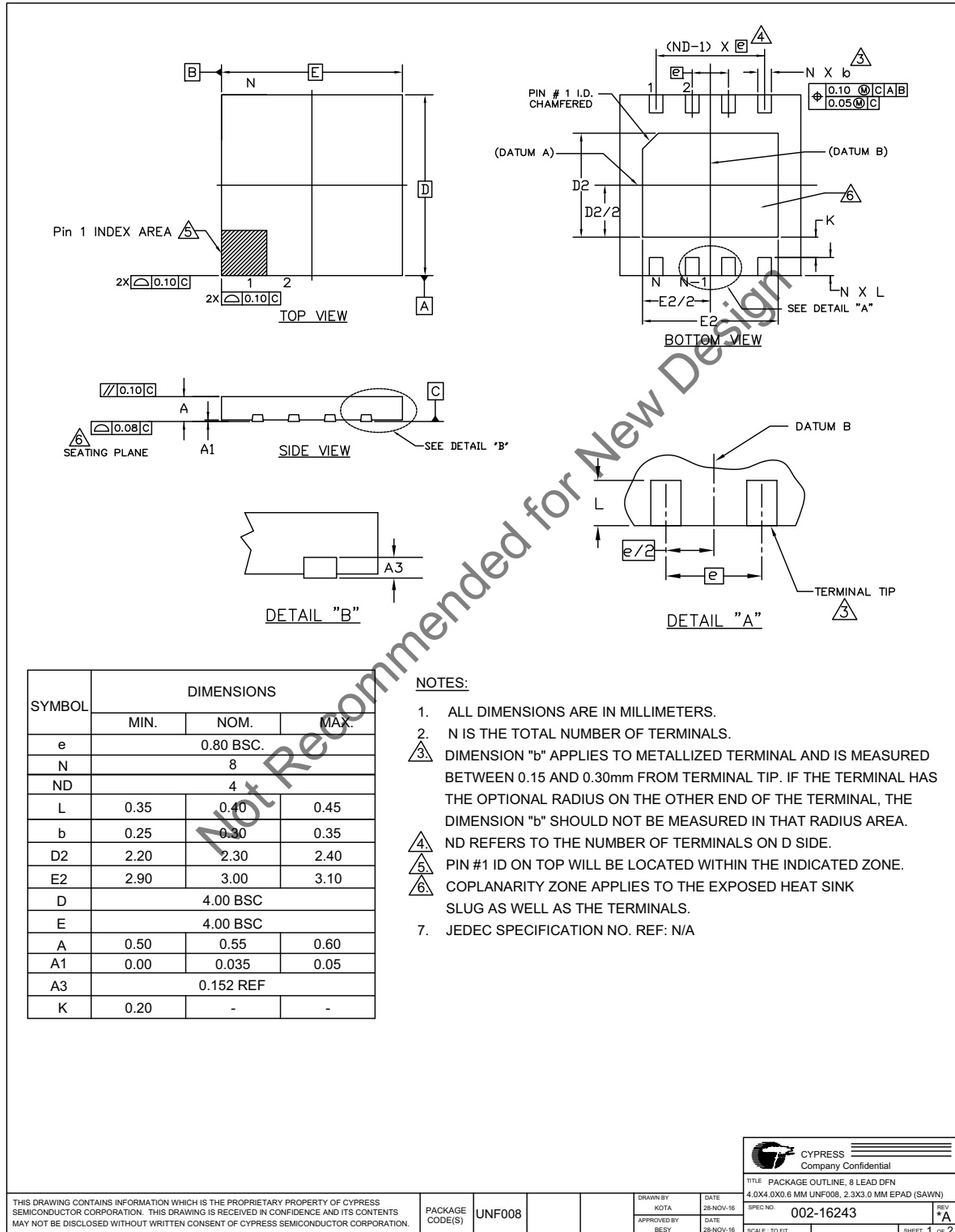
### 5.2.3 SO3016 — 16-Lead Plastic Wide Outline Package (300-mils Body Width)



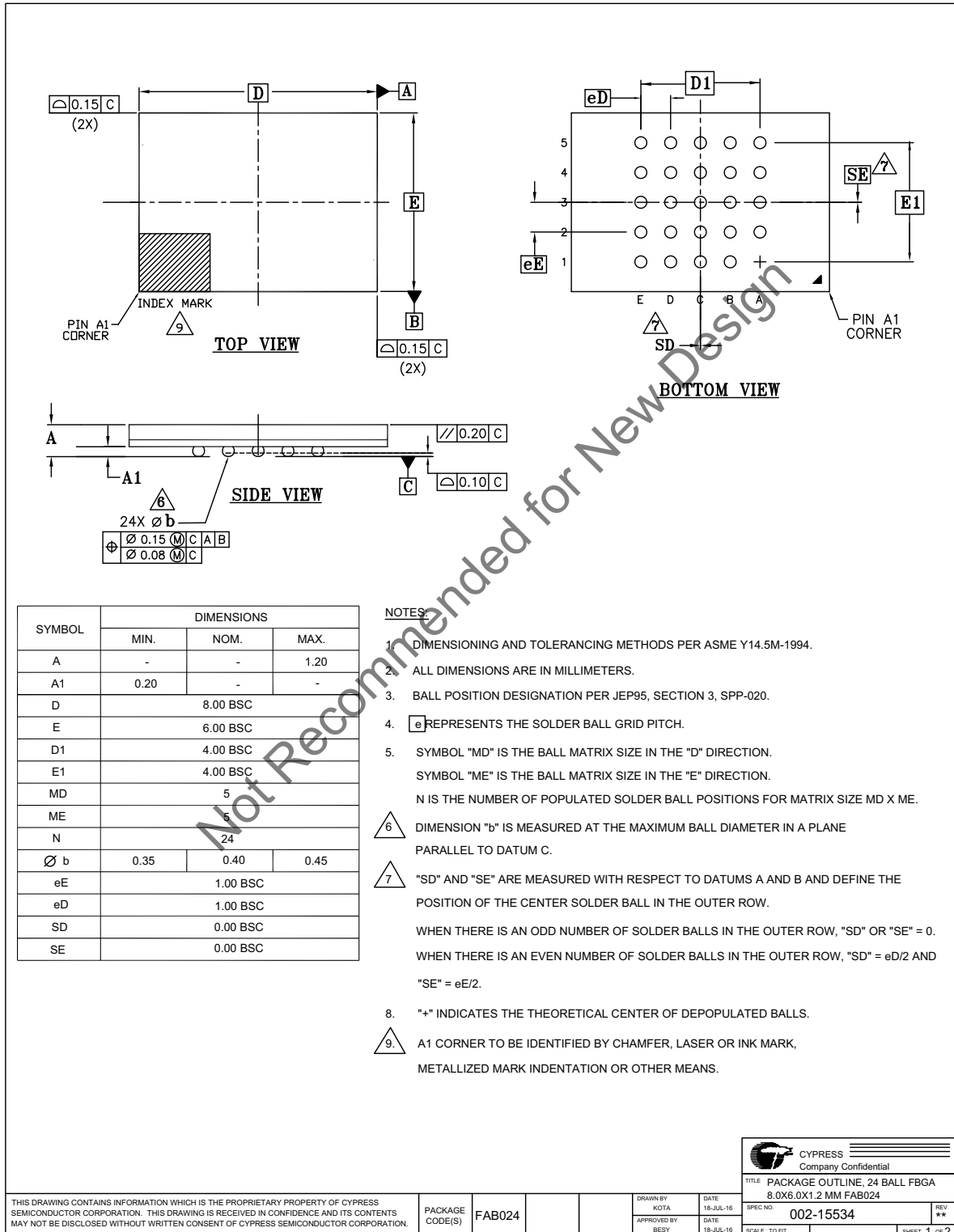
| SYMBOL | DIMENSIONS |      |      |
|--------|------------|------|------|
|        | MIN.       | NOM. | MAX. |
| A      | 2.35       | -    | 2.65 |
| A1     | 0.10       | -    | 0.30 |
| A2     | 2.05       | -    | 2.55 |
| b      | 0.31       | -    | 0.51 |
| b1     | 0.27       | -    | 0.48 |
| c      | 0.20       | -    | 0.33 |
| c1     | 0.20       | -    | 0.30 |
| D      | 10.30 BSC  |      |      |
| E      | 10.30 BSC  |      |      |
| E1     | 7.50 BSC   |      |      |
| e      | 1.27 BSC   |      |      |
| L      | 0.40       | -    | 1.27 |
| L1     | 1.40 REF   |      |      |
| L2     | 0.25 BSC   |      |      |
| N      | 16         |      |      |
| h      | 0.25       | -    | 0.75 |
| θ      | 0°         | -    | 8°   |
| θ 1    | 5°         | -    | 15°  |
| θ 2    | 0°         | -    | -    |

- NOTES:**
- ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M - 1994.
1. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 mm PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.
3. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUSIVE OF ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
4. DATUMS A AND B TO BE DETERMINED AT DATUM H.
6. "N" IS THE MAXIMUM NUMBER OF TERMINAL POSITIONS FOR THE SPECIFIED PACKAGE LENGTH.
7. THE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 mm FROM THE LEAD TIP.
8. DIMENSION "b" DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.10 mm TOTAL IN EXCESS OF THE "b" DIMENSION AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE LEAD FOOT.
9. THIS CHAMFER FEATURE IS OPTIONAL. IF IT IS NOT PRESENT, THEN A PIN 1 IDENTIFIER MUST BE LOCATED WITHIN THE INDEX AREA INDICATED.
10. LEAD COPLANARITY SHALL BE WITHIN 0.10 mm AS MEASURED FROM THE SEATING PLANE

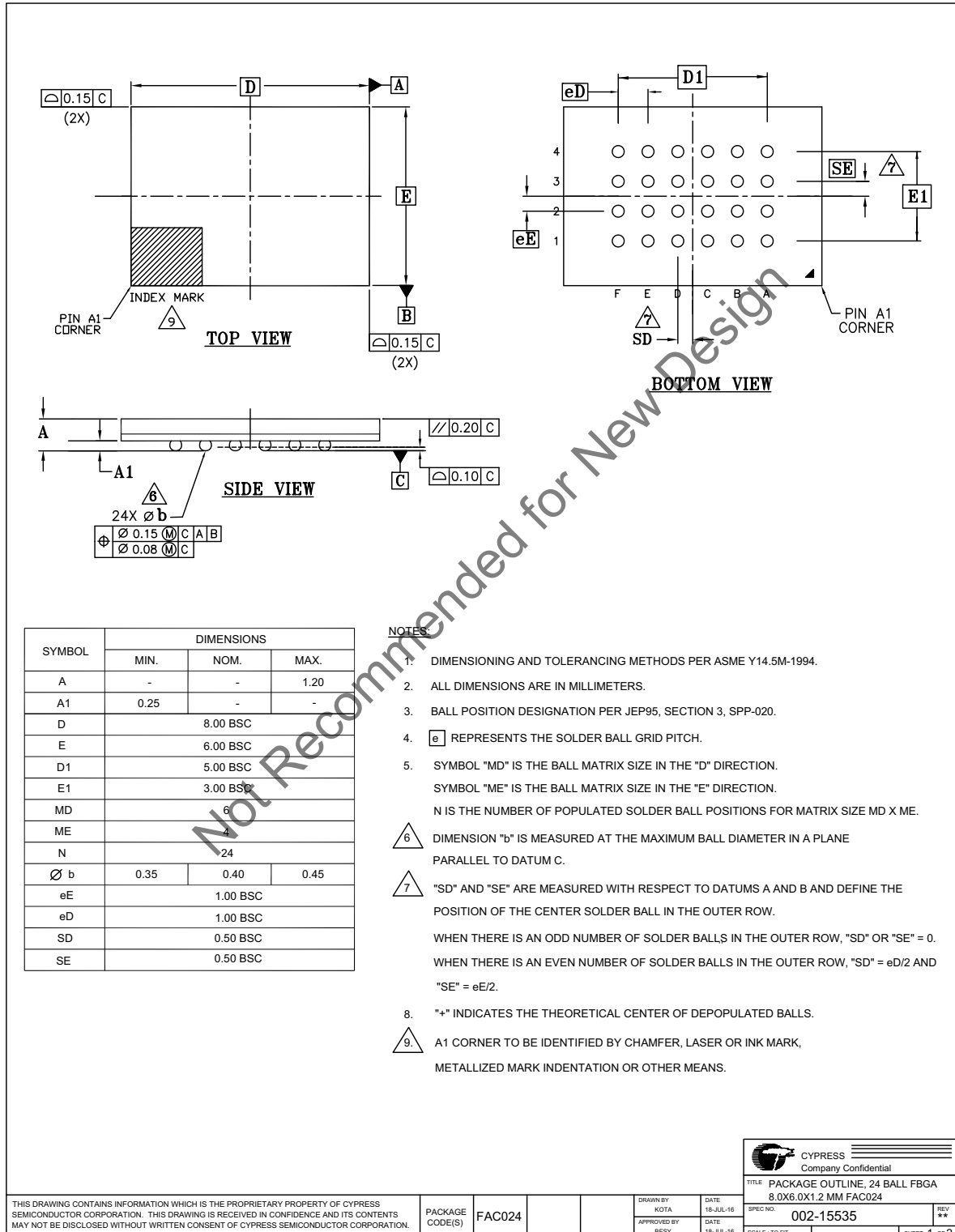
**5.2.4 WND008 — 8-Contact WSON 5 mm × 6 mm**


**5.2.5 UNF008 — 8-Contact USON 4 mm x 4 mm**


## 5.2.6 FAB024 — 24-Ball Ball Grid Array (8 mm × 6 mm) Package



## 5.2.7 FAC024 — 24-Ball Ball Grid Array (8 mm × 6 mm) Package



## Software Interface

This section discusses the features and behaviors most relevant to host system software that interacts with S25FL1-K memory devices.

## 6. Address Space Maps

### 6.1 Overview

Many commands operate on the main flash memory array. Some commands operate on address spaces separate from the main flash array. Each separate address space uses the full 24-bit address but may only define a small portion of the available address space.

### 6.2 Flash Memory Array

The main flash array is divided into erase units called sectors. The sectors are uniform 4 kbytes in size.

**Table 13. S25FL116K Main Memory Address Map**

| Sector Size (kbyte) | Sector Count | Sector Range | Address Range (Byte Address) | Notes                   |
|---------------------|--------------|--------------|------------------------------|-------------------------|
| 4                   | 512          | SA0          | 000000h-000FFFh              | Sector Starting Address |
|                     |              | :            | :                            | —                       |
|                     |              | SA511        | 1FF000h-1FFFFFFh             | Sector Ending Address   |

**Table 14. S25FL132K Main Memory Address Map**

| Sector Size (kbyte) | Sector Count | Sector Range | Address Range (Byte Address) | Notes                   |
|---------------------|--------------|--------------|------------------------------|-------------------------|
| 4                   | 1024         | SA0          | 000000h-000FFFh              | Sector Starting Address |
|                     |              | :            | :                            | —                       |
|                     |              | SA1023       | 3FF000h-3FFFFFFh             | Sector Ending Address   |

**Table 15. S25FL164K Main Memory Address Map**

| Sector Size (kbyte) | Sector Count | Sector Range | Address Range (Byte Address) | Notes                   |
|---------------------|--------------|--------------|------------------------------|-------------------------|
| 4                   | 2048         | SA0          | 000000h-000FFFh              | Sector Starting Address |
|                     |              | :            | :                            | —                       |
|                     |              | SA2047       | 7FF000h-7FFFFFFh             | Sector Ending Address   |

**Note:** These are condensed tables that use a couple of sectors as references. There are address ranges that are not explicitly listed. All 4-kB sectors have the pattern XXX000h-XXXFFFh.

## 6.3 Security Registers

The S25FL1-K provides four 256-byte Security Registers. Each register can be used to store information that can be permanently protected by programming One Time Programmable (OTP) lock bits in Status Register-2.

Register 0 is used by Cypress to store and protect the Serial Flash Discoverable Parameters (SFDP) information that is also accessed by the Read SFDP command. See [Section 6.4](#).

The three additional Security Registers can be erased, programmed, and protected individually. These registers may be used by system manufacturers to store and permanently protect security or other important information separate from the main memory array.

**Table 16. Security Register Addresses**

| Security Register | Address          |
|-------------------|------------------|
| 0 (SFDP)          | 000000h - 0000FF |
| 1                 | 001000h - 0010FF |
| 2                 | 002000h - 0020FF |
| 3                 | 003000h - 0030FF |

## 6.4 Security Register 0 — Serial Flash Discoverable Parameters (SFDP — JEDEC JESD216B)

This document defines the Serial Flash Discoverable Parameters (SFDP) revision B data structure for S25FL1-K family.

These data structure values are an update to the earlier revision SFDP data structure in the S25FL1-K family devices.

The Read SFDP (RSFDP) command (5Ah) reads information from a separate flash memory address space for device identification, feature, and configuration information, in accord with the JEDEC JESD216B standard for Serial Flash Discoverable Parameters.

The SFDP data structure consists of a header table that identifies the revision of the JESD216 header format that is supported and provides a revision number and pointer for each of the SFDP parameter tables that are provided. The parameter tables follow the SFDP header. However, the parameter tables may be placed in any physical location and order within the SFDP address space. The tables are not necessarily adjacent nor in the same order as their header table entries.

The SFDP header points to the following parameter tables:

- Basic Flash
  - This is the original SFDP table. It has a few modified fields and new additional field added at the end of the table.
- Sector Map
  - This is the original SFDP table. It has a few modified fields and new additional field added at the end of the table.

The physical order of the tables in the SFDP address space is: SFDP Header, Cypress Vendor Specific, Basic Flash, and Sector Map.

The SFDP address space is programmed by Cypress and read-only for the host system.

### 6.4.1 Serial Flash Discoverable Parameters (SFDP) Address Map

The SFDP address space has a header starting at address zero that identifies the SFDP data structure and provides a pointer to each parameter. One Basic Flash parameter is mandated by the JEDEC JESD216B standard.

**Table 17. SFDP Overview Map — Security Register 0**

| Byte Address   | Description                                                           |
|----------------|-----------------------------------------------------------------------|
| 0000h          | Location zero within JEDEC JESD216B SFDP space – start of SFDP header |
| ...            | Remainder of SFDP header followed by undefined space                  |
| 0080h          | Start of SFDP parameter                                               |
| ...            | Remainder of SFDP JEDEC parameter followed by undefined space         |
| 00BFh          | End of SFDP space                                                     |
| 00C0h to 00F7h | Reserved space                                                        |
| 00F8h to 00FFh | Unique Id                                                             |

### 6.4.2 SFDP Header Field Definitions

**Table 18. SFDP Header**

| SFDP Byte Address | SFDP Dword Name       | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-------------------|-----------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 00h               | SFDP Header 1st DWORD | 53h  | This is the entry point for Read SFDP (5Ah) command i.e. location zero within SFDP space<br>ASCII "S"                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 01h               |                       | 46h  | ASCII "F"                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 02h               |                       | 44h  | ASCII "D"                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 03h               |                       | 50h  | ASCII "P"                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 04h               | SFDP Header 2nd DWORD | 06h  | SFDP Minor Revision (06h = JEDEC JESD216 Revision B)<br>– This revision is backward compatible with all prior minor revisions. Minor revisions are changes that define previously reserved fields, add fields to the end, or that clarify definitions of existing fields. Increments of the minor revision value indicate that previously reserved parameter fields may have been assigned a new definition or entire Dwords may have been added to the parameter table. However, the definition of previously existing fields is unchanged and therefore remain backward compatible with earlier SFDP parameter table revisions. Software can safely ignore increments of the minor revision number, as long as only those parameters the software was designed to support are used i.e. previously reserved fields and additional Dwords must be masked or ignored. Do not do a simple compare on the minor revision number, looking only for a match with the revision number that the software is designed to handle. There is no problem with using a higher number minor revision. |
| 05h               |                       | 01h  | SFDP Major Revision<br>– This is the original major revision. This major revision is compatible with all SFDP reading and parsing software.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 06h               |                       | 03h  | Number of Parameter Headers (zero based, 03h = 4 parameters)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 07h               |                       | FFh  | Unused                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

**Table 18. SFDP Header (Continued)**

| SFDP Byte Address | SFDP Dword Name                 | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------------|---------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 08h               | Parameter Header 0<br>1st DWORD | 00h  | Parameter ID LSB (00h = JEDEC SFDP Basic SPI Flash Parameter)                                                                                                                                                                                                                                                                                                                                                           |
| 09h               |                                 | 00h  | Parameter Minor Revision (00h = JESD216)<br>– This older revision parameter header is provided for any legacy SFDP reading and parsing software that requires seeing a minor revision 0 parameter header. SFDP software designed to handle later minor revisions should continue reading parameter headers looking for a higher numbered minor revision that contains additional parameters for that software revision. |
| 0Ah               |                                 | 01h  | Parameter Major Revision (01h = The original major revision - all SFDP software is compatible with this major revision.                                                                                                                                                                                                                                                                                                 |
| 0Bh               |                                 | 09h  | Parameter Table Length (in double words = Dwords = 4-byte units) 09h = 9 Dwords                                                                                                                                                                                                                                                                                                                                         |
| 0Ch               | Parameter Header 0<br>2nd DWORD | 80h  | Parameter Table Pointer Byte 0 (Dword = 4-byte aligned)<br>JEDEC Basic SPI Flash parameter byte offset = 80h                                                                                                                                                                                                                                                                                                            |
| 0Dh               |                                 | 00h  | Parameter Table Pointer Byte 1                                                                                                                                                                                                                                                                                                                                                                                          |
| 0Eh               |                                 | 00h  | Parameter Table Pointer Byte 2                                                                                                                                                                                                                                                                                                                                                                                          |
| 0Fh               |                                 | FFh  | Parameter ID MSB (FFh = JEDEC defined legacy Parameter ID)                                                                                                                                                                                                                                                                                                                                                              |
| 10h               | Parameter Header 1<br>1st DWORD | EFh  | Parameter ID LSB (EFh = Winbond Legacy SPI Flash Parameter)                                                                                                                                                                                                                                                                                                                                                             |
| 11h               |                                 | 00h  | Parameter Minor Revision (00h = JESD216)<br>– This older revision parameter header is provided for any legacy SFDP reading and parsing software that requires seeing a minor revision 0 parameter header. SFDP software designed to handle later minor revisions should continue reading parameter headers looking for a later minor revision that contains additional parameters.                                      |
| 12h               |                                 | 01h  | Parameter Major Revision (01h = The original major revision – all SFDP software is compatible with this major revision.                                                                                                                                                                                                                                                                                                 |
| 13h               |                                 | 04h  | Parameter Table Length (in double words = Dwords = 4-byte units) 04h = 4 Dwords                                                                                                                                                                                                                                                                                                                                         |
| 14h               | Parameter Header 1<br>2nd DWORD | 80h  | Parameter Table Pointer Byte 0 (Dword = 4-byte aligned)<br>JEDEC Basic SPI Flash parameter byte offset = 0080h address                                                                                                                                                                                                                                                                                                  |
| 15h               |                                 | 00h  | Parameter Table Pointer Byte 1                                                                                                                                                                                                                                                                                                                                                                                          |
| 16h               |                                 | 00h  | Parameter Table Pointer Byte 2                                                                                                                                                                                                                                                                                                                                                                                          |
| 17h               |                                 | FFh  | Parameter ID MSB (FFh = JEDEC defined Parameter)                                                                                                                                                                                                                                                                                                                                                                        |
| 18h               | Parameter Header 2<br>1st DWORD | 00h  | Parameter ID LSB (00h = JEDEC SFDP Basic SPI Flash Parameter)                                                                                                                                                                                                                                                                                                                                                           |
| 19h               |                                 | 06h  | Parameter Minor Revision (06h = JESD216 Revision B)                                                                                                                                                                                                                                                                                                                                                                     |
| 1Ah               |                                 | 01h  | Parameter Major Revision (01h = The original major revision - all SFDP software is compatible with this major revision.                                                                                                                                                                                                                                                                                                 |
| 1Bh               |                                 | 10h  | Parameter Table Length (in double words = Dwords = 4-byte units) 10h = 16 Dwords                                                                                                                                                                                                                                                                                                                                        |
| 1Ch               | Parameter Header 2<br>2nd DWORD | 80h  | Parameter Table Pointer Byte 0 (Dword = 4-byte aligned)<br>JEDEC Basic SPI Flash parameter byte offset = 0080h address                                                                                                                                                                                                                                                                                                  |
| 1Dh               |                                 | 00h  | Parameter Table Pointer Byte 1                                                                                                                                                                                                                                                                                                                                                                                          |
| 1Eh               |                                 | 00h  | Parameter Table Pointer Byte 2                                                                                                                                                                                                                                                                                                                                                                                          |
| 1Fh               |                                 | FFh  | Parameter ID MSB (FFh = JEDEC defined Parameter)                                                                                                                                                                                                                                                                                                                                                                        |

**Table 18. SFDP Header (Continued)**

| SFDP Byte Address | SFDP Dword Name                    | Data | Description                                                                                                                                                 |
|-------------------|------------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 20h               | Parameter Header<br>3<br>1st DWORD | 01h  | Parameter ID LSB (Cypress Vendor Specific ID parameter)<br>Legacy Manufacturer ID 01h = AMD / Cypress                                                       |
| 21h               |                                    | 01h  | Parameter Minor Revision (01h = ID updated with SFDP Rev B table)                                                                                           |
| 22h               |                                    | 01h  | Parameter Major Revision (01h = The original major revision - all SFDP software that recognizes this parameter's ID is compatible with this major revision. |
| 23h               |                                    | 00h  | Parameter Table Length (in double words = Dwords = 4-byte units) 00h not implemented                                                                        |
| 24h               | Parameter Header<br>3<br>2nd DWORD | 00h  | Parameter Table Pointer Byte 0 (Dword = 4-byte aligned)                                                                                                     |
| 25h               |                                    | 00h  | Parameter Table Pointer Byte 1                                                                                                                              |
| 26h               |                                    | 00h  | Parameter Table Pointer Byte 2                                                                                                                              |
| 27h               |                                    | 01h  | Parameter ID MSB (01h = JEDEC JEP106 Bank Number 1)                                                                                                         |

### 6.4.3 JEDEC SFDP Basic SPI Flash Parameter

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                     | Data                             | Description                                                                                                                                                                                                                                                                                                                                                                             |
|--------------------------------------|-------------------------------------|----------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 00h                                  | JEDEC Basic Flash Parameter Dword-1 | E5h                              | Start of SFDP JEDEC parameter<br>Bits 7:5 = unused = 111b<br>Bit 4:3 = 05h is volatile status register write instruction and status register is default non-volatile= 00b<br>Bit 2 = Program Buffer > 64 bytes = 1<br>Bits 1:0 = Uniform 4-kB erase is supported through out the device = 01b                                                                                           |
| 01h                                  |                                     | 20h                              | Bits 15:8 = Uniform 4-kB erase instruction = 20h                                                                                                                                                                                                                                                                                                                                        |
| 02h                                  |                                     | F1h                              | Bit 23 = Unused = 1b<br>Bit 22 = Supports QOR Read (1-1-4), Yes = 1b<br>Bit 21 = Supports QIO Read (1-4-4), Yes = 1b<br>Bit 20 = Supports DIO Read (1-2-2), Yes = 1b<br>Bit 19 = Supports DDR, No = 0 b<br>Bit 18:17 = Number of Address Bytes 3 only = 00b<br>Bit 16 = Supports SIO and DIO Yes = 1b<br><br>Binary Field: 1-1-1-1-0-00-1<br>Nibble Format: 1111_0001<br>Hex Format: F1 |
| 03h                                  |                                     | FFh                              | Bits 31:24 = Unused = FFh                                                                                                                                                                                                                                                                                                                                                               |
| 04h                                  | JEDEC Basic Flash Parameter Dword-2 | FFh                              | Density in bits, zero based,<br>16 Mb = 00FFFFFFh<br>32 Mb = 01FFFFFFh<br>64 Mb = 03FFFFFFh                                                                                                                                                                                                                                                                                             |
| 05h                                  |                                     | FFh                              |                                                                                                                                                                                                                                                                                                                                                                                         |
| 06h                                  |                                     | FFh                              |                                                                                                                                                                                                                                                                                                                                                                                         |
| 07h                                  |                                     | 00h 16Mb<br>01h 32Mb<br>03h 64Mb |                                                                                                                                                                                                                                                                                                                                                                                         |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                     | Data | Description                                                                                                                                    |
|--------------------------------------|-------------------------------------|------|------------------------------------------------------------------------------------------------------------------------------------------------|
| 08h                                  | JEDEC Basic Flash Parameter Dword-3 | 44h  | Bits 7:5 = number of QIO (1-4-4) Mode cycles = 010b<br>Bits 4:0 = number of Fast Read QIO Dummy cycles = 00100b for default latency code       |
| 09h                                  |                                     | EBh  | Fast Read QIO (1-4-4) instruction code                                                                                                         |
| 0Ah                                  |                                     | 08h  | Bits 23:21 = number of Quad Out (1-1-4) Mode cycles = 000b<br>Bits 20:16 = number of Quad Out Dummy cycles = 01000b for default latency code   |
| 0Bh                                  |                                     | 6Bh  | Quad Out (1-1-4) instruction code                                                                                                              |
| 0Ch                                  | JEDEC Basic Flash Parameter Dword-4 | 08h  | Bits 7:5 = number of Dual Out (1-1-2) Mode cycles = 000b<br>Bits 4:0 = number of Dual Out Dummy cycles = 01000b for default latency code       |
| 0Dh                                  |                                     | 3Bh  | Dual Out (1-1-2) instruction code                                                                                                              |
| 0Eh                                  |                                     | 80h  | Bits 23:21 = number of Dual I/O Mode cycles = 100b<br>Bits 20:16 = number of Dual I/O Dummy cycles = 00000b for default latency code           |
| 0Fh                                  |                                     | BBh  | Dual I/O instruction code                                                                                                                      |
| 10h                                  | JEDEC Basic Flash Parameter Dword-5 | EEh  | Bits 7:5 RFU = 111b<br>Bit 4 = QPI (4-4-4) fast read commands not supported = 0b<br>Bits 3:1 RFU = 111b<br>Bit 0 = Dual All not supported = 0b |
| 11h                                  |                                     | FFh  | Bits 15:8 = RFU = FFh                                                                                                                          |
| 12h                                  |                                     | FFh  | Bits 23:16 = RFU = FFh                                                                                                                         |
| 13h                                  |                                     | FFh  | Bits 31:24 = RFU = FFh                                                                                                                         |
| 14h                                  | JEDEC Basic Flash Parameter Dword-6 | FFh  | Bits 7:0 = RFU = FFh                                                                                                                           |
| 15h                                  |                                     | FFh  | Bits 15:8 = RFU = FFh                                                                                                                          |
| 16h                                  |                                     | FFh  | Bits 23:21 = number of Dual All Mode cycles = 111b<br>Bits 20:16 = number of Dual All Dummy cycles = 11111b                                    |
| 17h                                  |                                     | FFh  | Dual All instruction code                                                                                                                      |
| 18h                                  | JEDEC Basic Flash Parameter Dword-7 | FFh  | Bits 7:0 = RFU = FFh                                                                                                                           |
| 19h                                  |                                     | FFh  | Bits 15:8 = RFU = FFh                                                                                                                          |
| 1Ah                                  |                                     | FFh  | Bits 23:21 = number of QPI Mode cycles = 111b not supported<br>Bits 20:16 = number of QPI Dummy cycles = 11111b for default latency code       |
| 1Bh                                  |                                     | FFh  | QPI instruction code "Not supported FF"                                                                                                        |
| 1Ch                                  | JEDEC Basic Flash Parameter Dword-8 | 0Ch  | Sector type 1 size 2 <sup>N</sup> Bytes = 4 kB = 0Ch (for Uniform 4 kB)                                                                        |
| 1Dh                                  |                                     | 20h  | Sector type 1 instruction                                                                                                                      |
| 1Eh                                  |                                     | 10h  | Sector type 2 size 2 <sup>N</sup> Bytes = 64 kB = 0Fh (for Uniform 64 kB)                                                                      |
| 1Fh                                  |                                     | D8h  | Sector type 2 instruction                                                                                                                      |
| 20h                                  | JEDEC Basic Flash Parameter Dword-9 | 00h  | Sector type 3 size 2 <sup>N</sup> Bytes = not supported = 00h                                                                                  |
| 21h                                  |                                     | FFh  | Sector type 3 instruction = not supported = FFh                                                                                                |
| 22h                                  |                                     | 00h  | Sector type 4 size 2 <sup>N</sup> Bytes = not supported = 00h                                                                                  |
| 23h                                  |                                     | FFh  | Sector type 4 instruction = not supported = FFh                                                                                                |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                      | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|--------------------------------------|--------------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 24h                                  | JEDEC Basic Flash Parameter Dword-10 | 42h  | <p>Bits 31:30 = Sector Type 4 Erase, Typical time units (00b: 1 ms, 01b: 16 ms, 10b: 128 ms, 11b: 1 s) = RFU = 11b<br/>           Bits 29:25 = Sector Type 4 Erase, Typical time count = RFU = 11111b (typ erase time = (count + 1) * units) = RFU = 11111<br/>           Bits 24:23 = Sector Type 3 Erase, Typical time units (00b: 1 ms, 01b: 16 ms, 10b: 128 ms, 11b: 1 s) = RFU = 11b<br/>           Bits 22:18 = Sector Type 3 Erase, Typical time count = 00100b (typ erase time = (count + 1) * units) = RFU = 11111<br/>           Bits 17:16 = Sector Type 2 Erase, Typical time units (00b: 1 ms, 01b: 16 ms, 10b: 128 ms, 11b: 1 s) = 16 ms = 01b<br/>           Bits 15:11 = Sector Type 2 Erase, Typical time count = 11110b (typ erase time = (count + 1) * units) = 31*16 ms = 496 ms<br/>           Bits 10:9 = Sector Type 1 Erase, Typical time units (00b: 1 ms, 01b: 16 ms, 10b: 128 ms, 11b: 1 s) = 16ms = 01b<br/>           Bits 8:4 = Sector Type 1 Erase, Typical time count = 00100b (typ erase time = (count + 1) * units) = 5*16 ms = 80 ms<br/>           Bits 3:0 = Count = (Max Erase time / (2 * Typical Erase time))- 1 = 0010b<br/>           Multiplier from typical erase time to maximum erase time = 6x multiplier<br/>           Max Erase time = 2*(Count + 1)*Typ Erase time</p> <p>Binary Fields: 11-11111-11-11111-01-11110-01-00100-0010<br/>           Nibble Format: 1111_1111_1111_1101_1111_0010_0100_0010<br/>           Hex Format: FF_FD_F2_42</p> |
| 25h                                  |                                      | F2h  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 26h                                  |                                      | FDh  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 27h                                  |                                      | FFh  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                      | Data                             | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|--------------------------------------|--------------------------------------|----------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 28h                                  | JEDEC Basic Flash Parameter Dword-11 | 81h                              | Bits 23 = Byte Program Typical time, additional byte units (0b:1 $\mu$ s, 1b:8 $\mu$ s) = 1 $\mu$ s = 0b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 29h                                  |                                      | 6Ah                              | Bits 22:19 = Byte Program Typical time, additional byte count, (count+1)*units, count = 0010b, (typ Program time = (count + 1) * units) = 3*1 $\mu$ s = 3 $\mu$ s                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 2Ah                                  |                                      | 14h                              | Bits 18 = Byte Program Typical time, first byte units (0b:1 $\mu$ s, 1b:8 $\mu$ s) = 8 $\mu$ s = 1b<br>Bits 17:14 = Byte Program Typical time, first byte count, (count+1)*units, count = 0001b, (typ Program time = (count + 1) * units) = 2*8 $\mu$ s = 16 $\mu$ s<br>Bits 13 = Page Program Typical time units (0b:8 $\mu$ s, 1b:64 $\mu$ s) = 64 $\mu$ s = 1b<br>Bits 12:8 = Page Program Typical time count, (count+1)*units, count = 01010b, (typ Program time = (count + 1) * units) = 11*64 $\mu$ s = 704 $\mu$ s<br>Bits 7:4 = N = 1000b, Page size = $2^N$ = 256B page<br>Bits 3:0 = Count = 0001b = (Max Page Program time / (2 * Typ Page Program time)) - 1<br>Multiplier from typical Page Program time to maximum Page Program time = 4x multiplier<br>Max Page Program time = 2*(Count + 1)*Typ Page Program time<br><br>Binary Fields: 0_0010-1-0001-1-01010-1000-0001<br>Nibble Format: 0001_0100_0110_1010_1000_0001<br>Hex Format: 14_6A_81 |
| 2Bh                                  |                                      | C2h 16Mb<br>C7h 32Mb<br>CFh 64Mb | 16 Mb = 1100_0010b = C2h<br>Bit 31 Reserved = 1b<br>Bits 30:29 = Chip Erase, Typical time units (00b: 16 ms, 01b: 256 ms, 10b: 4 s, 11b: 64 s) = 4s = 10b<br>Bits 28:24 = Chip Erase, Typical time count, (count+1)*units, count = 00010b, (typ Program time = (count + 1) * units) = 3*4s = 12S<br><br>32 Mb = 1100_0111b = C7h<br>Bit 31 Reserved = 1b<br>Bits 30:29 = Chip Erase, Typical time units (00b: 16 ms, 01b: 256 ms, 10b: 4 s, 11b: 64 s) = 4s = 10b<br>Bits 28:24 = Chip Erase, Typical time count, (count+1)*units, count = 00111b, (typ Program time = (count + 1) * units) = 8*4s = 32s<br><br>64 Mb = 1100_1111b = CFh<br>Bit 31 Reserved = 1b<br>Bits 30:29 = Chip Erase, Typical time units (00b: 16 ms, 01b: 256 ms, 10b: 4 s, 11b: 64 s) = 4s = 10b<br>Bits 28:24 = Chip Erase, Typical time count, (count+1)*units, count = 01111b, (typ Program time = (count + 1) * units) = 16*4S = 64S                                               |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                      | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|--------------------------------------|--------------------------------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2Ch                                  | JEDEC Basic Flash Parameter Dword-12 | CCh  | Bit 31 = Suspend and Resume supported = 0b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 2Dh                                  |                                      | 63h  | Bits 30:29 = Suspend in-progress erase max latency units (00b: 128ns, 01b: 1us, 10b: 8 μs, 11b: 64 μs) = 1 μs = 01b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| 2Eh                                  |                                      | 16h  | Bits 28:24 = Suspend in-progress erase max latency count = 10011b, max erase suspend latency = (count + 1) * units = 20 * 1 μs = 20 μs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 2Fh                                  |                                      | 33h  | Bits 23:20 = Erase resume to suspend interval count = 0001b, interval = (count + 1) * 64 μs = 2 * 64 μs = 128 μs<br>Bits 19:18 = Suspend in-progress program max latency units (00b: 128ns, 01b: 1us, 10b: 8 μs, 11b: 64 μs) = 1 μs = 01b<br>Bits 17:13 = Suspend in-progress program max latency count = 10011b, max erase suspend latency = (count + 1) * units = 20 * 1 μs = 20 μs<br>Bits 12:9 = Program resume to suspend interval count = 0001b, interval = (count + 1) * 64 μs = 2 * 64 μs = 128 μs<br>Bit 8 = RFU = 1b<br>Bits 7:4 = Prohibited operations during erase suspend<br>= xxx0b: May not initiate a new erase anywhere (erase nesting not permitted)<br>+ xx0xb: May not initiate a page program anywhere<br>+ x1xxb: May not initiate a read in the erase suspended sector size<br>+ 1xxb: The erase and program restrictions in bits 5:4 are sufficient = 1100b<br>Bits 3:0 = Prohibited Operations During Program Suspend<br>= xxx0b: May not initiate a new erase anywhere (erase nesting not permitted)<br>+ xx0xb: May not initiate a new page program anywhere (program nesting not permitted)<br>+ x1xxb: May not initiate a read in the program suspended page size<br>+ 1xxb: The erase and program restrictions in bits 1:0 are sufficient = 1100b<br><br>Binary Fields: 0-01-10011-0001-01-10011-0001-1-1100-1100<br>Nibble Format: 0011_0011_0001_0110_0110_0011_1100_1100<br>Hex Format: 33_16_63_CC |
| 30h                                  | JEDEC Basic Flash Parameter Dword-13 | 7Ah  | Bits 31:24 = Erase Suspend Instruction = 75h                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 31h                                  |                                      | 75h  | Bits 23:16 = Erase Resume Instruction = 7Ah                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 32h                                  |                                      | 7Ah  | Bits 15:8 = Program Suspend Instruction = 75h                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 33h                                  |                                      | 75h  | Bits 7:0 = Program Resume Instruction = 7Ah                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                      | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|--------------------------------------|--------------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 34h                                  | JEDEC Basic Flash Parameter Dword-14 | F7h  | Bit 31 = Deep Power-Down Supported = 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 35h                                  |                                      | A2h  | Bits 30:23 = Enter Deep Power-Down Instruction = B9h                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 36h                                  |                                      | D5h  | Bits 22:15 = Exit Deep Power-Down Instruction = ABh                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 37h                                  |                                      | 5Ch  | Bits 14:13 = Exit Deep Power-Down to next operation delay units = (00b: 128 ns, 01b: 1 $\mu$ s, 10b: 8 $\mu$ s, 11b: 64 $\mu$ s) = 1 $\mu$ s = 01b<br>Bits 12:8 = Exit Deep Power-Down to next operation delay count = 00010b, Exit Deep Power-Down to next operation delay = (count+1)*units = 3*1 $\mu$ s=3 $\mu$ s<br>Bits 7:4 = RFU = 1111b<br>Bit 3:2 = Status Register Polling Device Busy = 01b: Legacy status polling supported = Use legacy polling by reading the Status Register with 05h instruction and checking WIP bit[0] (0=ready; 1=busy).<br>Bits 1:0 = RFU = 11b<br><br>Binary Fields: 0-10111001-10101011-01-00010-1111-01-11<br>Nibble Format: 0101_1100_1101_0101_1010_0010_1111_0111<br>Hex Format: 5C_D5_A2_F7                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 38h                                  | JEDEC Basic Flash Parameter Dword-15 | 00h  | Bits 31:24 = RFU = FFh                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 39h                                  |                                      | F6h  | Bit 23 = Hold and WP Disable = not supported = 0b                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 3Ah                                  |                                      | 59h  | Bits 22:20 = Quad Enable Requirements = 101b: QE is bit 1 of the status register 2. Status register 1 is read using Read Status instruction 05h. Status register 2 is read using instruction 35h. QE is set via Write Status instruction 01h with two data bytes where bit 1 of the second byte is one. It is cleared via Write Status with two data bytes where bit 1 of the second byte is zero.<br>Bits 19:16 0-4-4 Mode Entry Method = xxx1b: Mode Bits[7:0] = A5h Note: QE must be set prior to using this mode<br>+ x0xxb: Mode Bits[7:0] = Axh<br>+ 1xxxb: RFU<br>= 1001b<br>Bits 15:10 0-4-4 Mode Exit Method = xx_1xxb: Mode Bits[7:0] = 00h will terminate this mode at the end of the current read operation<br>+ xx_1xxb: Input Fh (mode bit reset) on DQ0-DQ3 for 8 clocks. This will terminate the mode prior to the next read operation.<br>+ 11_x1xx: RFU<br>= 111101<br>Bit 9 = 0-4-4 mode supported = 1<br>Bits 8:4 = 4-4-4 mode enable sequences = 0_0000b: not supported<br>Bits 3:0 = 4-4-4 mode disable sequences = 0000b: not supported<br><br>Binary Fields: 11111111-0-101-1001-111101-1-00000-0000<br>Nibble Format: 1111_1111_0101_1001_1111_0110_0000_0000<br>Hex Format: FF_59_F6_00 |
| 3Bh                                  |                                      | FFh  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

**Table 19. Basic SPI Flash Parameter, JEDEC SFDP Rev B (Continued)**

| SFDP Parameter Relative Byte Address | SFDP Dword Name                      | Data | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|--------------------------------------|--------------------------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3Ch                                  | JEDEC Basic Flash Parameter Dword-16 | E8h  | Bits 31:24 = Enter 4-Byte Addressing                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 3Dh                                  |                                      | 10h  | = xxxx_xxx1b: issue instruction B7 (preceding write enable not required)<br>+ xx1x_xxxx: Supports dedicated 4-byte address instruction set.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 3Eh                                  |                                      | C0h  | Consult vendor data sheet for the instruction set definition or look for 4-byte Address Parameter Table.<br>+ 1xxx_xxxx: Reserved<br>= 10000000b not supported                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 3Fh                                  |                                      | 80h  | Bits 23:14 = Exit 4-byte Addressing<br>= xx_xxxx_xxx1b: issue instruction E9h to exit 4-byte address mode (Write enable instruction 06h is not required)<br>+ xx_xx1x_xxxx: Hardware reset<br>+ xx_x1xx_xxxx: Software reset (see bits 13:8 in this DWORD)<br>+ xx_1xxx_xxxx: Power cycle<br>+ x1_xxxx_xxxx: Reserved<br>+ 1x_xxxx_xxxx: Reserved<br>= 11_0000_0000b not supported<br>Bits 13:8 = Soft Reset and Rescue Sequence Support<br>= x1_xxxx: issue reset enable instruction 66h, then issue reset instruction 99h. The reset enable, reset sequence may be issued on 1,2, or 4 wires depending on the device operating mode<br>= 01_0000b<br>Bit 7 = RFU = 1<br>Bits 6:0 = Volatile or Non-Volatile Register and Write Enable Instruction for Status Register 1<br>= xxx_1xxx: Non-Volatile/Volatile status register 1 powers-up to last written value in the non-volatile status register, use instruction 06h to enable write to non-volatile status register. Volatile status register may be activated after power-up to override the non-volatile status register, use instruction 50h to enable write and activate the volatile status register.<br>+ x1x_xxxx: Reserved<br>+ 1xx_xxxx: Reserved<br>= 1101000b<br><br>Binary Fields: 10000000-1100000000-010000-1-1101000<br>Nibble Format: 1000_0000_1100_0000_0001_0000_1110_1000<br>Hex Format: 80_C0_10_E8 |

## 6.5 Status Registers

Status Register-1 (SR1) and Status Register-2 (SR2) can be used to provide status on the availability of the flash memory array, if the device is write enabled or disabled, the state of write protection, Quad SPI setting, Security Register lock status, and Erase / Program Suspend status.

SR1 and SR2 contain non-volatile bits in locations SR1[7:2] and SR2[6:0] that control sector protection, OTP Register Protection, Status Register Protection, and Quad mode. Bit locations SR2[7], SR1[1], and SR1[0] are read only volatile bits for suspend, write enable, and busy status; these are updated by the memory control logic. The SR1[1] write enable bit is set only by the Write Enable (06h) command and cleared by the memory control logic when an embedded operation is completed.

Write access to the non-volatile Status Register bits is controlled by the state of the non-volatile Status Register Protect bits SR1[7] and SR2[0] (SRP0, SRP1), the Write Enable command (06h) preceding a Write Status Registers command, and while Quad mode is not enabled, the WP# pin.

A volatile version of bits SR2[6], SR2[1], and SR1[7:2] that control sector protection and Quad Mode are used to control the behavior of these features after power up. During power up or software reset, these volatile bits are loaded from the non-volatile version of the Status Register bits. The Write Enable for Volatile Status Register (50h) command can be used to write these volatile bits when the command is followed by a Write Status Registers (01h) command. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits.

Write access to the volatile SR1 and SR2 Status Register bits is controlled by the state of the non-volatile Status Register Protect bits SR1[7] and SR2[0] (SRP0, SRP1), the Write Enable for Volatile Status Register command (50h) preceding a Write Status Registers command, and while Quad mode is not enabled, the WP# pin.

Status Register-3 (SR3) is used to configure and provide status on the variable read latency, and Quad IO wrapped read features.

Write access to the volatile SR3 Status Register bits is controlled by Write Enable for Volatile Status Register command (50h) preceding a Write Status Register command. The SRP bits do not protect SR3.

**Table 20. Status Register-1 (SR1)**

| Bits | Field Name | Function                  | Type                               | Default State       | Description                                                                                                                                                                               |
|------|------------|---------------------------|------------------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7    | SRP0       | Status Register Protect 0 | Non-volatile and Volatile versions | 0                   | 0 = WP# input has no effect or Power Supply Lock Down mode<br>1 = WP# input can protect the Status Register or OTP Lock Down<br>See <a href="#">Table 29 on page 56</a> .                 |
| 6    | SEC        | Sector / Block Protect    |                                    | 0                   | 0 = BP2-BP0 protect 64-kB blocks<br>1 = BP2-BP0 protect 4-kB sectors<br>See <a href="#">Table 25 on page 53</a> and <a href="#">Table 26 on page 54</a> for protection ranges.            |
| 5    | TB         | Top / Bottom Protect      |                                    | 0                   | 0 = BP2-BP0 protect from the Top down<br>1 = BP2-BP0 protect from the Bottom up<br>See <a href="#">Table 25 on page 53</a> and <a href="#">Table 26 on page 54</a> for protection ranges. |
| 4    | BP2        | Block Protect Bits        |                                    | 0                   | 000b = No protection<br>See <a href="#">Table 25 on page 53</a> and <a href="#">Table 26 on page 54</a> for protection ranges.                                                            |
| 3    | BP1        |                           |                                    | 0                   |                                                                                                                                                                                           |
| 2    | BP0        |                           |                                    | 0                   |                                                                                                                                                                                           |
| 1    | WEL        | Write Enable Latch        |                                    | Volatile, Read only | 0                                                                                                                                                                                         |
| 0    | BUSY       | Embedded Operation Status | Volatile, Read only                | 0                   | 0 = Not Busy, no embedded operation in progress<br>1 = Busy, embedded operation in progress                                                                                               |

**Table 21. Status Register-2 (SR2)**

| Bits | Field Name | Function                    | Type                               | Default State                            | Description                                                                                                                                                                                                                                     |
|------|------------|-----------------------------|------------------------------------|------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7    | SUS        | Suspend Status              | Volatile, Read Only                | 0                                        | 0 = Erase / Program not suspended<br>1 = Erase / Program suspended                                                                                                                                                                              |
| 6    | CMP        | Complement Protect          | Non-volatile and Volatile versions | 0                                        | 0 = Normal Protection Map<br>1 = Inverted Protection Map<br>See <a href="#">Table 25 on page 53</a> and <a href="#">Table 26 on page 54</a> for protection ranges.                                                                              |
| 5    | LB3        | Security Register Lock Bits | OTP                                | 0                                        | OTP Lock Bits 3:0 for Security Registers 3:0<br>0 = Security Register not protected<br>1 = Security Register protected<br>Security register 0 contains the Serial Flash Discoverable Parameters and is always programmed and locked by Cypress. |
| 4    | LB2        |                             |                                    | 0                                        |                                                                                                                                                                                                                                                 |
| 3    | LB1        |                             |                                    | 0                                        |                                                                                                                                                                                                                                                 |
| 2    | LB0        |                             |                                    | 1                                        |                                                                                                                                                                                                                                                 |
| 1    | QE         | Quad Enable                 | Non-volatile and Volatile versions | 0<br>(For all model numbers except 'Q1') | 0 = Quad Mode Not Enabled, the WP# pin and HOLD# are enabled<br>1 = Quad Mode Enabled, the IO2 and IO3 pins are enabled, and WP# and HOLD# functions are disabled                                                                               |
|      |            |                             |                                    | 1<br>(For model number 'Q1')             | 1 = Quad Mode Enabled and <b>can not</b> be changed, the IO2 and IO3 pins are enabled, and WP# and HOLD# functions are disabled                                                                                                                 |
| 0    | SRP1       | Status Register Protect 1   |                                    | 0                                        | 0 = SRP1 selects whether WP# input has effect on protection of the status register<br>1 = SRP1 selects Power Supply Lock Down or OTP Lock Down mode<br>See <a href="#">Table 29 on page 56</a> .                                                |

**Note:**

1. LB0 value should be considered don't care for read. This bit is set to 1.

**Table 22. Status Register-3 (SR3)**

| Bits | Field Name           | Function                      | Type     | Default State | Description                                                                                                                                                                                                                                                                                                                                                                                                                                |
|------|----------------------|-------------------------------|----------|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7    | RFU                  | Reserved                      |          | 0             | Reserved for Future Use                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 6    | W6                   | Burst Wrap Length             | Volatile | 1             | 00 = 8-byte wrap. Data read starts at the initial address and wraps within an aligned 8-byte boundary.<br>01 = 16-byte wrap. Data read starts at the initial address and wraps within an aligned 16-byte boundary.<br>10 = 32-byte wrap. Data read starts at the initial address and wraps within an aligned 32-byte boundary.<br>11 = 64-byte wrap. Data read starts at the initial address and wraps within an aligned 64-byte boundary. |
| 5    | W5                   |                               |          | 1             |                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 4    | W4                   | Burst Wrap Enable             |          | 1             | 0 = Wrap Enabled<br>1 = Wrap Disabled                                                                                                                                                                                                                                                                                                                                                                                                      |
| 3    | Latency Control (LC) | Variable Read Latency Control |          | 0             | Defines the number of read latency cycles in Fast Read, Dual Out, Quad Out, Dual IO, and Quad IO commands. Binary values for 1 to 15 latency cycles. A value of zero disables the variable latency mode.                                                                                                                                                                                                                                   |
| 2    |                      |                               |          | 0             |                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 1    |                      |                               |          | 0             |                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 0    |                      |                               |          | 0             |                                                                                                                                                                                                                                                                                                                                                                                                                                            |

### 6.5.1 BUSY

BUSY is a read only bit in the Status Register (SR1[0]) that is set to a 1 state when the device is executing a Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Registers or Erase / Program Security Register command. During this time the device will ignore further commands except for the Software Reset, Read Status Register and Erase / Program Suspend commands (see  $t_W$ ,  $t_{PP}$ ,  $t_{SE}$ ,  $t_{BE}$ , and  $t_{CE}$  in [Section 4.8, AC Electrical Characteristics on page 25](#)). When the program, erase or write status / security register command has completed, the BUSY bit will be cleared to a 0 state indicating the device is ready for further commands.

### 6.5.2 Write Enable Latch (WEL)

Write Enable Latch (WEL) is a read only bit in the Status Register (SR1[1]) that is set to 1 after executing a Write Enable Command. The WEL status bit is cleared to 0 when the device is write disabled. A write disable state occurs upon power-up or after any of the following commands: Write Disable, Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Registers, Erase Security Register and Program Security Register. The WEL status bit is cleared to 0 even when a program or erase operation is prevented by the block protection bits. The WEL status bit is also cleared to 0 when a program or erase operation is suspended. The WEL status bit is set to 1 when a program or erase operation is resumed.

### 6.5.3 Block Protect Bits (BP2, BP1, BP0)

The Block Protect Bits (BP2, BP1, BP0) are non-volatile read / write bits in the Status Register (SR1[4:2]) that provide Write Protection control and status. Block Protect bits can be set using the Write Status Registers Command (see  $t_W$  in [Section 4.8, AC Electrical Characteristics on page 25](#)). All, none or a portion of the memory array can be protected from Program and Erase commands (see [Section 6.5.7, Block Protection Maps on page 52](#)). The factory default setting for the Block Protection Bits is 0 (none of the array is protected.)

### 6.5.4 Top / Bottom Block Protect (TB)

The non-volatile Top / Bottom bit (TB SR1[5]) controls if the Block Protect Bits (BP2, BP1, BP0) protect from the Top (TB=0) or the Bottom (TB=1) of the array as shown in [Section 6.5.7, Block Protection Maps on page 52](#). The factory default setting is TB=0. The TB bit can be set with the Write Status Registers Command depending on the state of the SRP0, SRP1 and WEL bits.

### 6.5.5 Sector / Block Protect (SEC)

The non-volatile Sector / Block Protect bit (SEC SR1[6]) controls if the Block Protect Bits (BP2, BP1, BP0) protect either 4-kB Sectors (SEC=1) or 64-kB Blocks (SEC=0) in the Top (TB=0) or the Bottom (TB=1) of the array as shown in [Section 6.5.7, Block Protection Maps on page 52](#). The default setting is SEC=0.

### 6.5.6 Complement Protect (CMP)

The Complement Protect bit (CMP SR2[6]) is a non-volatile read / write bit in the Status Register (SR2[6]). It is used in conjunction with SEC, TB, BP2, BP1 and BP0 bits to provide more flexibility for the array protection. Once CMP is set to 1, previous array protection set by SEC, TB, BP2, BP1 and BP0 will be reversed. For instance, when CMP=0, a top 4-kB sector can be protected while the rest of the array is not; when CMP=1, the top 4-kB sector will become unprotected while the rest of the array become read-only. Refer to [Section 6.5.7, Block Protection Maps on page 52](#) for details. The default setting is CMP=0.

## 6.5.7 Block Protection Maps

**Table 23. FL116K Block Protection (CMP = 0)**

| Status Register (1) |    |     |     |     | S25FL1-K (16 Mbit) Block Protection (CMP=0) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|-------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                              | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | None                                            | None                | None              | None              |
| 0                   | 0  | 0   | 0   | 1   | 31                                              | 1F0000h – 1FFFFFFh  | 64 kB             | Upper 1/32        |
| 0                   | 0  | 0   | 1   | 0   | 30 and 31                                       | 1E0000h – 1FFFFFFh  | 128 kB            | Upper 1/16        |
| 0                   | 0  | 0   | 1   | 1   | 28 thru 31                                      | 1C0000h – 1FFFFFFh  | 256 kB            | Upper 1/8         |
| 0                   | 0  | 1   | 0   | 0   | 24 thru 31                                      | 180000h – 1FFFFFFh  | 512 kB            | Upper 1/4         |
| 0                   | 0  | 1   | 0   | 1   | 16 thru 31                                      | 100000h – 1FFFFFFh  | 1 MB              | Upper 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 0                                               | 000000h – 00FFFFh   | 64 kB             | Lower 1/32        |
| 0                   | 1  | 0   | 1   | 0   | 0 and 1                                         | 000000h – 01FFFFh   | 128 kB            | Lower 1/16        |
| 0                   | 1  | 0   | 1   | 1   | 0 thru 3                                        | 000000h – 03FFFFh   | 256 kB            | Lower 1/8         |
| 0                   | 1  | 1   | 0   | 0   | 0 thru 7                                        | 000000h – 07FFFFh   | 512 kB            | Lower 1/4         |
| 0                   | 1  | 1   | 0   | 1   | 0 thru 15                                       | 000000h – 0FFFFFFh  | 1 MB              | Lower 1/2         |
| X                   | X  | 1   | 1   | X   | 0 thru 31                                       | 000000h – 1FFFFFFh  | 2 MB              | All               |
| 1                   | 0  | 0   | 0   | 1   | 31                                              | 1FF000h – 1FFFFFFh  | 4 kB              | Upper 1/512       |
| 1                   | 0  | 0   | 1   | 0   | 31                                              | 1FE000h – 1FFFFFFh  | 8 kB              | Upper 1/256       |
| 1                   | 0  | 0   | 1   | 1   | 31                                              | 1FC000h – 1FFFFFFh  | 16 kB             | Upper 1/128       |
| 1                   | 0  | 1   | 0   | X   | 31                                              | 1F8000h – 1FFFFFFh  | 32 kB             | Upper 1/64        |
| 1                   | 1  | 0   | 0   | 1   | 0                                               | 000000h – 00FFFFh   | 4 kB              | Lower 1/512       |
| 1                   | 1  | 0   | 1   | 0   | 0                                               | 000000h – 001FFFh   | 8 kB              | Lower 1/256       |
| 1                   | 1  | 0   | 1   | 1   | 0                                               | 000000h – 003FFFh   | 16 kB             | Lower 1/128       |
| 1                   | 1  | 1   | 0   | X   | 0                                               | 000000h – 007FFFh   | 32 kB             | Lower 1/64        |

**Notes:**

1. X = don't care.
2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

**Table 24. FL116K Block Protection (CMP = 1)**

| Status Register (1) |    |     |     |     | S25FL1-K (16 Mbit) Block Protection (CMP=1) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|-------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                              | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | 0 thru 31                                       | 000000h – 1FFFFFFh  | All               | All               |
| 0                   | 0  | 0   | 0   | 1   | 0 thru 30                                       | 000000h – 1EFFFFh   | 1,984 kB          | Lower 31/32       |
| 0                   | 0  | 0   | 1   | 0   | 0 thru 29                                       | 000000h – 1DFFFFh   | 1,920 kB          | Lower 15/16       |
| 0                   | 0  | 0   | 1   | 1   | 0 thru 27                                       | 000000h – 1BFFFFh   | 1,792 kB          | Lower 7/8         |
| 0                   | 0  | 1   | 0   | 0   | 0 thru 23                                       | 000000h – 17FFFFh   | 1,536 kB          | Lower 3/4         |
| 0                   | 0  | 1   | 0   | 1   | 0 thru 15                                       | 000000h – 0FFFFFFh  | 1 MB              | Lower 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 1 thru 31                                       | 010000h – 1FFFFFFh  | 1,984 kB          | Upper 31/32       |
| 0                   | 1  | 0   | 1   | 0   | 2 and 31                                        | 020000h – 1FFFFFFh  | 1,920 kB          | Upper 15/16       |
| 0                   | 1  | 0   | 1   | 1   | 4 thru 31                                       | 040000h – 1FFFFFFh  | 1,792 kB          | Upper 7/8         |
| 0                   | 1  | 1   | 0   | 0   | 8 thru 31                                       | 080000h – 1FFFFFFh  | 1,536 kB          | Upper 3/4         |
| 0                   | 1  | 1   | 0   | 1   | 16 thru 31                                      | 100000h – 1FFFFFFh  | 1 MB              | Upper 1/2         |
| X                   | X  | 1   | 1   | X   | None                                            | None                | None              | None              |

**Table 24. FL116K Block Protection (CMP = 1) (Continued)**

| Status Register (1) |   |   |   |   | S25FL1-K (16 Mbit) Block Protection (CMP=1) (2) |                   |          |               |
|---------------------|---|---|---|---|-------------------------------------------------|-------------------|----------|---------------|
| 1                   | 0 | 0 | 0 | 1 | 0 thru 31                                       | 000000h – 1FEFFFh | 2,044 kB | Lower 511/512 |
| 1                   | 0 | 0 | 1 | 0 | 0 thru 31                                       | 000000h – 1FDFFFh | 2,040 kB | Lower 255/256 |
| 1                   | 0 | 0 | 1 | 1 | 0 thru 31                                       | 000000h – 1FBFFFh | 2,032 kB | Lower 127/128 |
| 1                   | 0 | 1 | 0 | X | 0 thru 31                                       | 000000h – 1F7FFFh | 2,016 kB | Lower 63/64   |
| 1                   | 1 | 0 | 0 | 1 | 0 thru 31                                       | 001000h – 1FFFFFh | 2,044 kB | Upper 511/512 |
| 1                   | 1 | 0 | 1 | 0 | 0 thru 31                                       | 002000h – 1FFFFFh | 2,040 kB | Upper 255/256 |
| 1                   | 1 | 0 | 1 | 1 | 0 thru 31                                       | 004000h – 1FFFFFh | 2,032 kB | Upper 127/128 |
| 1                   | 1 | 1 | 0 | X | 0 thru 31                                       | 008000h – 1FFFFFh | 2,016 kB | Upper 63/64   |

**Notes:**

1. X = don't care.

2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

**Table 25. FL132K Block Protection (CMP = 0)**

| Status Register (1) |    |     |     |     | S25FL132K (32-Mbit) Block Protection (CMP=0) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | None                                             | None                | None              | None              |
| 0                   | 0  | 0   | 0   | 1   | 63                                               | 3F0000h – 3FFFFFFh  | 64 kB             | Upper 1/64        |
| 0                   | 0  | 0   | 1   | 0   | 62 and 63                                        | 3E0000h – 3FFFFFFh  | 128 kB            | Upper 1/32        |
| 0                   | 0  | 0   | 1   | 1   | 60 thru 63                                       | 3C0000h – 3FFFFFFh  | 256 kB            | Upper 1/16        |
| 0                   | 0  | 1   | 0   | 0   | 56 thru 63                                       | 380000h – 3FFFFFFh  | 512 kB            | Upper 1/8         |
| 0                   | 0  | 1   | 0   | 1   | 48 thru 63                                       | 300000h – 3FFFFFFh  | 1 MB              | Upper 1/4         |
| 0                   | 0  | 1   | 1   | 0   | 32 thru 63                                       | 200000h – 3FFFFFFh  | 2 MB              | Upper 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 0                                                | 000000h – 00FFFFh   | 64 kB             | Lower 1/64        |
| 0                   | 1  | 0   | 1   | 0   | 0 and 1                                          | 000000h – 01FFFFh   | 128 kB            | Lower 1/32        |
| 0                   | 1  | 0   | 1   | 1   | 0 thru 3                                         | 000000h – 03FFFFh   | 256 kB            | Lower 1/16        |
| 0                   | 1  | 1   | 0   | 0   | 0 thru 7                                         | 000000h – 07FFFFh   | 512 kB            | Lower 1/8         |
| 0                   | 1  | 1   | 0   | 1   | 0 thru 15                                        | 000000h – 0FFFFFFh  | 1 MB              | Lower 1/4         |
| 0                   | 1  | 1   | 1   | 0   | 0 thru 31                                        | 000000h – 1FFFFFFh  | 2 MB              | Lower 1/2         |
| X                   | X  | 1   | 1   | 1   | 0 thru 63                                        | 000000h – 3FFFFFFh  | 4 MB              | All               |
| 1                   | 0  | 0   | 0   | 1   | 63                                               | 3FF000h – 3FFFFFFh  | 4 kB              | Upper 1/1024      |
| 1                   | 0  | 0   | 1   | 0   | 63                                               | 3FE000h – 3FFFFFFh  | 8 kB              | Upper 1/512       |
| 1                   | 0  | 0   | 1   | 1   | 63                                               | 3FC000h – 3FFFFFFh  | 16 kB             | Upper 1/256       |
| 1                   | 0  | 1   | 0   | X   | 63                                               | 3F8000h – 3FFFFFFh  | 32 kB             | Upper 1/128       |
| 1                   | 1  | 0   | 0   | 1   | 0                                                | 000000h – 00FFFFh   | 4 kB              | Lower 1/1024      |
| 1                   | 1  | 0   | 1   | 0   | 0                                                | 000000h – 001FFFh   | 8 kB              | Lower 1/512       |
| 1                   | 1  | 0   | 1   | 1   | 0                                                | 000000h – 003FFFh   | 16 kB             | Lower 1/256       |
| 1                   | 1  | 1   | 0   | X   | 0                                                | 000000h – 007FFFh   | 32 kB             | Lower 1/128       |

**Notes:**

1. X = don't care.

2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

**Table 26. FL132K Block Protection (CMP = 1)**

| Status Register (1) |    |     |     |     | S25FL132K (32-Mbit) Block Protection (CMP=1) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | 0 thru 63                                        | 000000h – 3FFFFFFh  | 4 MB              | All               |
| 0                   | 0  | 0   | 0   | 1   | 0 thru 62                                        | 000000h – 3FFFFFFh  | 4,032 kB          | Lower 63/64       |
| 0                   | 0  | 0   | 1   | 0   | 0 and 61                                         | 000000h – 3DFFFFFFh | 3,968 kB          | Lower 31/32       |
| 0                   | 0  | 0   | 1   | 1   | 0 thru 59                                        | 000000h – 3BFFFFFFh | 3,840 kB          | Lower 15/16       |
| 0                   | 0  | 1   | 0   | 0   | 0 thru 55                                        | 000000h – 37FFFFFFh | 3,584 kB          | Lower 7/8         |
| 0                   | 0  | 1   | 0   | 1   | 0 thru 47                                        | 000000h – 2FFFFFFh  | 3 MB              | Lower 3/4         |
| 0                   | 0  | 1   | 1   | 0   | 0 thru 31                                        | 000000h – 1FFFFFFh  | 2 MB              | Lower 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 1 thru 63                                        | 010000h – 3FFFFFFh  | 4,032 kB          | Upper 63/64       |
| 0                   | 1  | 0   | 1   | 0   | 2 and 63                                         | 020000h – 3FFFFFFh  | 3,968 kB          | Upper 31/32       |
| 0                   | 1  | 0   | 1   | 1   | 4 thru 63                                        | 040000h – 3FFFFFFh  | 3,840 kB          | Upper 15/16       |
| 0                   | 1  | 1   | 0   | 0   | 8 thru 63                                        | 080000h – 3FFFFFFh  | 3,584 kB          | Upper 7/8         |
| 0                   | 1  | 1   | 0   | 1   | 16 thru 63                                       | 100000h – 3FFFFFFh  | 3 MB              | Upper 3/4         |
| 0                   | 1  | 1   | 1   | 0   | 32 thru 63                                       | 200000h – 3FFFFFFh  | 2 MB              | Upper 1/2         |
| X                   | X  | 1   | 1   | 1   | None                                             | None                | None              | None              |
| 1                   | 0  | 0   | 0   | 1   | 0 thru 63                                        | 000000h – 3FEFFFFh  | 4,092 kB          | Lower 1023/1024   |
| 1                   | 0  | 0   | 1   | 0   | 0 thru 63                                        | 000000h – 3FDFFFFh  | 4,088 kB          | Lower 511/512     |
| 1                   | 0  | 0   | 1   | 1   | 0 thru 63                                        | 000000h – 3FBFFFFh  | 4,080 kB          | Lower 255/256     |
| 1                   | 0  | 1   | 0   | X   | 0 thru 63                                        | 000000h – 3F7FFFFh  | 4,064 kB          | Lower 127/128     |
| 1                   | 1  | 0   | 0   | 1   | 0 thru 63                                        | 001000h – 3FFFFFFh  | 4,092 kB          | Upper 1023/1024   |
| 1                   | 1  | 0   | 1   | 0   | 0 thru 63                                        | 002000h – 3FFFFFFh  | 4,088 kB          | Upper 511/512     |
| 1                   | 1  | 0   | 1   | 1   | 0 thru 63                                        | 004000h – 3FFFFFFh  | 4,080 kB          | Upper 255/256     |
| 1                   | 1  | 1   | 0   | X   | 0 thru 63                                        | 008000h – 3FFFFFFh  | 4,064 kB          | Upper 127/128     |

**Notes:**

1. X = don't care.
2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

**Table 27. FL164K Block Protection (CMP = 0)**

| Status Register (1) |    |     |     |     | S25FL164K (64-Mbit) Block Protection (CMP=0) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | None                                             | None                | None              | None              |
| 0                   | 0  | 0   | 0   | 1   | 126 and 127                                      | 7E0000h – 7FFFFFFh  | 128 kB            | Upper 1/64        |
| 0                   | 0  | 0   | 1   | 0   | 124 thru 127                                     | 7C0000h – 7FFFFFFh  | 256 kB            | Upper 1/32        |
| 0                   | 0  | 0   | 1   | 1   | 120 thru 127                                     | 780000h – 7FFFFFFh  | 512 kB            | Upper 1/16        |
| 0                   | 0  | 1   | 0   | 0   | 112 thru 127                                     | 700000h – 7FFFFFFh  | 1 MB              | Upper 1/8         |
| 0                   | 0  | 1   | 0   | 1   | 96 thru 127                                      | 600000h – 7FFFFFFh  | 2 MB              | Upper 1/4         |
| 0                   | 0  | 1   | 1   | 0   | 64 thru 127                                      | 400000h – 7FFFFFFh  | 4 MB              | Upper 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 0 and 1                                          | 000000h – 01FFFFFFh | 128 kB            | Lower 1/64        |
| 0                   | 1  | 0   | 1   | 0   | 0 thru 3                                         | 000000h – 03FFFFFFh | 256 kB            | Lower 1/32        |

**Table 27. FL164K Block Protection (CMP = 0) (Continued)**

| Status Register (1) |    |     |     |     | S25FL164K (64-Mbit) Block Protection (CMP=0) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| 0                   | 1  | 0   | 1   | 1   | 0 thru 7                                         | 000000h – 07FFFFh   | 512 kB            | Lower 1/16        |
| 0                   | 1  | 1   | 0   | 0   | 0 thru 15                                        | 000000h – 0FFFFFh   | 1 MB              | Lower 1/8         |
| 0                   | 1  | 1   | 0   | 1   | 0 thru 31                                        | 000000h – 1FFFFFh   | 2 MB              | Lower 1/4         |
| 0                   | 1  | 1   | 1   | 0   | 0 thru 63                                        | 000000h – 3FFFFFh   | 4 MB              | Lower 1/2         |
| X                   | X  | 1   | 1   | 1   | 0 thru 127                                       | 000000h – 7FFFFFh   | 8 MB              | ALL               |
| 1                   | 0  | 0   | 0   | 1   | 127                                              | 7FF000h – 7FFFFFFh  | 4 kB              | Upper 1/2048      |
| 1                   | 0  | 0   | 1   | 0   | 127                                              | 7FE000h – 7FFFFFFh  | 8 kB              | Upper 1/1024      |
| 1                   | 0  | 0   | 1   | 1   | 127                                              | 7FC000h – 7FFFFFFh  | 16 kB             | Upper 1/512       |
| 1                   | 0  | 1   | 0   | X   | 127                                              | 7F8000h – 7FFFFFFh  | 32 kB             | Upper 1/256       |
| 1                   | 1  | 0   | 0   | 1   | 0                                                | 000000h – 000FFFh   | 4 kB              | Lower 1/2048      |
| 1                   | 1  | 0   | 1   | 0   | 0                                                | 000000h – 001FFFh   | 8 kB              | Lower 1/1024      |
| 1                   | 1  | 0   | 1   | 1   | 0                                                | 000000h – 003FFFh   | 16 kB             | Lower 1/512       |
| 1                   | 1  | 1   | 0   | X   | 0                                                | 000000h – 007FFFh   | 32 kB             | Lower 1/256       |

**Notes:**

1. X = don't care.

2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

**Table 28. FL164K Block Protection (CMP = 1)**

| Status Register (1) |    |     |     |     | S25FL164K (64-Mbit) Block Protection (CMP=1) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| X                   | X  | 0   | 0   | 0   | 0 thru 127                                       | 000000h – 7FFFFFFh  | 8 MB              | ALL               |
| 0                   | 0  | 0   | 0   | 1   | 0 thru 125                                       | 000000h – 7DFFFFh   | 8,064 kB          | Lower 63/64       |
| 0                   | 0  | 0   | 1   | 0   | 0 thru 123                                       | 000000h – 7BFFFFh   | 7,936 kB          | Lower 31/32       |
| 0                   | 0  | 0   | 1   | 1   | 0 thru 119                                       | 000000h – 77FFFFh   | 7,680 kB          | Lower 15/16       |
| 0                   | 0  | 1   | 0   | 0   | 0 thru 111                                       | 000000h – 6FFFFFFh  | 7 MB              | Lower 7/8         |
| 0                   | 0  | 1   | 0   | 1   | 0 thru 95                                        | 000000h – 5FFFFFFh  | 5 MB              | Lower 3/4         |
| 0                   | 0  | 1   | 1   | 0   | 0 thru 63                                        | 000000h – 3FFFFFFh  | 4 MB              | Lower 1/2         |
| 0                   | 1  | 0   | 0   | 1   | 2 thru 127                                       | 020000h – 7FFFFFFh  | 8,064 kB          | Upper 63/64       |
| 0                   | 1  | 0   | 1   | 0   | 4 thru 127                                       | 040000h – 7FFFFFFh  | 7,936 kB          | Upper 31/32       |
| 0                   | 1  | 0   | 1   | 1   | 8 thru 127                                       | 080000h – 7FFFFFFh  | 7,680 kB          | Upper 15/16       |
| 0                   | 1  | 1   | 0   | 0   | 16 thru 127                                      | 100000h – 7FFFFFFh  | 7 MB              | Upper 7/8         |
| 0                   | 1  | 1   | 0   | 1   | 32 thru 127                                      | 200000h – 7FFFFFFh  | 5 MB              | Upper 3/4         |
| 0                   | 1  | 1   | 1   | 0   | 64 thru 127                                      | 400000h – 7FFFFFFh  | 4 MB              | Upper 1/2         |
| X                   | X  | 1   | 1   | 1   | None                                             | None                | None              | None              |
| 1                   | 0  | 0   | 0   | 1   | 0 thru 127                                       | 000000h – 7FEFFFh   | 8,188 kB          | Lower 2047/2048   |
| 1                   | 0  | 0   | 1   | 0   | 0 thru 127                                       | 000000h – 7FDFFFh   | 8,184 kB          | Lower 1023/1024   |
| 1                   | 0  | 0   | 1   | 1   | 0 thru 127                                       | 000000h – 7FBFFFh   | 8,176 kB          | Lower 511/512     |
| 1                   | 0  | 1   | 0   | X   | 0 thru 127                                       | 000000h – 7F7FFFh   | 8,160 kB          | Lower 255/256     |

**Table 28. FL164K Block Protection (CMP = 1) (Continued)**

| Status Register (1) |    |     |     |     | S25FL164K (64-Mbit) Block Protection (CMP=1) (2) |                     |                   |                   |
|---------------------|----|-----|-----|-----|--------------------------------------------------|---------------------|-------------------|-------------------|
| SEC                 | TB | BP2 | BP1 | BP0 | Protected Block(s)                               | Protected Addresses | Protected Density | Protected Portion |
| 1                   | 1  | 0   | 0   | 1   | 0 thru 127                                       | 001000h – 7FFFFFFh  | 8,188 kB          | Lower 2047/2048   |
| 1                   | 1  | 0   | 1   | 0   | 0 thru 127                                       | 002000h – 7FFFFFFh  | 8,184 kB          | Lower 1023/1024   |
| 1                   | 1  | 0   | 1   | 1   | 0 thru 127                                       | 004000h – 7FFFFFFh  | 8,176 kB          | Lower 511/512     |
| 1                   | 1  | 1   | 0   | X   | 0 thru 127                                       | 008000h – 7FFFFFFh  | 8,160 kB          | Lower 255/256     |

**Notes:**

1. X = don't care.
2. If any Erase or Program command specifies a memory region that contains protected data portion, this command will be ignored.

## 6.5.8 Status Register Protect (SRP1, SRP0)

The Status Register Protect bits (SRP1 and SRP0) are non-volatile read / write bits in the Status Register (SR2[0] and SR1[7]). The SRP bits control the method of write protection: software protection, hardware protection, power supply lock-down, or one time programmable (OTP) protection.

**Table 29. Status Register Protection Bits**

| SRP1 | SRP0 | WP# | Status Register        | Description                                                                                                  |
|------|------|-----|------------------------|--------------------------------------------------------------------------------------------------------------|
| 0    | 0    | X   | Software Protection    | WP# pin has no control. SR1 and SR2 can be written to after a Write Enable command, WEL=1. [Factory Default] |
| 0    | 1    | 0   | Hardware Protected     | When WP# pin is low the SR1 and SR2 are locked and can not be written.                                       |
| 0    | 1    | 1   | Hardware Unprotected   | When WP# pin is high SR1 and SR2 are unlocked and can be written to after a Write Enable command, WEL=1.     |
| 1    | 0    | X   | Power Supply Lock-Down | SR1 and SR2 are protected and can not be written to again until the next power-down, power-up cycle. (1)     |
| 1    | 1    | X   | One Time Program (2)   | SR1 and SR2 are permanently protected and can not be written.                                                |

**Notes:**

1. When SRP1, SRP0 = (1, 0), a power-down, power-up, or Software Reset cycle will change SRP1, SRP0 to (0, 0) state.
2. The One-Time Program feature is available upon special order. Contact Cypress for details.
3. Busy, WEL, and SUS (SR1[1:0] and SR2[7]) are volatile read only status bits that are never affected by the Write Status Registers command.
4. The non-volatile version of CMP, QE, SRP1, SRP0, SEC, TB, and BP2-BP0 (SR2[6,1,0] and SR1[6:2]) bits and the OTP LB3-LB0 bits are not writable when protected by the SRP bits and WP# as shown in the table. The non-volatile version of these Status Register bits are selected for writing when the Write Enable (06h) command precedes the Write Status Registers (01h) command.
5. The volatile version of CMP, QE, SRP1, SRP0, SEC, TB, and BP2-BP0 (SR2[6,1,0] and SR1[6:2]) bits are not writable when protected by the SRP bits and WP# as shown in the table. The volatile version of these Status Register bits are selected for writing when the Write Enable for volatile Status Register (50h) command precedes the Write Status Registers (01h) command. There is no volatile version of the LB3-LB0 bits and these bits are not affected by a volatile Write Status Registers command.
6. The volatile SR3 bits are not protected by the SRP bits and may be written at any time by volatile (50h) Write Enable command preceding the Write Status Registers (01h) command.

## 6.5.9 Erase / Program Suspend Status (SUS)

The Suspend Status bit is a read only bit in the status register (SR2[7]) that is set to 1 after executing an Erase / Program Suspend (75h) command. The SUS status bit is cleared to 0 by Erase / Program Resume (7Ah) command as well as a power-down, power-up cycle.

### 6.5.10 Security Register Lock Bits (LB3, LB2, LB1, LB0)

The Security Register Lock Bits (LB3, LB2, LB1, LB0) are non-volatile One Time Program (OTP) bits in Status Register (SR2[5:2]) that provide the write protect control and status to the Security Registers. The default state of LB[3:1] is 0, Security Registers 1 to 3 are unlocked. LB[3:1] can be set to 1 individually using the Write Status Registers command. LB[3:1] are One Time Programmable (OTP), once it's set to 1, the corresponding 256-byte Security Register will become read-only permanently.

Security Register 0 is programmed with the SFDP parameters and LB0 is programmed to 1 by Cypress.

### 6.5.11 Quad Enable (QE)

The Quad Enable (QE) bit is a non-volatile read / write bit in the Status Register (SR2[1]) that allows Quad SPI operation. When the QE bit is set to a 0 state (factory default), the WP# pin and HOLD# are enabled. When the QE bit is set to a 1, the Quad IO2 and IO3 pins are enabled, and WP# and HOLD# functions are disabled.

**Note:** If the WP# or HOLD# pins are tied directly to the power supply or ground during standard SPI or Dual SPI operation, the QE bit should never be set to a 1.

### 6.5.12 Latency Control (LC)

Status Register-3 provides bits (SR3[3:0]) to select the number of read latency cycles used in each Fast Read command. The Read Data command is not affected by the latency code. The binary value of this field selects from 1 to 15 latency cycles. The zero value selects the legacy number of latency cycles used in prior generation FL-K family devices. The default is 0 cycles to provide backward compatibility to legacy devices. The Latency Control bits may be set to select a number of read cycles optimized for the frequency in use. If the number of latency cycles is not sufficient for the operating frequency, invalid data will be read.

**Table 30. Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V**

| Latency Control            | Read Command Maximum Frequency (MHz) |                  |                         |                  |                         |
|----------------------------|--------------------------------------|------------------|-------------------------|------------------|-------------------------|
|                            | Fast Read                            | Dual Output      | Dual I/O                | Quad Output      | Quad I/O                |
| 0<br>(legacy read latency) | 108<br>(8 dummy)                     | 108<br>(8 dummy) | 88<br>(4 mode, 0 dummy) | 108<br>(8 dummy) | 78<br>(2 mode, 4 dummy) |
| 1                          | 50                                   | 50               | 94                      | 43               | 49                      |
| 2                          | 95                                   | 85               | 105                     | 56               | 59                      |
| 3                          | 105                                  | 95               | 108                     | 70               | 69                      |
| 4                          | 108                                  | 105              | 108                     | 83               | 78                      |
| 5                          | 108                                  | 108              | 108                     | 94               | 86                      |
| 6                          | 108                                  | 108              | 108                     | 105              | 95                      |
| 7                          | 108                                  | 108              | 108                     | 108              | 105                     |
| 8                          | 108                                  | 108              | 108                     | 108              | 108                     |
| 9                          | 108                                  | 108              | 108                     | 108              | 108                     |
| 10                         | 108                                  | 108              | 108                     | 108              | 108                     |
| 11                         | 108                                  | 108              | 108                     | 108              | 108                     |
| 12                         | 108                                  | 108              | 108                     | 108              | 108                     |
| 13                         | 108                                  | 108              | 108                     | 108              | 108                     |
| 14                         | 108                                  | 108              | 108                     | 108              | 108                     |
| 15                         | 108                                  | 108              | 108                     | 108              | 108                     |

**Notes:**

1. SCK frequency > 108 MHz SIO, 108 MHz DIO, or 108 MHz QIO is not supported by this family of devices.
2. The Dual I/O and Quad I/O command protocols include Continuous Read Mode bits following the address. The clock cycles for these bits are not counted as part of the latency cycles shown in the table. Example: the legacy Dual I/O command has four Continuous Read Mode bits following the address and no additional dummy cycles. Therefore, the legacy Dual I/O command without additional read latency is supported only up to the frequency shown in the table for a read latency of zero cycles. By increasing the variable read latency the frequency of the Dual I/O command can be increased to allow operation up to the maximum supported 108 MHz DIO frequency.

### **6.5.13 Burst Wrap Enable (W4)**

Status Register-3 provides a bit (SR3[4]) to enable a read with wrap option for the Quad I/O Read command. When SR3[4]=1, the wrap mode is not enabled and unlimited length sequential read is performed. When SR3[4]=0, the wrap mode is enabled and a fixed length and aligned group of 8, 16, 32, or 64 bytes will be read starting at the byte address provided by the Quad I/O Read command and wrapping around at the group alignment boundary.

### **6.5.14 Burst Wrap Length (W6, W5)**

Status Register-3 provides bits (SR3[1:0]) to select the alignment boundary at which reading will wrap to perform a cache line fill. Reading begins at the initial byte address of a Fast Read Quad IO command, then sequential bytes are read until the selected boundary is reached. Reading then wraps to the beginning of the selected boundary. This enables critical word first cache line refills. The wrap point can be aligned on 8-, 16-, 32-, or 64-byte boundaries.

Not Recommended for New Design

## 6.6 Device Identification

### 6.6.1 Legacy Device Identification Commands

Three legacy commands are supported to access device identification that can indicate the manufacturer, device type, and capacity (density). The returned data bytes provide the information as shown in [Table 31](#).

**Table 31. Device Identification**

| Device OPN | Instruction | Data 1                | Data 2            | Data 3         |
|------------|-------------|-----------------------|-------------------|----------------|
| S25FL116K  | ABh(1)      | Device ID = 14h       | —                 | —              |
|            | 90h(2)      | Manufacturer ID = 01h | Device ID = 14h   | —              |
|            | 9Fh(3)      | Manufacturer ID = 01h | Device Type = 40h | Capacity = 15h |
| S25FL132K  | ABh(1)      | Device ID = 15h       | —                 | —              |
|            | 90h(2)      | Manufacturer ID = 01h | Device ID = 15h   | —              |
|            | 9Fh(3)      | Manufacturer ID = 01h | Device Type = 40h | Capacity = 16h |
| S25FL164K  | ABh(1)      | Device ID = 16h       | —                 | —              |
|            | 90h(2)      | Manufacturer ID = 01h | Device ID = 16h   | —              |
|            | 9Fh(3)      | Manufacturer ID = 01h | Device Type = 40h | Capacity = 17h |

**Note:**

1. The ABh instruction is followed by three dummy address bytes then the output of Device ID byte. See [Command Set \(ID, Security Commands\)](#) on page 64 and [Release from Deep-Power-Down / Device ID \(ABh\)](#) on page 77.
2. The 90h instruction is followed by three address bytes with (Address = 0) followed by the output of Manufacturer ID byte then the Device ID byte. See [Command Set \(ID, Security Commands\)](#) on page 64, and [Read Manufacturer / Device ID \(90h\)](#) on page 78.
3. The 9Fh instruction is followed by the output of the Manufacturer ID byte then Device ID byte then the Capacity byte. See [Command Set \(ID, Security Commands\)](#) on page 64 and [Read JEDEC ID \(9Fh\)](#) on page 78.

### 6.6.2 Serial Flash Discoverable Parameters (SFDP)

A Read SFDP (5Ah) command to read a JEDEC standard (JESD216) defined device information structure is supported. The information is stored in Security Register 0 and described in [Security Register 0 — Serial Flash Discoverable Parameters \(SFDP — JEDEC JESD216B\)](#) on page 39.

## 7. Functional Description

### 7.1 SPI Operations

#### 7.1.1 Standard SPI Commands

The S25FL1-K is accessed through an SPI compatible bus consisting of four signals: Serial Clock (SCK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Standard SPI commands use the SI input pin to serially write instructions, addresses or data to the device on the rising edge of SCK. The SO output pin is used to read data or status from the device on the falling edge SCK.

SPI bus operation Mode 0 (0,0) and 3 (1,1) are supported. The primary difference between Mode 0 and Mode 3 concerns the normal state of the SCK signal when the SPI bus master is in standby and data is not being transferred to the serial flash. For Mode 0, the SCK signal is normally low on the falling and rising edges of CS#. For Mode 3, the SCK signal is normally high on the falling and rising edges of CS#.

#### 7.1.2 Dual SPI Commands

The S25FL1-K supports Dual SPI operation when using the “Fast Read Dual Output (3Bh)” and “Fast Read Dual I/O (BBh)” commands. These commands allow data to be transferred to or from the device at two to three times the rate of ordinary serial flash devices. The Dual SPI Read commands are ideal for quickly downloading code to RAM upon power-up (code-shadowing) or for executing non-speed-critical code directly from the SPI bus (XIP). When using Dual SPI commands, the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

#### 7.1.3 Quad SPI Commands

The S25FL1-K supports Quad SPI operation when using the “Fast Read Quad Output (6Bh)”, and “Fast Read Quad I/O (EBh)” commands. These commands allow data to be transferred to or from the device four to six times the rate of ordinary serial flash. The Quad Read commands offer a significant improvement in continuous and random access transfer rates allowing fast code-shadowing to RAM or execution directly from the SPI bus (XIP). When using Quad SPI commands the SI and SO pins become bidirectional IO0 and IO1, and the WP# and HOLD# pins become IO2 and IO3 respectively. Quad SPI commands require the non-volatile or volatile Quad Enable bit (QE) in Status Register-2 to be set.

#### 7.1.4 Hold Function

For Standard SPI and Dual SPI operations, the HOLD# (IO3) signal allows the device interface operation to be paused while it is actively selected (when CS# is low). The Hold function may be useful in cases where the SPI data and clock signals are shared with other devices. For example, if the page buffer is only partially written when a priority interrupt requires use of the SPI bus, the Hold function can save the state of the interface and the data in the buffer so programming command can resume where it left off once the bus is available again. The Hold function is only available for standard SPI and Dual SPI operation, not during Quad SPI.

To initiate a Hold condition, the device must be selected with CS# low. A Hold condition will activate on the falling edge of the HOLD# signal if the SCK signal is already low. If the SCK is not already low the Hold condition will activate after the next falling edge of SCK. The Hold condition will terminate on the rising edge of the HOLD# signal if the SCK signal is already low. If the SCK is not already low the Hold condition will terminate after the next falling edge of SCK. During a Hold condition, the Serial Data Output, (SO) or IO0 and IO1, are high impedance and Serial Data Input, (SI) or IO0 and IO1, and Serial Clock (SCK) are ignored. The Chip Select (CS#) signal should be kept active (low) for the full duration of the Hold operation to avoid resetting the internal logic state of the device.

## 7.2 Write Protection

Applications that use non-volatile memory must take into consideration the possibility of noise and other adverse system conditions that may compromise data integrity. To address this concern, the S25FL1-K provides several means to protect the data from inadvertent program or erase.

### 7.2.1 Write Protect Features

- Device resets when  $V_{CC}$  is below threshold
- Time delay write disable after Power-Up
- Write enable / disable commands and automatic write disable after erase or program
- Command length protection
  - All commands that Write, Program or Erase must complete on a byte boundary (CS# driven high after a full 8 bits have been clocked) otherwise the command will be ignored
- Software and Hardware write protection using Status Register control
  - WP# input protection
  - Lock Down write protection until next power-up or Software Reset
  - One-Time Program (OTP) write protection
- Write Protection using the Deep Power-Down command

Upon power-up or at power-down, the S25FL1-K will maintain a reset condition while  $V_{CC}$  is below the threshold value of VWI, (see [Figure 19, Power-Up Timing and Voltage Levels on page 24](#)). While reset, all operations are disabled and no commands are recognized. During power-up and after the  $V_{CC}$  voltage exceeds VWI, all program and erase related commands are further disabled for a time delay of  $t_{PUW}$ . This includes the Write Enable, Page Program, Sector Erase, Block Erase, Chip Erase and the Write Status Registers commands. Note that the chip select pin (CS#) must track the  $V_{CC}$  supply level at power-up until the  $V_{CC}$ -min level and  $t_{VSL}$  time delay is reached. If needed a pull-up resistor on CS# can be used to accomplish this.

After power-up the device is automatically placed in a write-disabled state with the Status Register Write Enable Latch (WEL) set to a 0. A Write Enable command must be issued before a Page Program, Sector Erase, Block Erase, Chip Erase or Write Status Registers command will be accepted. After completing a program, erase or write command the Write Enable Latch (WEL) is automatically cleared to a write-disabled state of 0.

Software controlled main flash array write protection is facilitated using the Write Status Registers command to write the Status Register Protect (SRP0, SRP1) and Block Protect (CMP, SEC, TB, BP2, BP1 and BP0) bits.

The BP method allows a portion as small as 4-kB sector or the entire memory array to be configured as read only. Used in conjunction with the Write Protect (WP#) pin, changes to the Status Register can be enabled or disabled under hardware control. [See Status Registers on page 49](#) for further information.

Additionally, the Deep Power-Down (DPD) command offers an alternative means of data protection as all commands are ignored during the DPD state, except for the Release from Deep-Power-Down (RES ABh) command. Thus, preventing any program or erase during the DPD state.

## 7.3 Status Registers

The Read and Write Status Registers commands can be used to provide status and control of the flash memory device.

## 8. Commands

The command set of the S25FL1-K is fully controlled through the SPI bus (see [Table 32](#) to [Table 35](#) on page 64). Commands are initiated with the falling edge of Chip Select (CS#). The first byte of data clocked into the SI input provides the instruction code. Data on the SI input is sampled on the rising edge of clock with most significant bit (MSB) first.

Commands vary in length from a single byte to several bytes. Each command begins with an instruction code and may be followed by address bytes, a mode byte, read latency (dummy / don't care) cycles, or data bytes. Commands are completed with the rising edge of edge CS#. Clock relative sequence diagrams for each command are included in the command descriptions. All read commands can be completed after any data bit. However, all commands that Write, Program or Erase must complete on a byte boundary (CS# driven high after a full 8 bits have been clocked) otherwise the command will be ignored. This feature further protects the device from inadvertent writes. Additionally, while the memory is being programmed or erased, all commands except for Read Status Register and Suspend commands will be ignored until the program or erase cycle has completed. When the Status Register is being written, all commands except for Read Status Register will be ignored until the Status Register write operation has completed.

**Table 32. Command Set (Configuration, Status, Erase, Program Commands <sup>(1)</sup>)**

| Command Name                                              | BYTE 1<br>(Instruction) | BYTE 2              | BYTE 3        | BYTE 4   | BYTE 5       | BYTE 6 |
|-----------------------------------------------------------|-------------------------|---------------------|---------------|----------|--------------|--------|
| Read Status Register-1                                    | 05h                     | SR1[7:0] (2)<br>(4) |               |          |              |        |
| Read Status Register-2                                    | 35h                     | SR2[7:0] (2)<br>(4) |               |          |              |        |
| Read Status Register-3                                    | 33h                     | SR3[7:0] (2)        |               |          |              |        |
| Write Enable                                              | 06h                     |                     |               |          |              |        |
| Write Enable for Volatile Status Register                 | 50h                     |                     |               |          |              |        |
| Write Disable                                             | 04h                     |                     |               |          |              |        |
| Write Status Registers                                    | 01h                     | SR1[7:0]            | SR2[7:0]      | SR3[7:0] |              |        |
| Set Burst with Wrap                                       | 77h                     | xxh                 | xxh           | xxh      | SR3[7:0] (3) |        |
| Set Block / Pointer Protection<br>(S25FL132K / S25FL164K) | 39h                     | A23–A16             | A15–A10, x, x | xxh      |              |        |
| Page Program                                              | 02h                     | A23–A16             | A15–A8        | A7–A0    | D7–D0        |        |
| Sector Erase (4 kB)                                       | 20h                     | A23–A16             | A15–A8        | A7–A0    |              |        |
| Block Erase (64 kB)                                       | D8h                     | A23–A16             | A15–A8        | A7–A0    |              |        |
| Chip Erase                                                | C7h / 60h               |                     |               |          |              |        |
| Erase / Program Suspend                                   | 75h                     |                     |               |          |              |        |
| Erase / Program Resume                                    | 7Ah                     |                     |               |          |              |        |

**Notes:**

1. Data bytes are shifted with Most Significant Bit First. Byte fields with data in brackets '[]' indicate data being read from the device on the SO pin.
2. Status Register contents will repeat continuously until CS# terminates the command.
3. Set Burst with Wrap Input format to load SR3. See [Table 22](#) on page 50.  
 IO0 = x, x, x, x, x, x, W4, x]  
 IO1 = x, x, x, x, x, x, W5, x]  
 IO2 = x, x, x, x, x, x, W6, x]  
 IO3 = x, x, x, x, x, x, x, x
4. When changing the value of any single bit, read all other bits and rewrite the same value to them.

**Table 33. Command Set (Read Commands)**

| Command Name                   | BYTE 1<br>(Instruction) | BYTE 2            | BYTE 3                    | BYTE 4           | BYTE 5       | BYTE 6           |
|--------------------------------|-------------------------|-------------------|---------------------------|------------------|--------------|------------------|
| Read Data                      | 03h                     | A23–A16           | A15–A8                    | A7–A0            | (D7–D0, ...) |                  |
| Fast Read                      | 0Bh                     | A23–A16           | A15–A8                    | A7–A0            | dummy        | (D7–D0, ...)     |
| Fast Read Dual Output          | 3Bh                     | A23–A16           | A15–A8                    | A7–A0            | dummy        | (D7–D0, ...) (1) |
| Fast Read Quad Output          | 6Bh                     | A23–A16           | A15–A8                    | A7–A0            | dummy        | (D7–D0, ...) (3) |
| Fast Read Dual I/O             | BBh                     | A23–A8 (2)        | A7–A0, M7–M0 (2)          | (D7–D0, ...) (1) |              |                  |
| Fast Read Quad I/O             | EBh                     | A23–A0, M7–M0 (4) | (x,x,x,x, D7–D0, ...) (5) | (D7–D0, ...) (3) |              |                  |
| Continuous Read Mode Reset (6) | FFh                     | FFh               |                           |                  |              |                  |

**Notes:**

- Dual Output data  
IO0 = (D6, D4, D2, D0)  
IO1 = (D7, D5, D3, D1)
- Dual Input Address  
IO0 = A22, A20, A18, A16, A14, A12, A10, A8, A6, A4, A2, A0, M6, M4, M2, M0  
IO1 = A23, A21, A19, A17, A15, A13, A11, A9, A7, A5, A3, A1, M7, M5, M3, M1
- Quad Output Data  
IO0 = (D4, D0, .....)  
IO1 = (D5, D1, .....)  
IO2 = (D6, D2, .....)  
IO3 = (D7, D3, .....)
- Quad Input Address  
IO0 = A20, A16, A12, A8, A4, A0, M4, M0  
IO1 = A21, A17, A13, A9, A5, A1, M5, M1  
IO2 = A22, A18, A14, A10, A6, A2, M6, M2  
IO3 = A23, A19, A15, A11, A7, A3, M7, M3
- Fast Read Quad I/O Data  
IO0 = (x, x, x, x, D4, D0, .....)  
IO1 = (x, x, x, x, D5, D1, .....)  
IO2 = (x, x, x, x, D6, D2, .....)  
IO3 = (x, x, x, x, D7, D3, .....)
- This command is recommended when using the Dual or Quad "Continuous Read Mode" feature. See [Section 8.4.3](#) and [Section 8.4.3 on page 75](#) for more information.

**Table 34. Command Set (Reset Commands)**

| Command Name                   | Byte 1<br>(Instruction) | Byte 2 | Byte 3 | Byte 4 | Byte 5 | Byte 6 |
|--------------------------------|-------------------------|--------|--------|--------|--------|--------|
| Software Reset Enable          | 66h                     |        |        |        |        |        |
| Software Reset                 | 99h                     |        |        |        |        |        |
| Continuous Read Mode Reset (1) | FFh                     | FFh    |        |        |        |        |

**Notes:**

- This command is recommended when using the Dual or Quad "Continuous Read Mode" feature. See [Section 8.4.3](#) and [Section 8.4.3 on page 75](#) for more information.

**Table 35. Command Set (ID, Security Commands)**

| Command Name                                  | BYTE 1<br>(Instruction) | BYTE 2       | BYTE 3      | BYTE 4   | BYTE 5        | BYTE 6       |
|-----------------------------------------------|-------------------------|--------------|-------------|----------|---------------|--------------|
| Deep Power-down                               | B9h                     |              |             |          |               |              |
| Release Power down / Device ID                | ABh                     | dummy        | dummy       | dummy    | Device ID (1) |              |
| Manufacturer / Device ID (2)                  | 90h                     | A23–A16      | A15–A8      | A7–A0    | Manufacturer  | Device ID    |
| JEDEC ID                                      | 9Fh                     | Manufacturer | Memory Type | Capacity |               |              |
| Read SFDP Register /<br>Read Unique ID Number | 5Ah                     | 00h          | 00h         | A7–A0    | dummy         | (D7–D0, ...) |
| Read Security Registers (3)                   | 48h                     | A23–A16      | A15–A8      | A7–A0    | dummy         | (D7–D0, ...) |
| Erase Security Registers (3)                  | 44h                     | A23–A16      | A15–A8      | A7–A0    |               |              |
| Program Security Registers<br>(3)             | 42h                     | A23–A16      | A15–A8      | A7–A0    | D7–D0, ...    |              |

**Notes:**

1. The Device ID will repeat continuously until CS# terminates the command.
2. See [Section 6.6.1, Legacy Device Identification Commands](#) on page 59 for Device ID information. The 90h instruction is followed by an address. Address = 0 selects Manufacturer ID as the first returned data as shown in the table. Address = 1 selects Device ID as the first returned data followed by Manufacturer ID.
3. Security Register Address:  
 Security Register 0: A23-16 = 00h; A15-8 = 00h; A7-0 = byte address  
 Security Register 1: A23-16 = 00h; A15-8 = 10h; A7-0 = byte address  
 Security Register 2: A23-16 = 00h; A15-8 = 20h; A7-0 = byte address  
 Security Register 3: A23-16 = 00h; A15-8 = 30h; A7-0 = byte address

Security Register 0 is used to store the SFDP parameters and is always programmed and locked by Cypress.

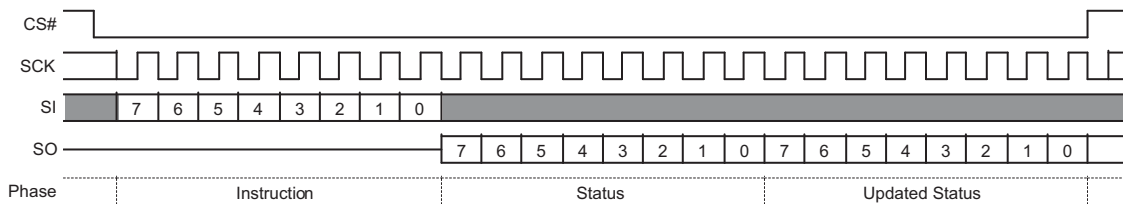
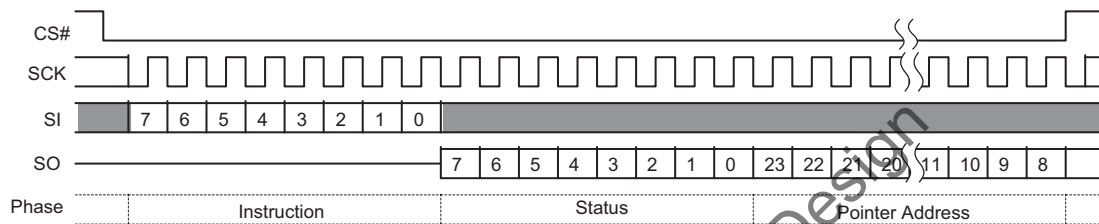
## 8.1 Configuration and Status Commands

### 8.1.1 Read Status Registers (05h), (35h), (33h)

The Read Status Register commands allow the 8-bit Status Registers to be read. The command is entered by driving CS# low and shifting the instruction code “05h” for Status Register-1, “35h” for Status Register-2, or 33h for Status Register-3, into the SI pin on the rising edge of SCK. The Status Register bits are then shifted out on the SO pin at the falling edge of SCK with most significant bit (MSB) first as shown in [Figure 33](#). The Status Register bits are shown in [Section 6.5, Status Registers](#) on page 49.

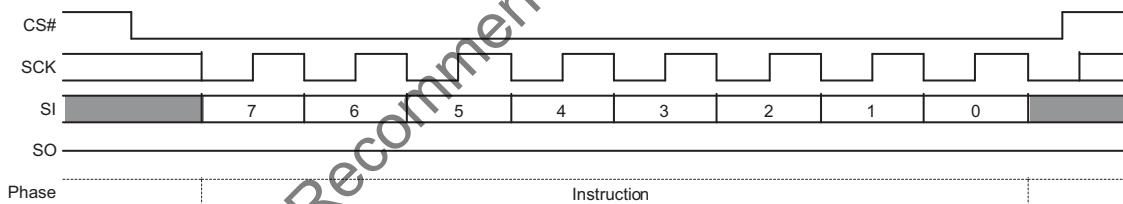
The Read Status Register-1 (05h) command may be used at any time, even while a Program, Erase, or Write Status Registers cycle is in progress. This allows the BUSY status bit to be checked to determine when the operation is complete and if the device can accept another command. The Read Status Register-2 (35h), and Read Status Registers (33h) may be used only when the device is in standby, not busy with an embedded operation.

Status Registers can be read continuously as each repeated data output delivers the updated current value of each status register. Example: using the instruction code “05h” for Read Status Register-1, the first output of eight bits may show the device is busy, SR1[0]=1. By continuing to hold CS# low, the updated value of SR1 will be shown in the next byte output. This repeated reading of SR1 can continue until the system detects the Busy bit has changed back to ready status in one of the status bytes being read out. The Read Status Register commands are completed by driving CS# high.

**Figure 33. Read Status Register Command Sequence Diagram for 05h and 35h**

**Figure 34. Read Status Register-3 Command Sequence Diagram for 33h — S25FL132K / S25FL164K**


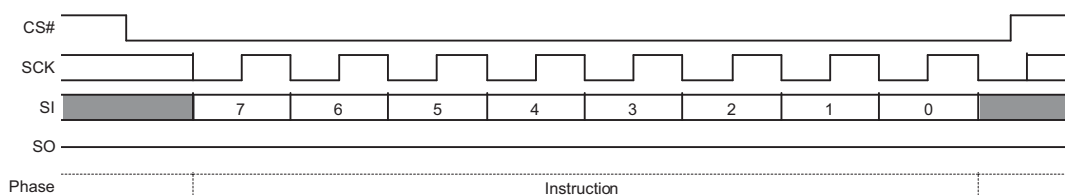
### 8.1.2 Write Enable (06h)

The Write Enable command (Figure 35) sets the Write Enable Latch (WEL) bit in the Status Register to a 1. The WEL bit must be set prior to every Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Registers and Erase / Program Security Registers command. The Write Enable command is entered by driving CS# low, shifting the instruction code “06h” into the Data Input (SI) pin on the rising edge of SCK, and then driving CS# high.

**Figure 35. Write Enable (WREN 06h) Command Sequence**


### 8.1.3 Write Enable for Volatile Status Register (50h)

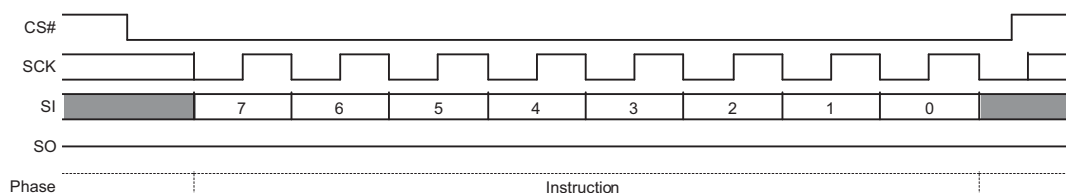
The non-volatile Status Register bits described in Section 6.5, Status Registers on page 49 can also be written to as volatile bits. During power up reset, the non-volatile Status Register bits are copied to a volatile version of the Status Register that is used during device operation. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. To write the volatile version of the Status Register bits, the Write Enable for Volatile Status Register (50h) command must be issued and immediately followed by the Write Status Registers (01h) command. Write Enable for Volatile Status Register command (Figure 36) will not set the Write Enable Latch (WEL) bit, it is only valid for the next following Write Status Registers command, to change the volatile Status Register bit values.

**Figure 36. Write Enable for Volatile Status Register Command Sequence**


### 8.1.4 Write Disable (04h)

The Write Disable command resets the Write Enable Latch (WEL) bit in the Status Register to a 0. The Write Disable command is entered by driving CS# low, shifting the instruction code "04h" into the SI pin and then driving CS# high. Note that the WEL bit is automatically reset after Power-up and upon completion of the Write Status Registers, Erase / Program Security Registers, Page Program, Sector Erase, Block Erase and Chip Erase commands.

**Figure 37. Write Disable (WRDI 04h) Command Sequence**



### 8.1.5 Write Status Registers (01h)

The Write Status Registers command allows the Status Registers to be written. Only non-volatile Status Register bits SRP0, SEC, TB, BP2, BP1, BP0 (SR1[7:2]) CMP, LB3, LB2, LB1, QE, SRP1 (SR2[6:0]), and the volatile bits SR3[6:0] can be written. All other Status Register bit locations are read-only and will not be affected by the Write Status Registers command. LB3-0 are non-volatile OTP bits; once each is set to 1, it can not be cleared to 0. The Status Register bits are shown in [Section 6.5, Status Registers on page 49](#). Any reserved bits should only be written to their default value.

To write non-volatile Status Register bits, a standard Write Enable (06h) command must previously have been executed for the device to accept the Write Status Registers Command (Status Register bit WEL must equal 1). Once write enabled, the command is entered by driving CS# low, sending the instruction code "01h", and then writing the Status Register data bytes as illustrated in [Figure 38](#).

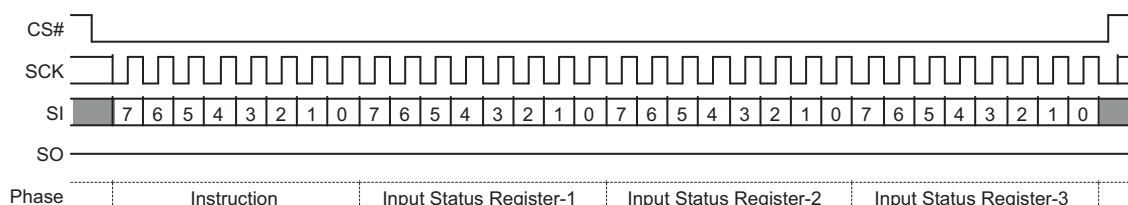
To write volatile Status Register bits, a Write Enable for Volatile Status Register (50h) command must have been executed prior to the Write Status Registers command (Status Register bit WEL remains 0). However, SRP1 and LB3, LB2, LB1, LB0 can not be changed because of the OTP protection for these bits. Upon power-off, the volatile Status Register bit values will be lost, and the non-volatile Status Register bit values will be restored when power on again.

To complete the Write Status Registers command, the CS# pin must be driven high after the eighth bit of a data value is clocked in (CS# must be driven high on an 8-bit boundary). If this is not done the Write Status Registers command will not be executed. If CS# is driven high after the eighth clock the CMP and QE bits will be cleared to 0 if the SRP1 bit is 0. The SR2 bits are unaffected if SRP1 is 1. If CS# is driven high after the eighth or sixteenth clock, the SR3 bits will not be affected.

During non-volatile Status Register write operation (06h combined with 01h), after CS# is driven high at the end of the Write Status Registers command, the self-timed Write Status Registers operation will commence for a time duration of  $t_W$  (see [Section 4.8, AC Electrical Characteristics on page 25](#)). While the Write Status Registers operation is in progress, the Read Status Register command may still be accessed to check the status of the BUSY bit. The BUSY bit is a 1 during the Write Status Registers operation and a 0 when the operation is finished and ready to accept other commands again. After the Write Status Registers operation has finished, the Write Enable Latch (WEL) bit in the Status Register will be cleared to 0.

During volatile Status Register write operation (50h combined with 01h), after CS# is driven high at the end of the Write Status Registers command, the Status Register bits will be updated to the new values within the time period of  $t_{SHSL2}$  (see [Section 4.8, AC Electrical Characteristics on page 25](#)). BUSY bit will remain 0 during the Status Register bit refresh period. Refer to [Section 6.5, Status Registers on page 49](#) for detailed Status Register bit descriptions.

**Figure 38. Write Status Registers Command Sequence Diagram**



## 8.2 Program and Erase Commands

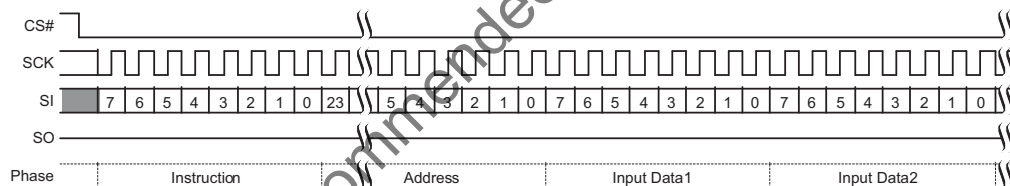
### 8.2.1 Page Program (02h)

The Page Program command allows from one byte to 256 bytes (a page) of data to be programmed at previously erased (FFh) memory locations. A Write Enable command must be executed before the device will accept the Page Program Command (Status Register bit WEL= 1). The command is initiated by driving the CS# pin low then shifting the instruction code “02h” followed by a 24-bit address (A23-A0) and at least one data byte, into the SI pin. The CS# pin must be held low for the entire length of the command while data is being sent to the device. The Page Program command sequence is shown in [Figure 39, Page Program Command Sequence](#) on page 67.

If an entire 256-byte page is to be programmed, the last address byte (the 8 least significant address bits) should be set to 0. If the last address byte is not zero, and the number of clocks exceed the remaining page length, the addressing will wrap to the beginning of the page. In some cases, less than 256 bytes (a partial page) can be programmed without having any effect on other bytes within the same page. One condition to perform a partial page program is that the number of clocks can not exceed the remaining page length. If more than 256 bytes are sent to the device the addressing will wrap to the beginning of the page and overwrite previously sent data.

As with the write and erase commands, the CS# pin must be driven high after the eighth bit of the last byte has been latched. If this is not done the Page Program command will not be executed. After CS# is driven high, the self-timed Page Program command will commence for a time duration of  $t_{PP}$  ([Section 4.8, AC Electrical Characteristics on page 25](#)). While the Page Program cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Page Program cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Page Program cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Page Program command will not be executed if the addressed page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

**Figure 39. Page Program Command Sequence**

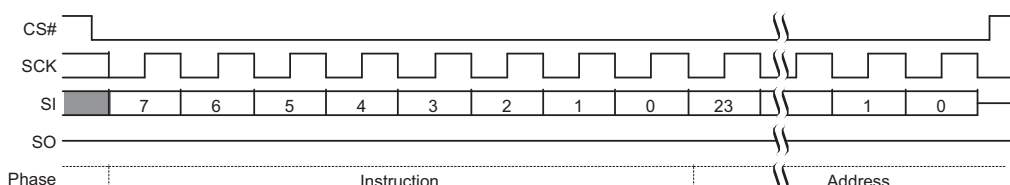


### 8.2.2 Sector Erase (20h)

The Sector Erase command sets all memory within a specified sector (4 kbytes) to the erased state of all 1's (FFh). A Write Enable command must be executed before the device will accept the Sector Erase command (Status Register bit WEL must equal 1). The command is initiated by driving the CS# pin low and shifting the instruction code “20h” followed a 24-bit sector address (A23-A0) [See Supply and Signal Ground \(V<sub>SS</sub>\) on page 10](#). The Sector Erase command sequence is shown in [Figure 40 on page 67](#).

The CS# pin must be driven high after the eighth bit of the last byte has been latched. If this is not done the Sector Erase command will not be executed. After CS# is driven high, the self-timed Sector Erase command will commence for a time duration of  $t_{SE}$ . [Section 4.8, AC Electrical Characteristics on page 25](#) While the Sector Erase cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Sector Erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Sector Erase cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Sector Erase command will not be executed if the addressed sector is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits ([Table 25, FL132K Block Protection \(CMP = 0\) on page 53](#)).

**Figure 40. Sector Erase Command Sequence**

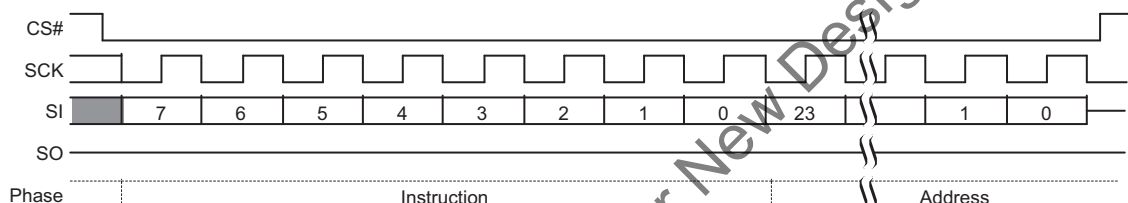


### 8.2.3 64-kB Block Erase (D8h)

The Block Erase command sets all memory within a specified block (64 kbytes) to the erased state of all 1s (FFh). A Write Enable command must be executed before the device will accept the Block Erase command (Status Register bit WEL must equal 1). The command is initiated by driving the CS# pin low and shifting the instruction code "D8h" followed a 24-bit block address (A23-A0). See [Supply and Signal Ground \(V<sub>SS</sub>\) on page 10](#). The Block Erase command sequence is shown in [Figure 41](#).

The CS# pin must be driven high after the eighth bit of the last byte has been latched. If this is not done the Block Erase command will not be executed. After CS# is driven high, the self-timed Block Erase command will commence for a time duration of  $t_{BE}$  (see [Section 4.8, AC Electrical Characteristics on page 25](#)). While the Block Erase cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Block Erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Block Erase cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Block Erase command will not be executed if the addressed sector is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits (see [Section 6.5, Status Registers on page 49](#)).

**Figure 41. 64-kB Block Erase Command Sequence**

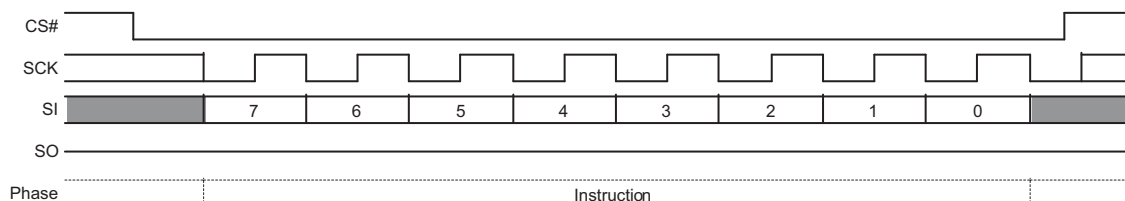


### 8.2.4 Chip Erase (C7h / 60h)

The Chip Erase command sets all memory within the device to the erased state of all 1's (FFh). A Write Enable command must be executed before the device will accept the Chip Erase command (Status Register bit WEL must equal 1). The command is initiated by driving the CS# pin low and shifting the instruction code "C7h" or "60h". The Chip Erase command sequence is shown in [Figure 42](#).

The CS# pin must be driven high after the eighth bit has been latched. If this is not done the Chip Erase command will not be executed. After CS# is driven high, the self-timed Chip Erase command will commence for a time duration of  $t_{CE}$  ([Section 4.8, AC Electrical Characteristics on page 25](#)). While the Chip Erase cycle is in progress, the Read Status Register command may still be accessed to check the status of the BUSY bit. The BUSY bit is a 1 during the Chip Erase cycle and becomes a 0 when finished and the device is ready to accept other commands again. After the Chip Erase cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Chip Erase command will not be executed if any page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits (see [Section 6.5, Status Registers on page 49](#)).

**Figure 42. Chip Erase Command Sequence**



## 8.2.5 Erase / Program Suspend (75h)

The Erase / Program Suspend command allows the system to interrupt a Sector or Block Erase operation, then read from or program data to any other sector. The Erase / Program Suspend command also allows the system to interrupt a Page Program operation and then read from any other page or erase any other sector or block. The Erase / Program Suspend command sequence is shown in [Figure 43, Erase / Program Suspend Command Sequence on page 70](#).

The Write Status Registers command (01h), Program Security Registers (42h), and Erase commands (20h, D8h, C7h, 60h, 44h) are not allowed during Erase Suspend. Erase Suspend is valid only during the Sector or Block erase operation. If written during the Chip Erase operation, the Erase Suspend command is ignored. The Write Status Registers command (01h), Erase Security Registers (44h), and Program commands (02h, 32h, 42h) are not allowed during Program Suspend. Program Suspend is valid only during the Page Program operation.

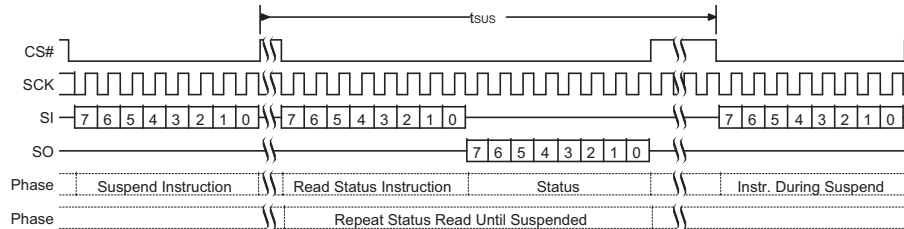
**Table 36. Commands Accepted During Suspend**

| Operation Suspended | Command Allowed            | Instruction |
|---------------------|----------------------------|-------------|
| Program or Erase    | Read Data                  | 03h         |
| Program or Erase    | Fast Read                  | 0Bh         |
| Program or Erase    | Fast Read Dual Output      | 3Bh         |
| Program or Erase    | Fast Read Quad Output      | 6Bh         |
| Program or Erase    | Fast Read Dual I/O         | BBh         |
| Program or Erase    | Fast Read Quad I/O         | EBh         |
| Program or Erase    | Continuous Read Mode Reset | FFh         |
| Program or Erase    | Read Status Register-1     | 05h         |
| Program or Erase    | Read Status Register-2     | 35h         |
| Program or Erase    | Write Enable               | 06h         |
| Erase               | Page Program               | 02h         |
| Program             | Sector Erase               | 20h         |
| Program             | Block Erase                | D8h         |
| Program or Erase    | Erase / Program Resume     | 7Ah         |

The Erase / Program Suspend command 75h will be accepted by the device only if the SUS bit in the Status Register equals to 0 and the BUSY bit equals to 1 while a Sector or Block Erase or a Page Program operation is on-going. If the SUS bit equals to 1 or the BUSY bit equals to 0, the Suspend command will be ignored by the device. Program or Erase command for the sector that is being suspended will be ignored.

A maximum of time of  $t_{SUS}$  ([Section 4.8, AC Electrical Characteristics on page 25](#)) is required to suspend the erase or program operation. The BUSY bit in the Status Register will be cleared from 1 to 0 within  $t_{SUS}$  and the SUS bit in the Status Register will be set from 0 to 1 immediately after Erase / Program Suspend. For a previously resumed Erase / Program operation, it is also required that the Suspend command 75h is not issued earlier than a minimum of time of  $t_{SUS}$  following the preceding Resume command 7Ah.

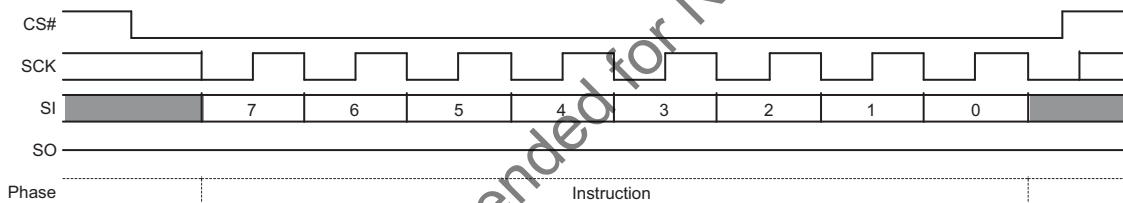
Unexpected power off during the Erase / Program suspend state will reset the device and release the suspend state. SUS bit in the Status Register will also reset to 0. The data within the page, sector or block that was being suspended may become corrupted. It is recommended for the user to implement system design techniques to prevent accidental power interruption, provide non-volatile tracking of in process program or erase commands, and preserve data integrity by evaluating the non-volatile program or erase tracking information during each system power up in order to identify and repair (re-erase and re-program) any improperly terminated program or erase operations.

**Figure 43. Erase / Program Suspend Command Sequence**


## 8.2.6 Erase / Program Resume (7Ah)

The Erase / Program Resume command “7Ah” must be written to resume the Sector or Block Erase operation or the Page Program operation after an Erase / Program Suspend. The Resume command “7Ah” will be accepted by the device only if the SUS bit in the Status Register equals to 1 and the BUSY bit equals to 0. After the Resume command is issued the SUS bit will be cleared from 1 to 0 immediately, the BUSY bit will be set from 0 to 1 within 200 ns and the Sector or Block will complete the erase operation or the page will complete the program operation. If the SUS bit equals to 0 or the BUSY bit equals to 1, the Resume command “7Ah” will be ignored by the device. The Erase / Program Resume command sequence is shown in Figure 44.

It is required that a subsequent Erase / Program Suspend command not to be issued within a minimum of time of  $t_{SUS}$  following a Resume command.

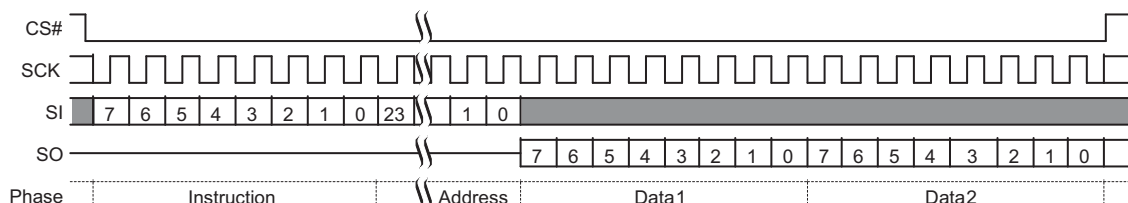
**Figure 44. Erase / Program Resume Command Sequence**


## 8.3 Read Commands

### 8.3.1 Read Data (03h)

The Read Data command allows one or more data bytes to be sequentially read from the memory. The command is initiated by driving the CS# pin low and then shifting the instruction code “03h” followed by a 24-bit address (A23-A0) into the SI pin. The code and address bits are latched on the rising edge of the SCK pin. After the address is received, the data byte of the addressed memory location will be shifted out on the SO pin at the falling edge of SCK with most significant bit (MSB) first. The address is automatically incremented to the next higher address after each byte of data is shifted out allowing for a continuous stream of data. This means that the entire memory can be accessed with a single command as long as the clock continues. The command is completed by driving CS# high.

The Read Data command sequence is shown in Figure 45. If a Read Data command is issued while an Erase, Program or Write cycle is in process (BUSY=1) the command is ignored and will not have any effects on the current cycle. The Read Data command allows clock rates from DC to a maximum of  $f_R$  (see Section 4.8, AC Electrical Characteristics on page 25).

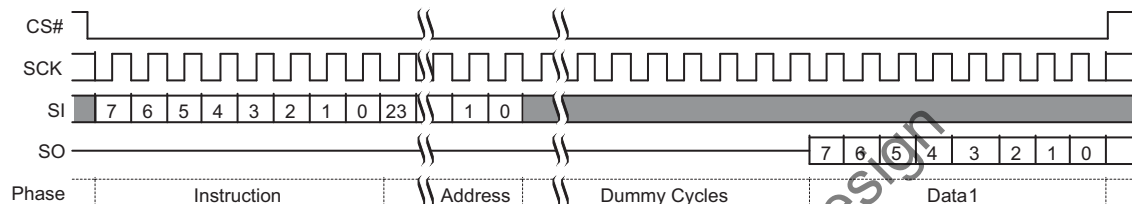
**Figure 45. Read Data Command Sequence**


### 8.3.2 Fast Read (0Bh)

The Fast Read command is similar to the Read Data command except that it can operate at higher frequency than the traditional Read Data command. This is accomplished by adding eight “dummy” clocks after the 24-bit address as shown in [Figure 46](#). The dummy clocks allow the device's internal circuits additional time for setting up the initial address. During the dummy clocks the data value on the SI pin is a “don't care.”

When variable read latency is enabled, the number of dummy cycles is set by the Latency Control value in SR3 to optimize the latency for the frequency in use. See [Table 30, Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V](#) on [page 57](#).

**Figure 46. Fast Read Command Sequence**



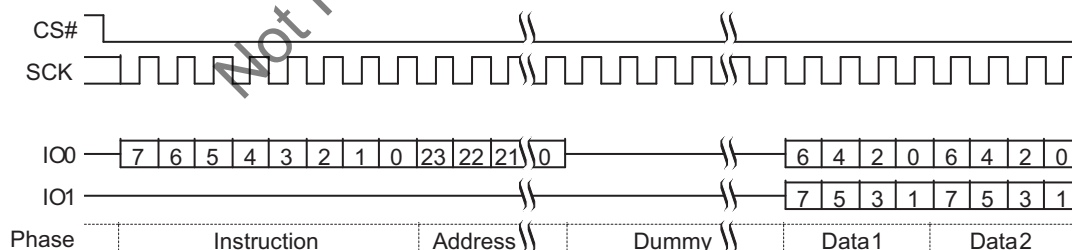
### 8.3.3 Fast Read Dual Output (3Bh)

The Fast Read Dual Output (3Bh) command is similar to the standard Fast Read (0Bh) command except that data is output on two pins; IO0 and IO1. This allows data to be transferred from the S25FL1-K at twice the rate of standard SPI devices. The Fast Read Dual Output command is ideal for quickly downloading code from flash to RAM upon power-up or for applications that cache code-segments to RAM for execution.

Similar to the Fast Read command, the Fast Read Dual Output command can operate at higher frequency than the traditional Read Data command. This is accomplished by adding eight “dummy” clocks after the 24-bit address as shown in [Figure 47](#). The dummy clocks allow the device's internal circuits additional time for setting up the initial address. The input data during the dummy clocks is “don't care.” However, the IO0 pin should be high-impedance prior to the falling edge of the first data out clock.

When variable read latency is enabled, the number of dummy cycles is set by the Latency Control value in SR3 to optimize the latency for the frequency in use. See [Table 30, Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V](#) on [page 57](#).

**Figure 47. Fast Read Dual Output Command Sequence**



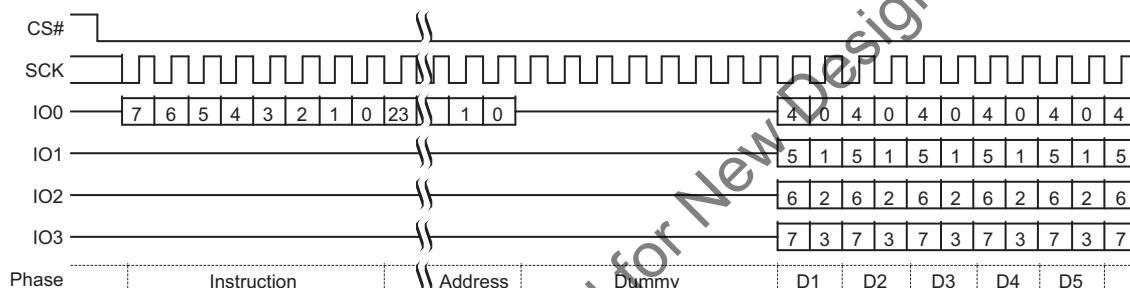
### 8.3.4 Fast Read Quad Output (6Bh)

The Fast Read Quad Output (6Bh) command is similar to the Fast Read Dual Output (3Bh) command except that data is output on four pins, IO0, IO1, IO2, and IO3. A Quad enable of Status Register-2 must be executed before the device will accept the Fast Read Quad Output Command (Status Register bit QE must equal 1). The Fast Read Quad Output Command allows data to be transferred from the S25FL1-K at four times the rate of standard SPI devices.

The Fast Read Quad Output command can operate at higher frequency than the traditional Read Data command. This is accomplished by adding eight “dummy” clocks after the 24-bit address as shown in Figure 48. The dummy clocks allow the device's internal circuits additional time for setting up the initial address. The input data during the dummy clocks is “don't care.” However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

When variable read latency is enabled, the number of dummy cycles is set by the Latency Control value in SR3 to optimize the latency for the frequency in use. See [Table 30, Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V on page 57](#).

**Figure 48. Fast Read Quad Output Command Sequence**



### 8.3.5 Fast Read Dual I/O (BBh)

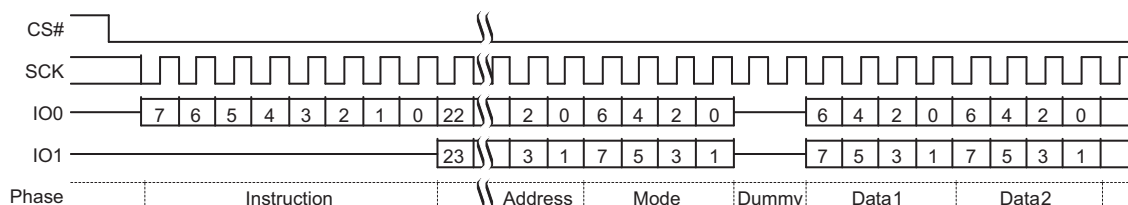
The Fast Read Dual I/O (BBh) command allows for improved random access while maintaining two IO pins, IO0 and IO1. It is similar to the Fast Read Dual Output (3Bh) command but with the capability to input the Address bits (A23-0) two bits per clock. This reduced command overhead may allow for code execution (XIP) directly from the Dual SPI in some applications.

#### Fast Read Dual I/O with “Continuous Read Mode”

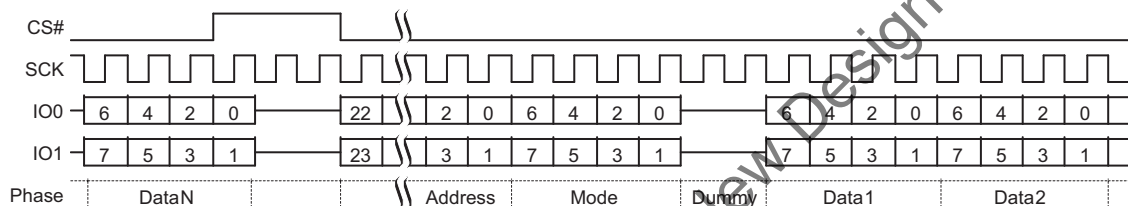
The Fast Read Dual I/O command can further reduce instruction overhead through setting the “Continuous Read Mode” bits (M7-0) after the input Address bits (A23-0), as shown in Figure 49. The upper nibble of the (M7-4) controls the length of the next Fast Read Dual I/O command through the inclusion or exclusion of the first byte instruction code. The lower nibble bits of the (M3-0) are don't care (“x”). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the “Continuous Read Mode” bits M5-4 = (1,0), then the next Fast Read Dual I/O command (after CS# is raised and then lowered) does not require the BBh instruction code, as shown in Figure 50. This reduces the command sequence by eight clocks and allows the Read address to be immediately entered after CS# is asserted low. If the “Continuous Read Mode” bits M5-4 do not equal to (1,0), the next command (after CS# is raised and then lowered) requires the first byte instruction code, thus returning to normal operation. A “Continuous Read Mode” Reset command can also be used to reset (M7-0) before issuing normal commands (see [See Continuous Read Mode Reset \(FFh or FFFFh\) on page 75](#)).

When variable read latency is enabled, the number of latency (Mode + Dummy) cycles is set by the Latency Control value in SR3 to optimize the latency for the frequency in use. See [Table 30, Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V on page 57](#). Note that the legacy Read Dual I/O command has four Mode cycles and no Dummy cycles for a total of four latency cycles. Enabling the variable read latency allows for the addition of more read latency to enable higher frequency operation of the Dual I/O command.

**Figure 49. Fast Read Dual I/O Command Sequence (Initial command or previous M5-4 ≠ 10)**

**Note:**

1. Least significant 4 bits of Mode are don't care and it is optional for the host to drive these bits. The host may turn off drive during these cycles to increase bus turn around time between Mode bits from host and returning data from the memory.

**Figure 50. Fast Read Dual I/O Command Sequence (Previous command set M5-4 = 10)**


### 8.3.6 Fast Read Quad I/O (EBh)

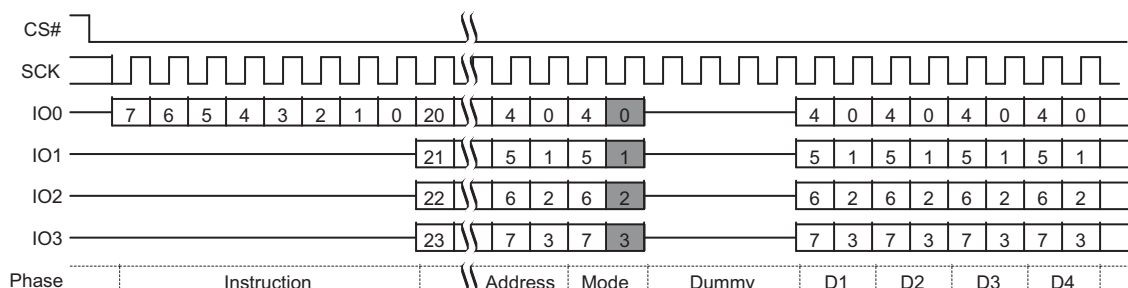
The Fast Read Quad I/O (EBh) command is similar to the Fast Read Dual I/O (BBh) command except that address and data bits are input and output through four pins IO0, IO1, IO2 and IO3 and four Dummy clock are required prior to the data output. The Quad I/O dramatically reduces instruction overhead allowing faster random access for code execution (XIP) directly from the Quad SPI. The Quad Enable bit (QE) of Status Register-2 must be set to enable the Fast Read Quad I/O Command.

#### Fast Read Quad I/O with “Continuous Read Mode”

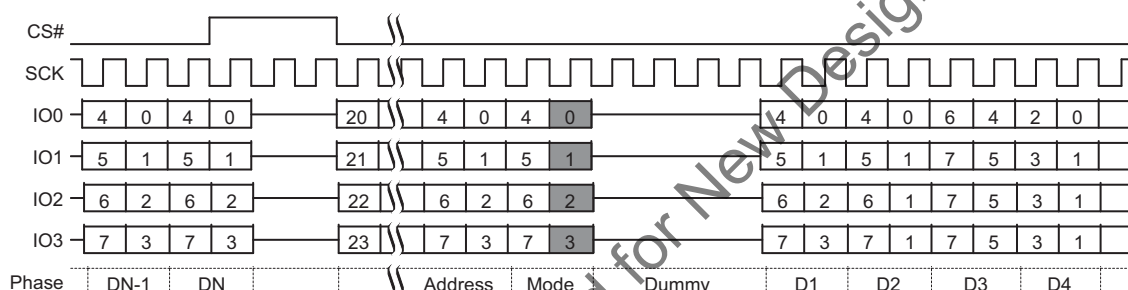
The Fast Read Quad I/O command can further reduce instruction overhead through setting the “Continuous Read Mode” bits (M7-0) after the input Address bits (A23-0), as shown in [Figure 51, Fast Read Quad I/O Command Sequence \(Initial command or previous M5-4 ≠ 10\) on page 74](#). The upper nibble of the (M7-4) controls the length of the next Fast Read Quad I/O command through the inclusion or exclusion of the first byte instruction code. The lower nibble bits of the (M3-0) are don't care (“x”). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the “Continuous Read Mode” bits M5-4 = (1,0), then the next Fast Read Quad I/O command (after CS# is raised and then lowered) does not require the EBh instruction code, as shown in [Figure 52, Fast Read Quad I/O Command Sequence \(Previous command set M5-4 = 10\) on page 74](#). This reduces the command sequence by eight clocks and allows the Read address to be immediately entered after CS# is asserted low. If the “Continuous Read Mode” bits M5-4 do not equal to (1,0), the next command (after CS# is raised and then lowered) requires the first byte instruction code, thus returning to normal operation. A “Continuous Read Mode” Reset command can also be used to reset (M7-0) before issuing normal commands (see [Section 8.4.3, Continuous Read Mode Reset \(FFh or FFFFh\) on page 75](#)).

When variable read latency is enabled, the number of latency (Mode + Dummy) cycles is set by the Latency Control value in SR3 to optimize the latency for the frequency in use. See [Table 30, Latency Cycles Versus Frequency for -40°C to 85°C/105°C at 2.7V to 3.6V on page 57](#). Note that the legacy Read Quad I/O command has two Mode cycles plus four Dummy cycles for a total of six latency cycles, Enabling the variable read latency allows for the addition of more read latency to enable higher frequency operation of the Quad I/O command.

**Figure 51. Fast Read Quad I/O Command Sequence (Initial command or previous M5-4 ≠ 10)**

**Note:**

1. Least significant 4 bits of Mode are don't care and it is optional for the host to drive these bits. The host may turn off drive during these cycles to increase bus turn around time between Mode bits from host and returning data from the memory.

**Figure 52. Fast Read Quad I/O Command Sequence (Previous command set M5-4 = 10)**

**Fast Read Quad I/O with “16 / 32 / 64-Byte Wrap Around”**

The Fast Read Quad I/O command can also be used to access a specific portion within a page by issuing a “Set Burst with Wrap” command prior to EBh. The “Set Burst with Wrap” command can either enable or disable the “Wrap Around” feature for the following EBh commands. When “Wrap Around” is enabled, the data being accessed can be limited to either a 16 / 32 / 64-byte section of data. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 16 / 32 / 64-byte section, the output will wrap around to the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (16 / 32 / 64-bytes) of data without issuing multiple read commands.

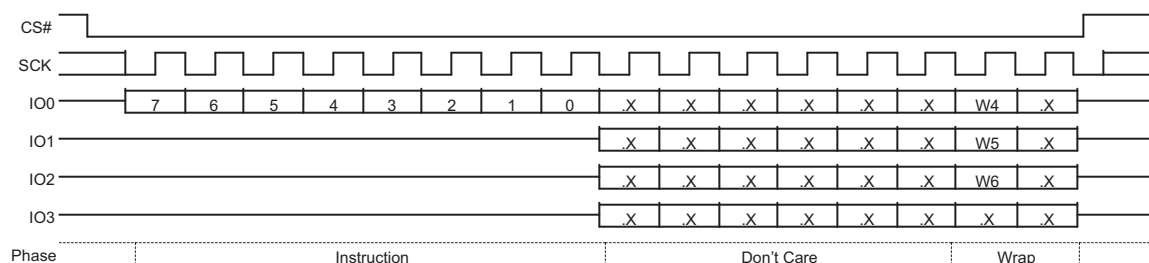
The “Set Burst with Wrap” command allows three “Wrap Bits”, W6-4 to be set. The W4 bit is used to enable or disable the “Wrap Around” operation while W6-5 are used to specify the length of the wrap around section within a page. See [Section 8.3.7, Set Burst with Wrap \(77h\) on page 74](#).

### 8.3.7 Set Burst with Wrap (77h)

The Set Burst with Wrap (77h) command is used in conjunction with “Fast Read Quad I/O” commands to access a fixed length and alignment of 8 / 16 / 32 / 64-bytes of data. Certain applications can benefit from this feature and improve the overall system code execution performance. This command loads the SR3 bits.

Similar to a Quad I/O command, the Set Burst with Wrap command is initiated by driving the CS# pin low and then shifting the instruction code “77h” followed by 24-dummy bits and 8 “Wrap Bits”, W7-0. The command sequence is shown in [Figure 53, Set Burst with Wrap Command Sequence on page 75](#). Wrap bit W7 and the lower nibble W3-0 are not used. See Status Register-3 (SR3[6:4]) for the encoding of W6-W4 in [Section 6.5, Status Registers on page 49](#).

Once W6-4 is set by a Set Burst with Wrap command, all the following “Fast Read Quad I/O” commands will use the W6-4 setting to access the 8 / 16 / 32 / 64-byte section of data. Note, Status Register-2 QE bit (SR2[1]) must be set to 1 in order to use the Fast Read Quad I/O and Set Burst with Wrap commands. To exit the “Wrap Around” function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4 = 1. The default value of W4 upon power on is 1. In the case of a system Reset while W4 = 0, it is recommended that the controller issues a Software Reset command or a Set Burst with Wrap command to reset W4 = 1 prior to any normal Read commands since S25FL1-K does not have a hardware Reset Pin.

**Figure 53. Set Burst with Wrap Command Sequence**


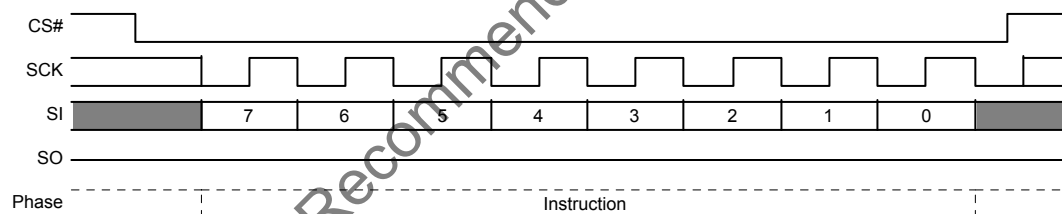
## 8.4 Reset Commands

Software controlled Reset commands restore the device to its initial power up state, by reloading volatile registers from non-volatile default values. If a software reset is initiated during a Erase, Program or writing of a Register operation the data in that Sector, Page or Register is not stable, the operation that was interrupted needs to be initiated again.

When the device is in Deep Power-Down mode it is protected from a software reset, the software reset commands are ignored and have no effect. To reset the device send the Release Power down command (ABh) and after time duration of  $t_{RES1}$  the device will resume normal operation and the Software reset commands will be accepted.

A software reset is initiated by the Software Reset Enable command (66h) followed by Software Reset command (99h) and then executed when CS# is brought high after  $t_{RCH}$  time at the end of the Software Reset instruction and requires  $t_{RST}$  time before executing the next Instruction after the Software Reset. See [Figure 27, Software Reset Input Timing on page 28](#)

**Note:** The  $t_{RCH}$  is a Cypress specific parameter and CS# must be brought high after  $t_{RCH}$  time, if not the Software Reset will not be executed.

**Figure 54. Software Reset Command Sequence**


### 8.4.1 Software Reset Enable (66h)

The Reset Enable (66h) command is required immediately before a software reset command (99h) such that a software reset is a sequence of the two commands. Any command other than Reset (99h) following the Reset Enable (66h) command, will clear the reset enable condition and prevent a later RST command from being recognized.

### 8.4.2 Software Reset (99h)

The Reset (99h) command immediately following a Reset Enable (66h) command, initiates the software reset process. Any command other than Reset (99h) following the Reset Enable (66h) command, will clear the reset enable condition and prevent a later Reset (99h) command from being recognized.

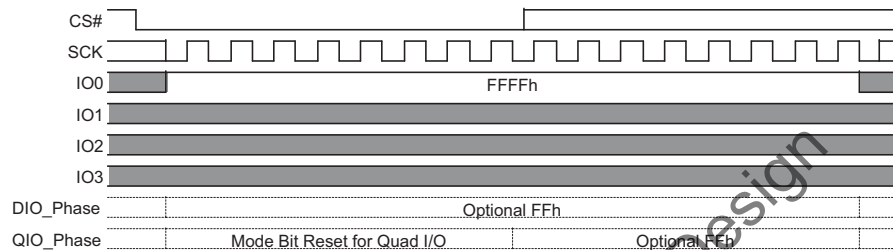
### 8.4.3 Continuous Read Mode Reset (FFh or FFFFh)

The "Continuous Read Mode" bits are used in conjunction with "Fast Read Dual I/O" and "Fast Read Quad I/O" commands to provide the highest random Flash memory access rate with minimum SPI instruction overhead, thus allowing more efficient XIP (execute in place) with this device family. A device that is in a continuous high performance read mode may not recognize any normal SPI command or the software reset command may not be recognized by the device. It is recommended to use the Continuous Read Mode Reset command after a system Power on Reset or, before sending a software reset, to ensure the device is released from continuous high performance read mode.

The “Continuous Read Mode” bits M7-0 are set by the Dual/Quad I/O Read commands. M5-4 are used to control whether the 8-bit SPI instruction code (BBh or EBh) is needed or not for the next command. When M5-4 = (1,0), the next command will be treated the same as the current Dual/Quad I/O Read command without needing the 8-bit instruction code; when M5-4 do not equal to (1,0), the device returns to normal SPI command mode, in which all commands can be accepted. M7-6 and M3-0 are reserved bits for future use, either 0 or 1 values can be used.

The Continuous Read Mode Reset command (FFh or FFFFh) can be used to set M4 = 1, thus the device will release the Continuous Read Mode and return to normal SPI operation, as shown in [Figure 55](#).

**Figure 55. Continuous Read Mode Reset for Fast Read Dual or Quad I/O**



**Notes:**

1. To reset “Continuous Read Mode” during Quad I/O operation, only eight clocks are needed. The instruction is “FFh”.
2. To reset “Continuous Read Mode” during Dual I/O operation, sixteen clocks are needed to shift in instruction “FFFFh”.

## 8.4.4 Host System Reset Commands

Since S25FL1-K does not have a hardware Reset pin, if the host system memory controller resets, without a complete power-down and power-up sequence, while an S25FL1-K device is set to Continuous Mode Read, the S25FL1-K device will not recognize any initial standard SPI commands from the controller. To address this possibility, it is recommended to issue a Continuous Read Mode Reset (FFFFh) command as the first command after a system Reset. Doing so will release the device from the Continuous Read Mode and allow Standard SPI commands to be recognized. See [Section 8.4.3, Continuous Read Mode Reset \(FFh or FFFFh\) on page 75](#).

If Burst Wrap Mode is used, it is also recommended to issue a Set Burst with Wrap (77h) command that sets the W4 bit to one as the second command after a system Reset. Doing so will release the device from the Burst Wrap Mode and allow standard sequential read SPI command operation. See [Section 8.3.7, Set Burst with Wrap \(77h\) on page 74](#).

Issuing these commands immediately after a non-power-cycle (warm) system reset, ensures the device operation is consistent with the power-on default device operation. The same commands may also be issued after device power-on (cold) reset so that system reset code is the same for warm or cold reset.

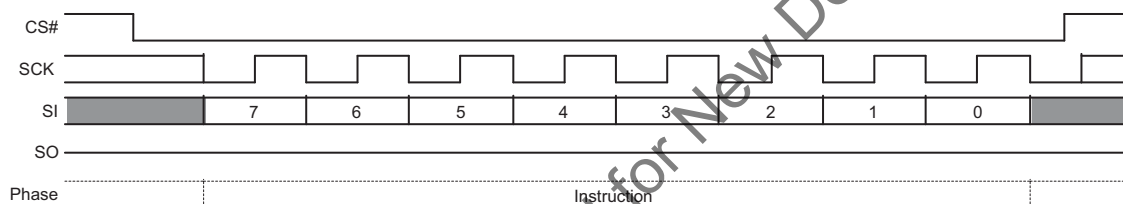
## 8.5 ID and Security Commands

### 8.5.1 Deep-Power-Down (B9h)

Although the standby current during normal operation is relatively low, standby current can be further reduced with the Deep-Power-Down command. The lower power consumption makes the Deep-Power-Down (DPD) command especially useful for battery powered applications (see  $I_{CC1}$  and  $I_{CC2}$  in [Section 4.8, AC Electrical Characteristics on page 25](#)). The command is initiated by driving the CS# pin low and shifting the instruction code “B9h” as shown in [Figure 56](#).

The CS# pin must be driven high after the eighth bit has been latched. If this is not done the Deep-Power-Down command will not be executed. After CS# is driven high, the power-down state will entered within the time duration of  $t_{DP}$  ([Section 4.8, AC Electrical Characteristics on page 25](#)). While in the power-down state only the Release from Deep-Power-Down / Device ID command, which restores the device to normal operation, will be recognized. All other commands are ignored. This includes the Read Status Register command, which is always available during normal operation. Ignoring all but one command also makes the Power Down state a useful condition for securing maximum write protection. The device always powers-up in the normal operation with the standby current of  $I_{CC1}$ .

**Figure 56. Deep Power-Down Command Sequence**



### 8.5.2 Release from Deep-Power-Down / Device ID (ABh)

The Release from Deep-Power-Down / Device ID command is a multi-purpose command. It can be used to release the device from the deep-power-down state, or obtain the devices electronic identification (ID) number.

To release the device from the deep-power-down state, the command is issued by driving the CS# pin low, shifting the instruction code “ABh” and driving CS# high as shown in [Figure 57](#). Release from deep-power-down will take the time duration of  $t_{RES1}$  ([Section 4.8, AC Electrical Characteristics on page 25](#)) before the device will resume normal operation and other commands are accepted. The CS# pin must remain high during the  $t_{RES1}$  time duration.

When used only to obtain the Device ID while not in the deep power-down state, the command is initiated by driving the CS# pin low and shifting the instruction code “ABh” followed by 3-dummy bytes. The Device ID bits are then shifted out on the falling edge of SCK with most significant bit (MSB) first. The Device ID values for the S25FL1-K is listed in [Section 6.6.1, Legacy Device Identification Commands on page 59](#). The Device ID can be read continuously. The command is completed by driving CS# high.

When used to release the device from the deep-power-down state and obtain the Device ID, the command is the same as previously described, and shown in [Figure 58](#), except that after CS# is driven high it must remain high for a time duration of  $t_{RES2}$ . After this time duration the device will resume normal operation and other commands will be accepted. If the Release from Deep-Power-Down / Device ID command is issued while an Erase, Program or Write cycle is in process (when BUSY equals 1) the command is ignored and will not have any effects on the current cycle.

**Figure 57. Release from Deep-Power-Down Command Sequence**

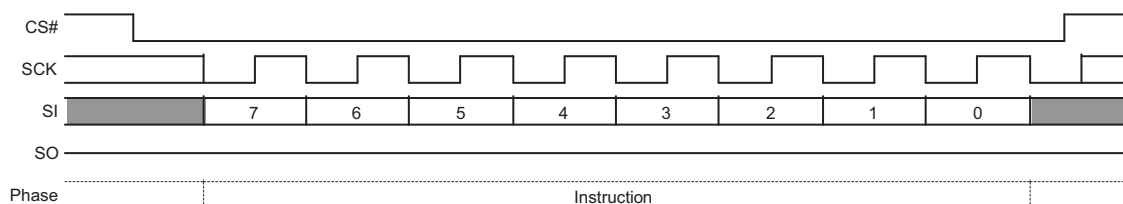
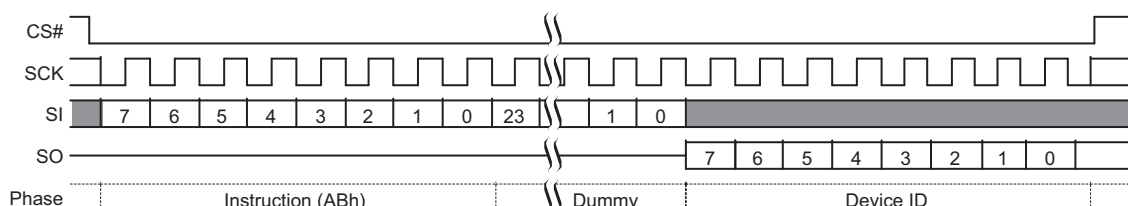
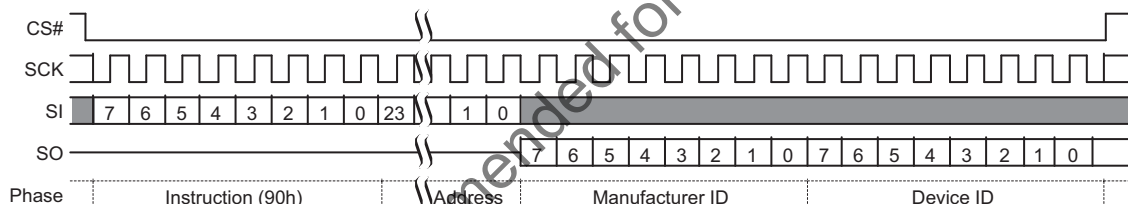


**Figure 58. Read Electronic Signature (RES ABh) Command Sequence**


### 8.5.3 Read Manufacturer / Device ID (90h)

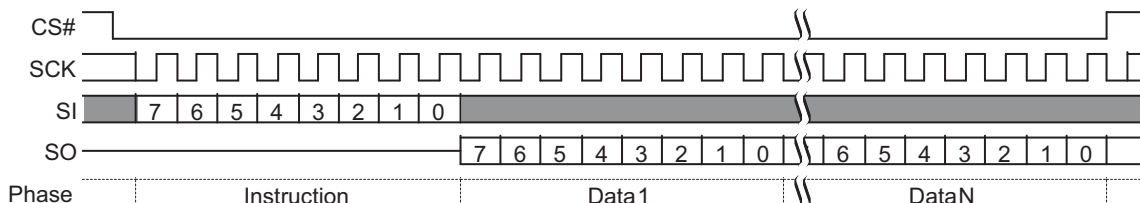
The Read Manufacturer / Device ID command is an alternative to the Release from Deep-Power-Down / Device ID command that provides both the JEDEC assigned manufacturer ID and the specific device ID.

The Read Manufacturer / Device ID command is very similar to the Release from Deep-Power-Down / Device ID command. The command is initiated by driving the CS# pin low and shifting the instruction code “90h” followed by a 24-bit address (A23-A0) of 000000h. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCK with most significant bit (MSB) first as shown in Figure 59. The Device ID values for the S25FL1-K is listed in Section 6.6.1, Legacy Device Identification Commands on page 59. If the 24-bit address is initially set to 000001h the Device ID will be read first and then followed by the Manufacturer ID. The Manufacturer and Device IDs can be read continuously, alternating from one to the other. The command is completed by driving CS# high.

**Figure 59. READ\_ID (90h) Command Sequence**


### 8.5.4 Read JEDEC ID (9Fh)

For compatibility reasons, the S25FL1-K provides several commands to electronically determine the identity of the device. The Read JEDEC ID command is compatible with the JEDEC standard for SPI compatible serial flash memories that was adopted in 2003. The command is initiated by driving the CS# pin low and shifting the instruction code “9Fh”. The JEDEC assigned Manufacturer ID byte and two Device ID bytes, Memory Type (ID15-ID8) and Capacity (ID7-ID0) are then shifted out on the falling edge of SCK with most significant bit (MSB) first as shown in Figure 60. For memory type and capacity values refer to Section 6.6.1, Legacy Device Identification Commands on page 59.

**Figure 60. Read JEDEC ID Command Sequence**


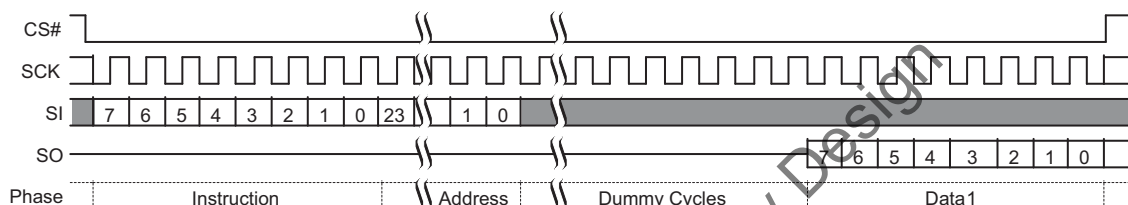
### 8.5.5 Read SFDP Register / Read Unique ID Number (5Ah)

The Read SFDP command is initiated by driving the CS# pin low and shifting the instruction code “5Ah” followed by a 24-bit address (A23-A0) into the SI pin. Eight “dummy” clocks are also required before the SFDP register contents are shifted out on the falling edge of the 40th SCK with most significant bit (MSB) first as shown in [Figure 61](#). For SFDP register values and descriptions, refer to [Table 6.6.2, Serial Flash Discoverable Parameters \(SFDP\)](#) on page 59.

**Note:** A23-A8 = 0; A7-A0 are used to define the starting byte address for the 256-byte SFDP Register.

The 5Ah command can also be used to access the Read Unique ID Number. This is a factory-set read-only 8-byte number that is unique to each S25FL1-K device. The ID number can be used in conjunction with user software methods to help prevent copying or cloning of a system.

**Figure 61. Read SFDP Register Command Sequence**



### 8.5.6 Erase Security Registers (44h)

The Erase Security Register command is similar to the Sector Erase command. A Write Enable command must be executed before the device will accept the Erase Security Register Command (Status Register bit WEL must equal 1). The command is initiated by driving the CS# pin low and shifting the instruction code “44h” followed by a 24-bit address (A23-A0) to erase one of the security registers.

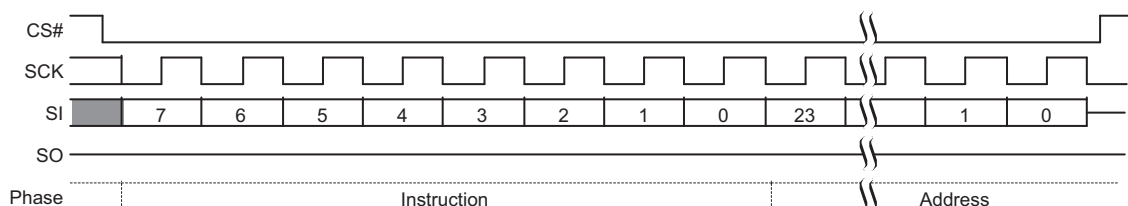
| Address             | A23-16 | A15-8 | A7-0 |
|---------------------|--------|-------|------|
| Security Register-1 | 00h    | 10h   | xxh  |
| Security Register-2 | 00h    | 20h   | xxh  |
| Security Register-3 | 00h    | 30h   | xxh  |

**Note:**

1. Addresses outside the ranges in the table have undefined results.

The Erase Security Register command sequence is shown in [Figure 62](#). The CS# pin must be driven high after the eighth bit of the last byte has been latched. If this is not done the command will not be executed. After CS# is driven high, the self-timed Erase Security Register operation will commence for a time duration of  $t_{SE}$  (see [Section 4.8, AC Electrical Characteristics](#) on page 25). While the Erase Security Register cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Erase Security Register cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Security Register Lock Bits (LB3:1) in the Status Register-2 can be used to OTP protect the security registers. Once a lock bit is set to 1, the corresponding security register will be permanently locked, and an Erase Security Register command to that register will be ignored (see [Security Register Lock Bits \(LB3, LB2, LB1, LB0\)](#) on page 57).

**Figure 62. Erase Security Registers Command Sequence**



### 8.5.7 Program Security Registers (42h)

The Program Security Register command is similar to the Page Program command. It allows from one byte to 256 bytes of security register data to be programmed at previously erased (FFh) memory locations. A Write Enable command must be executed before the device will accept the Program Security Register Command (Status Register bit WEL = 1). The command is initiated by driving the CS# pin low then shifting the instruction code "42h" followed by a 24-bit address (A23-A0) and at least one data byte, into the SI pin. The CS# pin must be held low for the entire length of the command while data is being sent to the device.

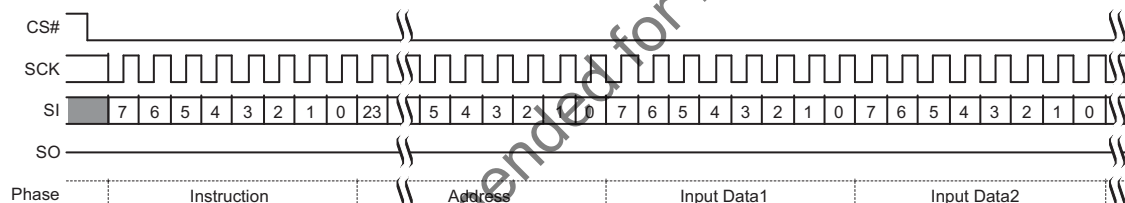
| Address             | A23-16 | A15-8 | A7-0         |
|---------------------|--------|-------|--------------|
| Security Register-1 | 00h    | 10h   | Byte Address |
| Security Register-2 | 00h    | 20h   | Byte Address |
| Security Register-3 | 00h    | 30h   | Byte Address |

**Note:**

1. Addresses outside the ranges in the table have undefined results.

The Program Security Register command sequence is shown in Figure 63. The Security Register Lock Bits (LB3:1) in the Status Register-2 can be used to OTP protect the security registers. Once a lock bit is set to 1, the corresponding security register will be permanently locked, and a Program Security Register command to that register will be ignored (see [Security Register Lock Bits \(LB3, LB2, LB1, LB0\)](#) on page 57 and [Page Program \(02h\)](#) on page 67 for detail descriptions).

**Figure 63. Program Security Registers Command Sequence**



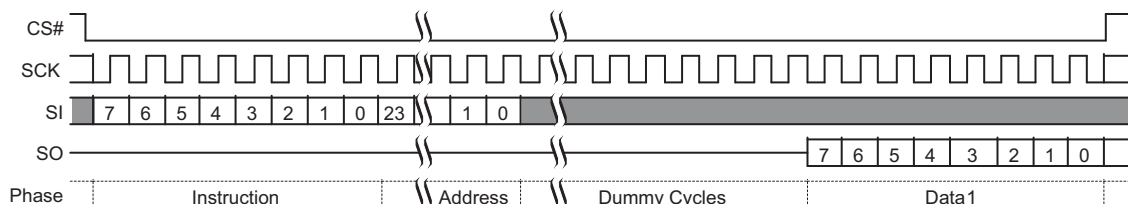
### 8.5.8 Read Security Registers (48h)

The Read Security Register command is similar to the Fast Read command and allows one or more data bytes to be sequentially read from one of the three security registers. The command is initiated by driving the CS# pin low and then shifting the instruction code "48h" followed by a 24-bit address (A23-A0) and eight "dummy" clocks into the SI pin. The code and address bits are latched on the rising edge of the SCK pin. After the address is received, and following the eight dummy cycles, the data byte of the addressed memory location will be shifted out on the SO pin at the falling edge of SCK with most significant bit (MSB) first. Locations with address bits A23-A16 not equal to zero, have undefined data. The byte address is automatically incremented to the next byte address after each byte of data is shifted out. Once the byte address reaches the last byte of the register (byte FFh), it will reset to 00h, the first byte of the register, and continue to increment. The command is completed by driving CS# high. The Read Security Register command sequence is shown in Figure 64. If a Read Security Register command is issued while an Erase, Program, or Write cycle is in process (BUSY=1), the command is ignored and will not have any effects on the current cycle. The Read Security Register command allows clock rates from DC to a maximum of  $F_R$  (see [Section 4.8, AC Electrical Characteristics](#) on page 25).

| Address                    | A23-16 | A15-8 | A7-0         |
|----------------------------|--------|-------|--------------|
| Security Register-0 (SFDP) | 00h    | 00h   | Byte Address |
| Security Register-1        | 00h    | 10h   | Byte Address |
| Security Register-2        | 00h    | 20h   | Byte Address |
| Security Register-3        | 00h    | 30h   | Byte Address |

**Note:**

1. Addresses outside the ranges in the table have undefined results.

**Figure 64. Read Security Registers Command Sequence**


## 8.6 Set Block / Pointer Protection (39h) — S25FL132K and S25FL164K

The user has a choice to enable one of two protection mechanisms: block protection or pointer protection. Only one protection mechanism can be enabled at one time.

The Set Block / Pointer Protection (39h) is a new command (see Figure 65) and is used to determine which one of the two protection mechanisms is enabled, and if the pointer protection mechanism is enabled, determines the pointer address. The Write Enable command must precede the Set Block / Pointer command.

After the Set Block / Pointer Protection command is given, the value of A10 in byte 3 selects whether the block protection or the pointer protection mechanism will be enabled. If A10 = 1, then the block protection mode is enabled. This is the default state, and the rest of pointer values are don't care. If A10=0, then the pointer protection is enabled, and the block protection feature is disabled. The pointer address values A9 to A0 are don't care.

If the pointer protection mechanism is enabled, a pointer address determines the boundary between the protected and the unprotected regions in the memory. The format of the Set Pointer command is the 39h instruction followed by three address bytes. For the S25FL132K, ten address bits (A21-A12) after the 39h command are used to program the non-volatile pointer address. For the 32M, A23 – A22 are don't care. For the S25FL164K, eleven address bits (A22-A12) after the 39h command are used to program the non-volatile pointer address. For the 64M, A23 is a don't care.

The A11 bit can be used to protect all sectors. If A11=1, then all sectors are protected, and A23 – A12 are don't cares. If A11=0, then the unprotected range will be determined by A22-A12 for the 64M and A21-A12 for the 32M. The area that is unprotected will be inclusive of the 4-kB sector selected by the pointer address.

Bit 5 (Top / Bottom) of SR1 is used to determine whether the region that will be unprotected will start from the top (highest address) or bottom (lowest address) of the memory array to the location of the pointer. If TB=0 and the 39h command is issued followed by a 24-bit address, then the 4-kB sector which includes that address and all the sectors from the bottom up (zero to higher address) will be unprotected. If TB=1 and 39h command is issued followed by a 24-bit address then the 4-kB sector which includes that address and all the sectors from the Top down (max to lower address) will be unprotected.

The SRP1 (SR2 [0]) and SRP0 (SR1 [7]) bits are used to protect the pointer address in the same way they protect SR1 and SR2. When SRP1 and SRP0 protect SR1 and SR2, the 39h command is ignored. This effectively prevents changes to the protection scheme using the existing SRP1-SRP0 mechanism – including the OTP protection option.

The 39h command is ignored during a suspend operation because the pointer address cannot be erased and re-programmed during a suspend.

The Read Status Register-3 command 39h (see Figure 34 for 39h timing diagram) reads the contents of SR3 followed by the contents of the pointer. This allows the contents of the pointer to be read out for test and verification. The read back order is SR3, A23-A16, A15-A8. If CS# remains low, the Bytes after A15-A8 are undefined.

| TB | A11 | A10 | Protect Address Range    | Unprotect Address Range  | Comment                                                                                                                                                                                                   |
|----|-----|-----|--------------------------|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| x  | x   | 1   | See Block Protect Method | See Block Protect Method | A10 = 1 the block protect protection mode is enabled (this is the default state and the rest of pointer address is don't care).                                                                           |
| 0  | 0   | 0   | Amax (1) to (A<22-12>+1) | A<22-12> (2) to 000000   | If TB=0 and the 39h command is issued followed by a 24-bit address, then the 4-kB sector which includes that address and all the sectors from the bottom up (zero to higher address) will be unprotected. |
| 1  | 0   | 0   | (A<22-12>-1) to 000000   | Amax (1) to A<22-12>     | If TB=1 and 39h command is issued followed by a 24-bit address then the 4-kB sector which includes that address and all the sectors from the Top down (max to lower address) will be unprotected.         |
| x  | 1   | 0   | Amax (1) to 000000       | Not Applicable           | A10=0 and A11 =1 means protect all sectors and Amax-A12 are don't care.                                                                                                                                   |

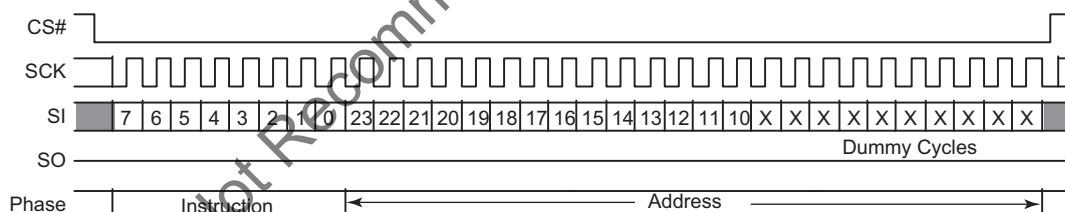
**Notes:**

1. Amax = 7FFFFFFh for the FL164K, and 3FFFFFFh for the FL132K.

2. A<21-12> for the FL132K.

Block Erase: In general, if the pointer protect scheme is active (A10=0), protect all sectors is not active (A11=0), and the pointer address points to anywhere within the block, the whole block will be protected from Block Erase even though part of the block is unprotected. The 2 exceptions where block erase goes through is if the pointer address points to the TOP sector of the block (A[15:12]=1111) if TB=0, and if the pointer points to the BOTTOM sector of the block (A[15:12]=0000) and TB=1.

**Figure 65. Set Pointer Address (39h)**



## 9. Data Integrity

### 9.1 Erase Endurance

**Table 37. Erase Endurance**

| Parameter                                                               | Min  | Unit     |
|-------------------------------------------------------------------------|------|----------|
| Program/Erase cycles main Flash array sector                            | 100K | PE cycle |
| Program/Erase cycles Security Registers non-volatile register array (1) | 1K   | PE cycle |

**Note:**

- Each write command to a non-volatile register causes a PE cycle on the entire non-volatile register array. Re-writing registers with the same value doesn't cause a PE cycle. OTP bits in registers internally reside in a separate array that is not cycled.

### 9.2 Data Retention

| Parameter           | Test Conditions           | Minimum Time | Unit  |
|---------------------|---------------------------|--------------|-------|
| Data Retention Time | 10K Program/Erase Cycles  | 20           | Years |
|                     | 100K Program/Erase Cycles | 2            | Years |

### 9.3 Initial Delivery State

The device is shipped from Cypress with non-volatile bits / default states set as follows:

- The entire memory array is erased: i.e. all bits are set to 1 (each byte contains FFh).
- The Unique Device ID is programmed to a random number seeded by the date and time of device test.
- The SFDP Security Register address space 0 contains the values as defined in [Table 6.6.2, Serial Flash Discoverable Parameters \(SFDP\) on page 59](#). Security Register address spaces 1 to 3 are erased: i.e. all bits are set to 1 (each byte contains FFh).
- Status Register-1 contains 00h.
- Status Register-2 contains 04h.
- Status Register-3 contains 70h.

## 10. Ordering Information

The ordering part number is formed by a valid combination of the following:

| S25FL1 | 32 | K | 0X | M | F | I | 01 | 1 |                                                                                  |
|--------|----|---|----|---|---|---|----|---|----------------------------------------------------------------------------------|
|        |    |   |    |   |   |   |    |   | <b>Packing Type</b>                                                              |
|        |    |   |    |   |   |   |    |   | 0 = Tray                                                                         |
|        |    |   |    |   |   |   |    |   | 1 = Tube                                                                         |
|        |    |   |    |   |   |   |    |   | 3 = 13" Tape and Reel                                                            |
|        |    |   |    |   |   |   |    |   | <b>Model Number (Additional Ordering Options)</b>                                |
|        |    |   |    |   |   |   |    |   | 00 = 16-lead SO package (300 mil)                                                |
|        |    |   |    |   |   |   |    |   | 01 = 8-lead SO package (208 mil) / 8-contact WSON                                |
|        |    |   |    |   |   |   |    |   | 02 = 5 x 5 ball BGA package                                                      |
|        |    |   |    |   |   |   |    |   | 03 = 4 x 6 ball BGA package (208 mil)                                            |
|        |    |   |    |   |   |   |    |   | 04 = 8-lead SO package (150 mil) / 8-contact USON (4 mm x 4 mm)                  |
|        |    |   |    |   |   |   |    |   | Q1 = 8-lead SO package (208 mil) / 8-contact WSON<br>(Default quad mode enabled) |
|        |    |   |    |   |   |   |    |   | <b>Temperature Range</b>                                                         |
|        |    |   |    |   |   |   |    |   | I = Industrial (-40°C to +85°C)                                                  |
|        |    |   |    |   |   |   |    |   | V = Industrial Plus (-40°C to +105°C)                                            |
|        |    |   |    |   |   |   |    |   | A = Automotive, AEC-Q100 Grade 3 (-40°C to +85°C)                                |
|        |    |   |    |   |   |   |    |   | B = Automotive, AEC-Q100 Grade 2 (-40°C to +105°C)                               |
|        |    |   |    |   |   |   |    |   | <b>Package Materials</b>                                                         |
|        |    |   |    |   |   |   |    |   | F = Lead (Pb)-free, Halogen-free                                                 |
|        |    |   |    |   |   |   |    |   | H = Low-halogen, Lead (Pb)-free                                                  |
|        |    |   |    |   |   |   |    |   | <b>Package Type</b>                                                              |
|        |    |   |    |   |   |   |    |   | M = 8-lead / 16-lead SO package                                                  |
|        |    |   |    |   |   |   |    |   | N = 8-contact WSON/USON package                                                  |
|        |    |   |    |   |   |   |    |   | B = 24-ball 6 x 8 mm BGA package, 1.0 mm pitch                                   |
|        |    |   |    |   |   |   |    |   | <b>Speed</b>                                                                     |
|        |    |   |    |   |   |   |    |   | 0X = 108 MHz                                                                     |
|        |    |   |    |   |   |   |    |   | <b>Device Technology</b>                                                         |
|        |    |   |    |   |   |   |    |   | K = 90 nm floating gate process technology                                       |
|        |    |   |    |   |   |   |    |   | <b>Density</b>                                                                   |
|        |    |   |    |   |   |   |    |   | 16 = 16 Mbits                                                                    |
|        |    |   |    |   |   |   |    |   | 32 = 32 Mbits                                                                    |
|        |    |   |    |   |   |   |    |   | 64 = 64 Mbits                                                                    |
|        |    |   |    |   |   |   |    |   | <b>Device Family</b>                                                             |
|        |    |   |    |   |   |   |    |   | S25FL1                                                                           |
|        |    |   |    |   |   |   |    |   | Cypress Memory 3.0 Volt-Only, Serial Peripheral Interface (SPI) Flash Memory     |

**Valid Combinations — Standard**

Table 38 lists standard configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

**Table 38. Valid Combinations for Standard Part Numbers**

| Base Ordering Part Number | Speed Option | Package and Temperature | Model Number | Packing Type | Package Marking |
|---------------------------|--------------|-------------------------|--------------|--------------|-----------------|
| FL116K                    | 0X           | MFI                     | 01           | 0, 1, 3      | FL116KIF01      |
|                           |              |                         | Q1           |              | FL116KIFQ1      |
|                           |              |                         | 04           |              | FL116KIF4       |
|                           |              | MFV                     | 01           |              | FL116KVF01      |
|                           |              |                         | 04           |              | FL116KVF4       |
|                           |              | NFI                     | 01           |              | FL116KIF01      |
|                           |              |                         | Q1           |              | FL116KIFQ1      |
|                           |              | NFV                     | 01           |              | FL116KVF01      |
|                           |              |                         | 02           | 0, 3         | FL116KIH02      |
|                           |              | BHI                     | 03           |              | FL116KIH03      |
|                           |              |                         | 02           |              | FL116KVH02      |
|                           |              | BHV                     | 03           |              | FL116KVH03      |
| FL132K                    | 0X           | MFI                     | 01           | 0, 1, 3      | FL132KIF01      |
|                           |              |                         | 04           |              | FL132KIF4       |
|                           |              |                         | Q1           |              | FL132KIFQ1      |
|                           |              | MFV                     | 01           |              | FL132KVF01      |
|                           |              |                         | 04           |              | FL132KVF4       |
|                           |              | NFI                     | 01           |              | FL132KIF01      |
|                           |              |                         | 04           |              | FL132KIF04      |
|                           |              | NFV                     | Q1           |              | FL132KIFQ1      |
|                           |              |                         | 01           |              | FL132KVF01      |
|                           |              | BHI                     | 04           | 0, 3         | FL132KVF04      |
|                           |              |                         | 02           |              | FL132KIH02      |
|                           |              | BHV                     | 03           |              | FL132KIH03      |
| FL164K                    | 0X           | MFI                     | 02           |              | FL132KVH02      |
|                           |              |                         | 03           |              | FL132KVH03      |
|                           |              |                         | 02           |              | FL164KIF00      |
|                           |              | MFV                     | 03           | 0, 1, 3      | FL164KIF01      |
|                           |              |                         | 00           |              | FL164KIFQ1      |
|                           |              | NFI                     | Q1           |              | FL164KIFQ1      |
|                           |              |                         | 00           |              | FL164KVF00      |
|                           |              | NFV                     | 01           |              | FL164KVF01      |
|                           |              |                         | 01           |              | FL164KIF01      |
|                           |              | BHI                     | Q1           |              | FL164KIFQ1      |
|                           |              |                         | 01           |              | FL164KVF01      |
|                           |              | BHV                     | 02           | 0, 3         | FL164KIH02      |
|                           |              |                         | 03           |              | FL164KIH03      |
|                           |              | BHV                     | 02           |              | FL164KVH02      |
|                           |              |                         | 03           |              | FL164KVH03      |

**Valid Combinations — Automotive Grade / AEC-Q100**

The table below lists configurations that are Automotive Grade / AEC-Q100 qualified and are planned to be available in volume. The table will be updated as new combinations are released. Consult your local sales representative to confirm availability of specific combinations and to check on newly released combinations.

Production Part Approval Process (PPAP) support is only provided for AEC-Q100 grade products.

Products to be used in end-use applications that require ISO/TS-16949 compliance must be AEC-Q100 grade products in combination with PPAP. Non-AEC-Q100 grade products are not manufactured or documented in full compliance with ISO/TS-16949 requirements.

AEC-Q100 grade products are also offered without PPAP support for end-use applications that do not require ISO/TS-16949 compliance.

**Table 39. Valid Combinations — Automotive Grade / AEC-Q100**

| Base Ordering Part Number | Speed Option | Package and Temperature | Model Number | Packing Type | Package Marking |
|---------------------------|--------------|-------------------------|--------------|--------------|-----------------|
| FL116K                    | 0X           | MFA                     | 01           | 0, 1, 3      | FL116KAF01      |
|                           |              |                         | Q1           |              | FL116KAFQ1      |
|                           |              |                         | 04           |              | FL116KAF4       |
|                           |              | MFB                     | 01           |              | FL116KBF01      |
|                           |              |                         | 04           |              | FL116KBF4       |
|                           |              | NFA                     | 01           |              | FL116KAF01      |
|                           |              |                         | Q1           |              | FL116KAFQ1      |
|                           |              | NFB                     | 01           |              | FL116KBF01      |
|                           |              | BHA<br>BHB              | 02           | 0, 3         | FL116KAH02      |
|                           |              |                         | 03           |              | FL116KAH03      |
|                           |              |                         | 02           |              | FL116KBH02      |
|                           |              |                         | 03           |              | FL116KBH03      |
| FL132K                    | 0X           | MFB                     | 01           | 0, 1, 3      | FL132KBF01      |
|                           |              |                         | 04           |              | FL132KBF4       |
|                           |              | NFA                     | 01           |              | FL132KAF01      |
|                           |              |                         | 04           |              | FL132KAF04      |
|                           |              |                         | Q1           |              | FL132KAFQ1      |
|                           |              | NFB                     | 01           |              | FL132KBF01      |
|                           |              |                         | 04           |              | FL132KBF04      |
|                           |              | BHA                     | 02           | 0, 3         | FL132KAH02      |
|                           |              |                         | 03           |              | FL132KAH03      |
|                           |              | BHB                     | 02           |              | FL132KBH02      |
|                           |              |                         | 03           |              | FL132KBH03      |
| FL164K                    | 0X           | MFB                     | Q1           | 0, 1, 3      | FL164KAFQ1      |
|                           |              | BHA                     | 02           | 0, 3         | FL164KAH02      |
|                           |              |                         | 03           |              | FL164KAH03      |
|                           |              | BHB                     | 02           |              | FL164KBH02      |
|                           |              |                         | 03           |              | FL164KBH03      |
|                           |              |                         |              |              |                 |

## 11. Revision History

### Document History Page

| Document Title: S25FL116K/S25FL132K/S25FL164K, 16-Mbit (2 Mbyte)/32-Mbit (4 Mbyte)/64-Mbit (8 Mbyte), 3.0 V, SPI Flash Memory<br>Document Number: 002-00497 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                                                                                        | ECN No. | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| **                                                                                                                                                          | —       | ASPA            | 04/14/2014      | Initial release<br>Combined S25FL116K_00_06 and S25FL132K_164K_00_05<br>Global: Promoted data sheet from Preliminary to Full Production<br>Added 125°C option                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| *A                                                                                                                                                          | —       | ASPA            | 10/10/2014      | Migration Notes: FL Generations Comparison table: corrected Sector Erase Time (typ.) for S25FL1-K<br>AC Electrical Characteristics: AC Electrical Characteristics — -40°C to +85°C/105°C at 2.7V to 3.6V table: added tRCH and tRST<br>Input / Output Timing: added Software Reset Input Timing figure<br>Physical Interface: Corrected figure: 8-Contact WSON (5 mm x 6 mm) Package<br>Security Register 0 — Serial Flash Discoverable Parameters (SFDP — JEDEC JESD216B): Updated section based on revised JEDEC JESD216B spec<br>Commands: Added Command Set (Reset Commands) table<br>Reset Commands: Added sections: Reset Commands, Software Reset Enable (66h), Software Reset (99h)<br>Updated section: Continuous Read Mode Reset (FFh or FFFFh)                                                                                                                                                                                                                                                                                                                                                                                                                              |
| *B                                                                                                                                                          | —       | ASPA            | 12/04/2014      | Power-Up Timing: Power-Up Timing and Voltage Levels table: corrected TPUW<br>Valid Combinations: Valid Combinations table: corrected FL116K Model Number and Package Marking                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| *C                                                                                                                                                          | 4891479 | BWHA            | 09/18/2015      | Updated to Cypress template.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| *D                                                                                                                                                          | 5044503 | BWHA            | 12/18/2015      | Added "USON 4 mm x 4 mm" package related information in all instances across the document.<br>Updated <a href="#">Features</a> :<br>Updated Package Options.<br>Updated <a href="#">Physical Interface</a> :<br>Updated <a href="#">Connection Diagrams</a> :<br>Updated <a href="#">SOIC 8</a> :<br>Updated <a href="#">Figure 28</a> .<br>Updated <a href="#">SOIC 16 — S25FL164K</a> :<br>Updated <a href="#">Figure 29</a> .<br>Updated <a href="#">WSON 8</a> :<br>Updated <a href="#">Figure 30</a> .<br>Updated <a href="#">FAB024 24-Ball BGA</a> :<br>Updated <a href="#">Figure 31</a> .<br>Updated <a href="#">FAC024 24-Ball BGA Package</a> :<br>Updated <a href="#">Figure 32</a> .<br>Updated <a href="#">Physical Diagrams</a> :<br>Added <a href="#">UNF008 — 8-Contact USON 4 mm x 4 mm</a> .<br>Updated <a href="#">Ordering Information</a> :<br>Added "Halogen-free" for "F" under "Package Materials".<br>Added Note "GT grade is Cypress's quality and reliability rating to indicate products that are tested to meet <10 ppm and intended for high reliability applications such as automotive." and referred the same note in "A" under "Temperature Range". |

**Document History Page (Continued)**

**Document Title:** S25FL116K/S25FL132K/S25FL164K, 16-Mbit (2 Mbyte)/32-Mbit (4 Mbyte)/64-Mbit (8 Mbyte), 3.0 V, SPI Flash Memory  
**Document Number:** 002-00497

| Rev. | ECN No. | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|------|---------|-----------------|-----------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| *E   | 5270099 | BWHA            | 06/29/2016      | Added <a href="#">Logic Block Diagram</a> .<br>Updated <a href="#">Electrical Characteristics</a> :<br>Added <a href="#">Thermal Resistance</a> .<br>Updated <a href="#">Data Integrity</a> :<br>Removed "Endurance".<br>Added <a href="#">Data Retention</a> .<br>Updated <a href="#">Ordering Information</a> :<br>Updated <a href="#">Valid Combinations — Automotive Grade / AEC-Q100</a> :<br>Updated <a href="#">Table 39</a> :<br>Added a column "Model Number".<br>Added a row under "FL164K" and added "MFB" and its corresponding details.<br>Updated to new template.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| *F   | 5645494 | BWHA            | 02/28/2017      | Updated <a href="#">Signal Descriptions</a> :<br>Updated <a href="#">Input / Output Summary</a> :<br>Update <a href="#">Table 2</a> :<br>Updated details in "Description" column corresponding to "DNU".<br>Updated <a href="#">Electrical Characteristics</a> :<br>Updated <a href="#">Operating Ranges</a> :<br>Updated <a href="#">Table 7</a> :<br>Removed Extended Temperature range related information.<br>Updated <a href="#">AC Electrical Characteristics</a> :<br>Updated <a href="#">Table 12</a> :<br>Added "t <sub>CS</sub> " parameter and its details.<br>Updated <a href="#">Physical Interface</a> :<br>Updated <a href="#">Physical Diagrams</a> :<br>Updated <a href="#">SOA008 — 8-Lead Plastic Small Outline Package (150-mils Body Width)</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">SOC008 — 8-Lead Plastic Small Outline Package (208-mils Body Width)</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">SO3016 — 16-Lead Plastic Wide Outline Package (300-mils Body Width)</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">WND008 — 8-Contact WSON 5 mm ´ 6 mm</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">UNF008 — 8-Contact USON 4 mm x 4 mm</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">FAB024 — 24-Ball Ball Grid Array (8 mm ´ 6 mm) Package</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">FAC024 — 24-Ball Ball Grid Array (8 mm ´ 6 mm) Package</a> (Updated Package Drawing to Cypress format).<br>Updated <a href="#">Address Space Maps</a> :<br>Updated <a href="#">Device Identification</a> :<br>Updated <a href="#">Table 31</a> :<br>Added <a href="#">Note 1</a> and referred the same note in "ABh" in "Instruction" column.<br>Added <a href="#">Note 2</a> and referred the same note in "90h" in "Instruction" column.<br>Added <a href="#">Note 3</a> and referred the same note in "9Fh" in "Instruction" column. |

**Document History Page (Continued)**

**Document Title:** S25FL116K/S25FL132K/S25FL164K, 16-Mbit (2 Mbyte)/32-Mbit (4 Mbyte)/64-Mbit (8 Mbyte), 3.0 V, SPI Flash Memory  
**Document Number:** 002-00497

| Rev.       | ECN No. | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|------------|---------|-----------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| *F (cont.) | 5645494 | BWHA            | 02/28/2017      | Updated <a href="#">Commands</a> :<br>Updated <a href="#">Table 35</a> :<br>Updated details in "BYTE 2", "BYTE 3" and "BYTE 4" columns corresponding to "Manufacturer / Device ID" command.<br>Update <a href="#">Data Integrity</a> :<br>Update <a href="#">Data Retention</a> :<br>Removed "Data Retention Time Security Registers non-volatile register array" parameter and its details.<br>Updated <a href="#">Ordering Information</a> :<br>Updated <a href="#">Valid Combinations — Automotive Grade / AEC-Q100</a> :<br>Updated description.<br>Removed a row corresponding to "MFI" under "FL132K".<br>Removed rows corresponding to "MFI", "MFV", "NFI" and "NFV" under "FL164K".<br>Updated to new template. |
| *G         | 5709491 | GNKK            | 04/25/2017      | Updated the Cypress logo and copyright information.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| *H         | 5742469 | NFB             | 05/19/2017      | Added "Not Recommended for New Design (NRND)" status.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

## Sales, Solutions, and Legal Information

### Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at [Cypress Locations](#).

### Products

|                               |                                                                    |
|-------------------------------|--------------------------------------------------------------------|
| ARM® Cortex® Microcontrollers | <a href="http://cypress.com/arm">cypress.com/arm</a>               |
| Automotive                    | <a href="http://cypress.com/automotive">cypress.com/automotive</a> |
| Clocks & Buffers              | <a href="http://cypress.com/clocks">cypress.com/clocks</a>         |
| Interface                     | <a href="http://cypress.com/interface">cypress.com/interface</a>   |
| Internet of Things            | <a href="http://cypress.com/iot">cypress.com/iot</a>               |
| Memory                        | <a href="http://cypress.com/memory">cypress.com/memory</a>         |
| Microcontrollers              | <a href="http://cypress.com/mcu">cypress.com/mcu</a>               |
| PSoC                          | <a href="http://cypress.com/psoc">cypress.com/psoc</a>             |
| Power Management ICs          | <a href="http://cypress.com/pmic">cypress.com/pmic</a>             |
| Touch Sensing                 | <a href="http://cypress.com/touch">cypress.com/touch</a>           |
| USB Controllers               | <a href="http://cypress.com/usb">cypress.com/usb</a>               |
| Wireless Connectivity         | <a href="http://cypress.com/wireless">cypress.com/wireless</a>     |

### PSoC® Solutions

[PSoC 1](#) | [PSoC 3](#) | [PSoC 4](#) | [PSoC 5LP](#) | [PSoC 6](#)

### Cypress Developer Community

[Forums](#) | [WICED IOT Forums](#) | [Projects](#) | [Video](#) | [Blogs](#) | [Training](#) | [Components](#)

### Technical Support

[cypress.com/support](http://cypress.com/support)

Not Recommended for New Design

© Cypress Semiconductor Corporation, 2014-2017. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products. You shall indemnify and hold Cypress harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit [cypress.com](http://cypress.com). Other names and brands may be claimed as property of their respective owners.

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

⊖ View [S25FL132K0XNFV011](#) on WIN SOURCE

⊖ [Cypress Semiconductor Corp](#) Information

## Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management